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UTILITY PATENT APPLICATION TRANSMITTAL
(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No. : 39390/CAG/B600
Inventor(s) : Jacob Rael et al.
Title : AN ADAPTIVE RADIO TRANSCEIVER WITH A WIDE TUNING RANGE VCO
Express Mail Label No. : EL387000733US

ADDRESS TO: Assistant Commissioner for Patents
Box Patent Application
Washington, D.C. 20231

Date: October 18, 2000

1. ☒ **FEE TRANSMITTAL FORM** (Submit an original, and a duplicate for fee processing).

2. **IF A CONTINUING APPLICATION**

☒ This application is a continuation of patent Application No. 09/634,55, filed August 8, 2000.

Prior application information: Examiner ; Group Art Unit:

☒ This application claims priority pursuant to 35 U.S.C. §119(e) and 37 CFR §1.78(a)(4), to provisional Application No. 60/160,806, filed October 21, 1999; Application No. 60/163,487, filed November 4, 1999; Application No. 60/163,398, filed November 4, 1999; Application No. 60/164,442, filed November 9, 1999; Application No. 60/164,194, filed November 9, 1999; Application No. 60/164,314, filed November 9, 1999; Application No. 60/165,234, filed November 11, 1999; Application No. 60/165,239, filed November 11, 1999; Application No. 60/165,356; filed November 12, 1999; Application No. 60/165,355, filed November 12, 1999; Application No. 60/172,348, filed December 16, 1999; Application No. 60/201,335, filed May 2, 2000; Application No. 60/201,157, filed May 2, 2000; Application No. 60/201,179, filed May 2, 2000; Application No. 60/202,997, filed May 2, 2000; Application No. 60/201,330, filed May 2, 2000.

3. **APPLICATION COMPRISED OF**

Specification

94 Specification, claims and Abstract (total pages)

Drawings

48 Sheets of drawing(s) (FIGS. 1 to 47)

Declaration and Power of Attorney

☐ Newly executed

☒ Unexecuted declaration

☐ Copy from a prior application (37 CFR 1.63(d))(for continuation and divisional)

4. ☐ **Microfiche Computer Program** (Appendix)

UTILITY PATENT APPLICATION TRANSMITTAL
(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No.: 39390/CAG/B600

5. ☐ **Nucleotide and/or Amino Acid Sequence Submission** (*if applicable, all necessary*)
- ☐ Computer Readable Copy
- ☐ Paper Copy (identical to computer copy)
- ☐ Statement verifying identity of above copies

6. **ALSO ENCLOSED ARE**

- ☐ Preliminary Amendment
- ☐ A Petition for Extension of Time for the parent application and the required fee are enclosed as separate papers
- ☐ Small Entity Statement(s)
- ☐ Statement filed in parent application, status still proper and desired
- ☐ Copy of Statement filed in provisional application, status still proper and desired
- ☐ An Assignment of the invention with the Recordation Cover Sheet and the recordation fee are enclosed as separate papers
- ☐ This application is owned by pursuant to an Assignment recorded at Reel , Frame
- ☐ Information Disclosure Statement (IDS)/PTO-1449
- ☐ Copies of IDS Citations
- ☐ Certified copy of Priority Document(s) (*if foreign priority is claimed*)
- ☐ English Translation Document (*if applicable*)
- ☒ Return Receipt Postcard (MPEP 503) (should be specifically itemized).
- ☐ Other

7. **CORRESPONDENCE ADDRESS**

CHRISTIE, PARKER & HALE, LLP, P.O. BOX 7068, PASADENA, CA 91109-7068
CUSTOMER NUMBER: 23363

Respectfully submitted,

CHRISTIE, PARKER & HALE, LLP

By Craig A. Gelfound
Craig A. Gelfound
Reg. No. 41,032
626/795-9900

CAG/ej

10/18/00
1c930 U.S. PTO

**FEE TRANSMITTAL
UTILITY PATENT APPLICATION**

DATE: October 18, 2000

Docket No. : 39390/CAG/B600
Inventor(s) : Jacob Rael et al.
Title : AN ADAPTIVE RADIO TRANSCEIVER WITH A WIDE TUNING RANGE
VCO

FEE DETERMINATION

CLAIMS AS FILED					
	NUMBER FILED	NUMBER EXTRA	SMALL ENTITY RATE	LARGE ENTITY RATE	FEE
TOTAL CLAIMS	93 - 20	73	x \$9.00	73 x \$18.00	\$1,314.00
INDEPENDENT CLAIMS	7 - 3	4	x \$40.00	4 x \$80.00	\$320.00
MULTIPLE-DEPENDENT CLAIMS FEE			\$135.00	\$270.00	
BASIC FEE			\$355.00	\$710.00	\$710.00
TOTAL FILING FEE					\$2,344.00
List Independent Claims: 1, 15, 29, 35, 48, 57 & 76					

METHOD OF PAYMENT

- ☒ No filing fee enclosed
☒ No Deposit Account Authorization.

Respectfully submitted,

CHRISTIE, PARKER & HALE, LLP

By Craig A. Gelfound
Craig A. Gelfound
Reg. No. 41,032
626/795-9900

AN ADAPTIVE RADIO TRANSCEIVER WITH A WIDE TUNING RANGE VCO

CROSS-REFERENCE TO RELATED APPLICATION

The present application is a continuation of co-pending patent Application No. 09/634,552, filed August 8, 2000, priority of which is hereby claimed under 35 U.S.C. §120. The present application also claims priority under 35 U.S.C. § 119(e) to provisional Application Nos. 60/160,806, filed October 21, 1999; Application No. 60/163,487, filed November 4, 1999; Application No. 60/163,398, filed November 4, 1999; Application No. 60/164,442, filed November 9, 1999; Application No. 60/164,194, filed November 9, 1999; Application No. 60/164,314, filed November 9, 1999; Application No. 60/165,234, filed November 11, 1999; Application No. 60/165,239, filed November 11, 1999; Application No. 60/165,356; filed November 12, 1999; Application No. 60/165,355, filed November 12, 1999; Application No. 60/172,348, filed December 16, 1999; Application No. 60/201,335, filed May 2, 2000; Application No. 60/201,157, filed May 2, 2000; Application No. 60/201,179, filed May 2, 2000; Application No. 60/202,997, filed May 2, 2000; Application No. 60/201,330, filed May 2, 2000. All these applications are expressly incorporated herein by referenced as though fully set forth in full.

FIELD OF THE INVENTION

The present invention relates to telecommunication systems, and in particular, to radio transceiver systems and techniques.

BACKGROUND OF THE INVENTION

Transceivers are used in wireless communications to transmit and receive electromagnetic waves in free space. In general, a transceiver comprises three main components: a transmitter, a receiver, and an LO generator or frequency synthesizer. The function of the transmitter is to modulate, upconvert, and amplify signals for transmission into free space. The function of the receiver is to detect signals in the presence of noise and interference, and provide amplification, downconversion and demodulation of the detected the signal such that it can be displayed or used in a data processor. The LO generator provides a reference signal to both the transmitter for upconversion and the receiver for downconversion.

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Transceivers have a wide variety of applications ranging from low data rate wireless applications (such as mouse and keyboard) to medium data rate Bluetooth and high data rate wireless LAN 802.11 standards. However, due to the high cost, size and power consumption of currently available transceivers, numerous applications are not being fully commercialized. A simplified architecture would make a transceiver more economically viable for wider applications and integration with other systems. The integration of the transceiver into a single integrated circuit (IC) would be an attractive approach. However, heretofore, the integration of the transceiver into a single IC has been difficult due to process variations and mismatches. Accordingly, there is a need for an innovative transceiver architecture that could be implemented on a single IC, or alternatively, with a minimum number of discrete off-chip components that compensate for process variations and mismatches.

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SUMMARY OF THE INVENTION

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In one aspect of the present invention, an oscillator includes a first resonator having a first tuning input to tune the first resonator as a function of a first current applied to the first tuning input, and a second resonator coupled to the first resonator, the second resonator having a second tuning input to tune the second resonator as a function of a second current applied to the second tuning input.

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In another aspect of the present invention, an oscillator includes a first resonator having a first tuning input, a second resonator coupled to the first resonator, the second resonator having a second tuning input, first control means for controlling a first current applied to the first resonator to tune the first resonator, and second control means for controlling a second current applied to the second resonator to tune the second resonator.

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In yet another aspect of the present invention, an oscillator including a first resonator having a first tuning input and a first output, a second resonator having a second tuning input and a second output, a first transconductance cell coupled between the first output and the second tuning input, a second transconductance cell coupled between the second output and the first tuning input, a third transconductance cell coupled between the first output and the first tuning input, and a fourth transconductance cell coupled between the second output and the second tuning input.

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In still another aspect of the present invention, a transceiver includes a current controlled oscillator including a first resonator having a first tuning input to tune the first resonator as a function of a first current applied to the first tuning input, and a second resonator coupled to the first resonator, the second resonator having a second tuning input to tune the second resonator as a function of a second current applied to the second tuning input, and a controller having a first control to control the first current to the first tuning input, and a second control to control the second current to the second tuning input.

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In a further aspect of the present invention, a method of tuning an oscillator includes converting an output of a first resonator to a first current, converting an output of a second resonator to a second current, tuning a first resonator as a function of the second current, and tuning the second resonator as a function of the first current.

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In yet a further aspect of the present invention, a method of tuning an oscillator having a tuning range over a tuning frequency, the tuning frequency being divided into a plurality of frequency bands, the method including generating a first digital word, selecting one of the frequency bands with the first digital word, generating a second digital word, and tuning the oscillator to an operating frequency within the selected frequency bands with the second digital word.

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In still a further aspect of the present invention, an oscillator having a tuning range over a tuning frequency, the tuning frequency being divided into a plurality of frequency bands, the oscillator including selection means for selecting one of the frequency bands as a function of a first digital word, and tuning means for tuning the oscillator to an operating frequency within the selected frequency bands as a function of a second digital word.

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It is understood that other embodiments of the present invention will become readily apparent to those skilled in the art from the following detailed description, wherein it is shown and described only embodiments of the invention by way of illustration of the best modes contemplated for carrying out the invention. As will be realized, the invention is capable of other and different embodiments and its several details are capable of modification in various other respects, all without departing from the spirit and scope of the present invention. Accordingly, the drawings and detailed description are to be regarded as illustrative in nature and not as restrictive.

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DESCRIPTION OF THE DRAWINGS

These and other features, aspects, and advantages of the present invention will become better understood with regard to the following description, appended claims, and accompanying drawings where:

FIG. 1 is a block diagram of a transceiver in accordance with an exemplary embodiment of the present invention;

FIG. 2 is a block diagram of the transceiver blocks including a receiver, transmitter and local oscillator in accordance with an exemplary embodiment of the present invention;

FIG. 3 is a block diagram of a mixer in accordance with an exemplary embodiment of the present invention;

FIG. 4 is an electrical diagram of a low noise amplifier in accordance with an exemplary embodiment of the present invention;

FIG. 4(a) is an electrical diagram of a low noise amplifier in accordance with an another exemplary embodiment of the present invention;

FIG. 5 is a block diagram of a four-stage biquad complex bandpass filter in accordance with an exemplary embodiment of the present invention;

FIG. 6 is an electrical diagram of one biquad stage of the complex bandpass filter in accordance with an exemplary embodiment of the present invention;

FIG. 7 is a graphical depiction of the frequency response on the biquad stage of FIG. 6 in accordance with an exemplary embodiment of the present invention;

FIG. 8 is an electrical diagram of one possible input circuit for the biquad stage in accordance with an exemplary embodiment of the present invention;

FIG. 9 is an electrical diagram of another possible input circuit for the biquad stage in accordance with an exemplary embodiment of the present invention;

FIG. 10 is an electrical diagram of a modified a modified biquad stage of FIG. 6 in accordance with an exemplary embodiment of the present invention;

FIG. 11 is a graphical depiction of the frequency response of the modified biquad stage of FIG. 10 in accordance with an exemplary embodiment of the present invention;

FIG. 12(a) is an electrical diagram of a tunable array of capacitors in accordance with an exemplary embodiment of the present invention;

FIG. 12(b) is an electrical diagram of a tunable array of resistors in accordance with an exemplary embodiment of the present invention;

FIG. 13 is a block diagram of a complex bandpass filter using polyphase in accordance with an exemplary embodiment of the present invention;

FIG. 14 is a block diagram of a programmable multiple stage amplifier in accordance with an exemplary embodiment of the present invention;

FIG. 15 is a block diagram of an input and/or output stage for the programmable multiple stage amplifier of FIG. 14 in accordance with an exemplary embodiment of the present invention;

FIG. 16(a) is a block diagram of one core amplifier stage of the programmable multiple stage amplifier of FIG. 14 in accordance with an exemplary embodiment of the present invention;

FIG. 16(b) is a block diagram of a full-wave rectifier of the of the programmable multiple stage amplifier of FIG. 14 in accordance with an exemplary embodiment of the present invention;

FIG. 17(a) is an IF mixer in accordance with an exemplary embodiment of the present invention;

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FIG. 17(b) is a graphical depiction of a frequency spectrum for the limited IF clocks into the mixer of FIG. 17(a) in accordance with an exemplary embodiment of the present invention;

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FIG. 17(c) is a graphical depiction of a frequency spectrum for the IF input into the mixer of FIG. 17(a) in accordance with an exemplary embodiment of the present invention;

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FIG. 17(d) is a graphical depiction of a frequency spectrum for the output of the mixer of FIG. 17(a) in accordance with an exemplary embodiment of the present invention;

FIG. 18 is a clock generator in accordance with an exemplary embodiment of the present invention;

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FIG. 19(a) is a graphical depiction of a clock signal spectrum input into the clock generator of FIG. 18 in accordance with an exemplary embodiment of the present invention;

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FIG. 19(b) is a graphical depiction of a signal spectrum at the output of a two second stage polyphase filter of the clock generator of FIG. 18 in accordance with an exemplary embodiment of the present invention;

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FIG. 19(c) is a graphical depiction of the signal spectrum output from a low pass filter of the clock generator of FIG. 18 in accordance with an exemplary embodiment of the present invention;

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FIG. 20(a) is a graphical depiction of a signal spectrum at the input to a polyphase filter in accordance with an exemplary embodiment of the present invention;

FIG. 20(b) is a graphical depiction of a signal spectrum at the output of the polyphase filter in accordance with an exemplary embodiment of the present invention;

FIG. 20(c) is a graphical depiction of the signal spectrum output from a low pass filter of the polyphase filter in accordance with an exemplary embodiment of the present invention;

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FIG. 21 is a block diagram of a demodulator in accordance with an exemplary embodiment of the present invention;

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FIG. 22 is a block diagram of a differentiator of the demodulator of FIG. 21 in accordance with an exemplary embodiment of the present invention;

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FIG. 23 is a block diagram of a multiplier of the demodulator of FIG. 21 in accordance with an exemplary embodiment of the present invention;

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FIG. 24 is a block diagram of a peak detector/slicer of the demodulator of FIG. 21 in accordance with an exemplary embodiment of the present invention;

FIG. 25 is a block diagram of a differential power amplifier in accordance with an exemplary embodiment of the present invention;

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FIG. 26(a) is a electrical diagram of one bias circuit to the input and/or output stage of the differential power amplifier of FIG. 25 in accordance with an exemplary embodiment of the present invention;

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FIG. 26(b) is an electrical diagram of another bias circuit to the input and/or output stage of the differential power amplifier of FIG. 25 in accordance with an exemplary embodiment of the present invention;

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FIG. 27 is an electrical diagram of a bias circuit for a the current source of the differential power amplifier of FIG. 25 in accordance with an exemplary embodiment of the present invention;

FIG. 28 is an electrical diagram of a power control circuit for the differential power amplifier of FIG. 25 in accordance with an exemplary embodiment of the present invention;

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FIG. 29 is an electrical diagram of a single-ended differential power amplifier in accordance with an exemplary embodiment of the present invention;

FIG. 30 is an electrical diagram of digitally programmable CMOS power amplifier in accordance with an exemplary embodiment of the present invention;

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FIG. 31(a) is a block diagram of a local oscillator (LO) architecture in accordance with an exemplary embodiment of the present invention;

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FIG. 31(b) is a block diagram of an LO architecture in accordance with another exemplary embodiment of the present invention;

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FIG. 32 is a block diagram of a LO architecture in accordance with an alternative exemplary embodiment of the present invention;

FIG. 33 is a block diagram of a LO architecture in accordance with an yet another exemplary embodiment of the present invention;

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FIG. 33(a) is a block diagram of a limiting buffer for the LO architecture of FIG. 33 in accordance with an exemplary embodiment of the present invention;

FIG. 34 is a block diagram of a wide tuning range voltage controlled oscillator (VCO) in accordance with an exemplary embodiment of the present invention;

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FIG. 35 is an electrical diagram of the wide tuning range VCO of FIG. 34 in accordance with an exemplary embodiment of the present invention;

FIG. 36(a) is a graphical depiction showing a typical VCO tuning curve;

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FIG. 36 (b) is a graphical depiction of a segmented VCO tuning curve in accordance with an exemplary embodiment of the present invention;

FIG. 37 (a) is a block diagram of a cross-coupled VCO in combination with a frequency divider in accordance with an exemplary embodiment of the present invention;

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FIG. 37 (b) is a block diagram of a VCO in combination with a divider and polyphase circuit in accordance with an exemplary embodiment of the present invention;

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FIG. 38 is a block diagram of a controller in accordance with an exemplary embodiment of the present invention;

FIG. 39 is an electrical diagram of an RC calibration circuit in accordance with an exemplary embodiment of the present invention;

FIG. 40 is a block diagram of an RC calibration circuit using polyphase in accordance with an exemplary embodiment of the present invention;

FIG. 41 is an electrical diagram of a capacitor array in accordance with an exemplary embodiment of the present invention;

FIG. 42 is an electrical diagram of a bandgap calibration circuit in accordance with an exemplary embodiment of the present invention;

FIG. 43 is a block diagram of bandgap circuit in accordance with an exemplary embodiment of the present invention;

FIG. 44 is a electrical diagram of a resistor array in accordance with an exemplary embodiment of the present invention;

FIG. 45 is a block diagram of a floating MOS capacitor in accordance with an exemplary embodiment of the present invention;

FIG. 46 is an electrical diagram of a duplexing circuit with the power amplifier on and the low noise amplifier off in accordance with an exemplary embodiment of the present invention; and

FIG. 47 is an electrical diagram of a duplexing circuit with the low noise amplifier on and the power amplifier off in accordance with an exemplary embodiment of the present invention.

DETAILED DESCRIPTION

Exemplary Embodiments of a Transceiver

In accordance with an exemplary embodiment of the present invention, a transceiver utilizes a combination of frequency planning, circuit design, layout and implementation,

1 differential signal paths, dynamic calibration, and self-tuning to achieve robust performance over
process variation and interference. This approach allows for the full integration of the transceiver
onto a single IC for a low cost, low power, reliable and more compact solution. This can be
5 achieved by (1) moving external bulky and expensive image reject filters, channel select filters,
and baluns onto the RF chip; (2) reducing the number of off-chip passive elements such as
capacitors, inductors, and resistors by moving them onto the chip; and (3) integrating all the
remaining components onto the chip. As those skilled in the art will appreciate, the described
exemplary embodiments of the transceiver do not require integration into a single IC and may
10 be implemented in a variety of ways including discrete hardware components.

As shown in Figure 1, a described exemplary embodiment of the transceiver includes an
antenna 8, a switch 9, a receiver 10, a transmitter 12, a local oscillator (LO) generator (also called
a synthesizer) 14, a controller 16, and a self-testing unit 18. All of these components can be
15 packaged for integration into a single IC including components such as filters and inductors.

The transceiver can operate in either a transmit or receive mode. In the transmit mode,
the transmitter 12 is coupled to the antenna 8 through the switch 9. The switch 9 provides
sufficient isolation to prevent transmitter leakage from desensitizing or damaging the receiver
20 10. In the receive mode, the switch 9 directs signal transmissions from the antenna 8 to the
receiver 10. The position of the switch 9 can be controlled by an external device (not shown)
such as a computer or any other processing device known in the art.

The receiver 10 provides detection of desired signals in the presence of noise and
interference. It should be able extract the desired signals and amplify it to a level where
information contained in the received transmission can be processed. In the described exemplary
embodiment, the receiver 10 is based on a heterodyne complex (I-Q) architecture with a
programmable intermediate frequency (IF). The LO generator 14 provides a reference signal to
the receiver 10 to downconvert the received transmission to the programmed IF.
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A low IF heterodyne architecture is chosen over a direct conversion receiver because of
the DC offset problem in direct conversion architectures. DC offset in direct conversion
architectures arises from a number of sources including impedance mismatches, variations in
threshold voltages due to process variations, and leakage from the LO generator to the receiver.
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With a low IF architecture, AC coupling between the IF stages can be used to remove the DC offset.

The transmitter 12 modulates incoming data onto a carrier frequency. The modulated carrier is upconverted by the reference signal from the LO generator 14 and amplified to a sufficient power level for radiation into free space through the antenna 8. The transmitter uses a direct conversion architecture. With this approach only one step of upconversion is required. This leads to a reduction in both circuit complexity and power consumption.

The controller 16 performs two functions. The first function provides for adaptive programming of the receiver 10, transmitter 14 and LO generator 16. By way of example, the transceiver can be programmed to handle various communication standards for local area networks (LAN) and personal area networks (PAN) including HomeRF, IEEE 802.11, Bluetooth, or any other wireless standard known in the art. This entails programming the transceiver to handle different modulation schemes and data rates. The described exemplary embodiment of the transceiver can support modulation schemes such as Binary Phase Shift Keying (BPSK), Quadrature Phase Shift Keying (QPSK), offset quadrature phase shift keying (OQPSK), Multiple frequency modulations such as M level frequency shift keying (FSK), Continuous Phase Frequency Shift Keying modulation (CFSK), Minimum Shift Keying modulation (MSK), Gaussian filtered FSK modulation (GFSK), and Gaussian filtered Minimum Shift Keying (GMSK), Phase/Amplitude modulation (such as Quadrature Amplitude Modulation (QAM)), orthogonal frequency modulation (such as Orthogonal Frequency Division Multiplexing (OFDM)), direct sequence spread spectrum systems, and frequency hopped spread spectrum systems and numerous other modulation schemes known in the art. Dynamic programming of the transceiver can also be used to provide optimal operation in the presence of noise and interference. By way of example, the IF can be programmed to avoid interference from an external source.

The second function provides for adaptive calibration of the receiver 10, transmitter 14 and LO generator 16. The calibration functionality controls the parameters of the transceiver to account for process and temperature variations that impact performance. By way of example, resistors can be calibrated within exacting tolerances despite process variations in the chip fabrication process. These exacting tolerances can be maintained in the presence of temperature changes by adaptively fine tuning the calibration of the resistors.

1 The controller 16 can be controlled externally by a central processing unit (CPU) , a microprocessor, a digital signal processor (DSP), a computer, or any other processing device known in the art. In the described exemplary embodiment, a control bus 17 provides two way
5 communication between the controller 16 and the external processing device (not shown). This communication link can be used to externally program the transceiver parameters for different modulation schemes, data rates and IF operating frequencies. The output of the controller 16 is used to adjust the parameters of the transceiver to achieve optimal performance in the presence of process and temperature variations for the selected modulation scheme, data rate and IF.
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The self-testing unit 18 generates test signals with different amplitudes and frequency ranges. The test signals are coupled to the receiver 10, transmitter 12 and LO generator 14 where they are processed and returned to the self-testing unit 18. The return signals are used to
15 determine the gain, frequency characteristics, selectivity, noise floor, and distortion behavior of the receiver 10, transmitter 12 and LO generator 14. This is accomplished by measuring the strength of the signals output from the self-testing unit 18 against the returned signals over the tested frequency ranges. In an exemplary embodiment of the self-testing unit 18, these measurements can be made with different transceiver parameters by sweeping the output of the controller 16 through its entire calibrating digital range, or alternatively making measurements
20 with the controller output set to a selected few points, by way of example, at the opposite ends of the digital range.

In the described exemplary embodiment, the self-testing unit 18 is in communication with the external processing device (not shown) via the control bus 17. During self-test, the external
25 processing device provides programming data to both the controller 16 and the self-testing unit 18. The self-testing unit 18 utilizes the programming data used by the controller 16 to set the parameters of the transceiver to determine the gain, frequency characteristics, selectivity, noise floor, and distortion behavior of the receiver 10, transmitter 12 and LO generator 14.

30 Figure 2 shows a block diagram of the transceiver in accordance with an embodiment of the invention. The described exemplary embodiment is integrated into a single IC. For ease of understanding, each component coupled to the controller is shown with a “program” designation or a “calibration” designation. These designations indicate whether the component is programmed by the controller or calibrated by the controller. In practice, in accordance with the
35 described exemplary embodiment of the present invention, the components that are programmed

1 receive the MSBs and the components that are calibrated receive the LSBs. The components
requiring both programming and calibration receive the entire digital output from the controller.
As those skilled in the art will appreciate, any number of methodologies may be used to deliver
5 programming and calibration information to the individual components. By way of example, a
single controller bus could be used having the programming and or calibration data with the
appropriate component addresses.

10 The receiver 10 front end includes a low noise amplifier (LNA) 22 which provides high
gain with good noise figure performance. Preferably, the gain of the LNA 22 can be set by the
controller (not shown) through a “select gain” input to maximize the receivers dynamic range.
The desirability of dynamic gain control arises from the effect of blockers or interferers which
can desensitize the LNA. Conventional filter designs at the input of the LNA 22 may serve to
15 sufficiently attenuate undesired signals below a certain power level, however, for higher power
blockers or interferers, the LNA 22 should be operated with low gain.

20 The output of the LNA 22 is downconverted to a low IF frequency by the combination
of complex IF mixers 24 and a complex bandpass filter 26. More particularly, the output of the
LNA 22 is coupled to the complex IF mixers 24 which generate a spectrum of frequencies based
upon the sum and difference of the received signal and the RF clocks from the LO generator.
The complex bandpass filter passes the complex IF signal while rejecting the image of the
received signal. The image rejection capability of the complex IF mixers 24 in cooperation with
the complex bandpass filter 26 eliminates the need for the costly and power consuming preselect
25 filter typically required at the input of the LNA for conventional low IF architectures.

30 The output of the complex bandpass filter 26 is coupled to a programmable multiple gain
stage amplifier 28. The amplifier 28 can be designed to be programmable to select between a
limiter and an automatic gain control (AGC) feature, depending on the modulation scheme used
in the transceiver. The limiting amplifier can be selected if the transceiver uses a constant
envelope modulation such as FSK. AGC can be selected if the modulation is not a constant
35 envelope, such as QAM. In addition, the bandwidth of the amplifier 28 can be changed by the
controller to accommodate various data rates and modulation schemes.

The output of the amplifier 28 is coupled to a second set of complex IF mixers 30 where
it is mixed with the IF clocks from the LO generator for the purpose of downconverting the

complex IF signal to baseband. The complex IF mixers 30 not only reject the image of the complex IF signal, but also reduces some of the unwanted cross modulation spurious signals thereby relaxing the filtering requirements.

The complex baseband signal from the mixers 30 is coupled to a programmable passive polyphase filter within a programmable low pass filter 32. The programmable low pass filter 32 further filters out higher order cross modulation products. The polyphase filter can be centered at four times the IF frequency to notch out one of the major cross modulation products which results from the multiplication of the third harmonic of the IF signal with the IF clock. After the complex baseband signal is filtered, it either is passed through an analog-to-digital (A/D) converter 34 to be digitized or is passed to an analog demodulator 36. The analog demodulator 36 can be implemented to handle any number of different modulation schemes by way of example FSK. Embodiments of the present invention with an FSK demodulator uses the A/D converter 36 to sample baseband data with other modulation schemes for digital demodulation in a digital signal processor (not shown).

The LO generator 14 provides the infrastructure for frequency planning. The LO generator 14 includes an IF clock generator 44 and an RF clock generator 47. The IF clock generator includes an oscillator 38 operating at a ratio of the RF signal (f_{OCS}). High stability and accuracy can be achieved in a number of ways including the use of a crystal oscillator.

The reference frequency output from the oscillator 38 is coupled to a divider 40. The divider 40 divides the reference signal f_{OSC} by a number L to generate the IF clocks for downconverting the complex IF signal in the receiver to baseband. A clock generator 41 is positioned at the output of the divider 40 to generate a quadrature sinusoidal signal from the square wave output of the divider 40. Alternatively, the clock generator 41 can be located in the receiver. The divider 40 may be programmed by through the program input. This feature allows changes in the IF frequency to avoid interference from an external source.

The output of the divider 40 is coupled to the RF clock generator 47 where it is further divided by a number n by a second divider 42. The output of the second divider 42 provides a reference frequency to a phase lock loop (PLL) 43. The PLL includes a phase detector 45, a divide by M circuit 46 and a voltage controlled oscillator (VCO) 48. The output of the VCO 48 is fed back through the divide by M circuit 46 to the phase detector 45 where it is compared with

the reference frequency. The phase detector 45 generates an error signal representative of the phase difference between the reference frequency and the output of the divide by M circuit 46. The error signal is fed back to the control input of the VCO 48 to adjust its output frequency f_{VCO} until the VCO 48 locks to a frequency which is a multiple of the reference frequency. The VCO 48 may be programmed by setting M via the controller through the program input to the divide by M circuit 46. The programmability resolution of the VCO frequency f_{VCO} is set by the reference frequency which also may be programmed by the controller through the program input of the divider 42.

In the described exemplary embodiment, the VCO frequency is sufficiently separated (in frequency) from the RF frequency generated by the transmitter 12 to prevent VCO pulling and injection lock of the VCO. Transmitter leakage can pull the VCO frequency toward the RF frequency and actually cause the VCO to lock to the RF signal if their frequencies are close to each other. The problem is exasperated if the gain and tuning range of the VCO is large. If the frequency of the RF clocks is f_{LO} , then the VCO frequency can be defined as: $f_{VCO} = Nf_{LO} / (N+1)$. This methodology is implemented with a divide by N circuit 50 coupled to the output of the VCO 48 in the PLL 43. The output of the VCO 48 and the output of the divide by N circuit 50 are coupled to a complex mixer 52 where they are multiplied together to generate the RF clocks. A filter 53 can be positioned at the output of the complex mixer to remove the harmonics and any residual mixing images of the RF clocks. The divide by N circuit can be programmable via the controller through the select input. For example, if $N=2$, then $f_{VCO} = (2/3)f_{LO}$, and if $N=3$, then $f_{VCO} = (3/4)f_{LO}$.

A VCO frequency set at $2/3$ the frequency of the RF clocks works well in the described exemplary embodiment because the transmitter output is sufficiently separated (in frequency) from the VCO frequency. In addition, the frequency of the RF clocks is high enough so that its harmonics and any residual mixing images such as $f_{VCO} \times 1 - (1/N)$, $3f_{VCO} \times 1 + (1/N)$, and $3f_{VCO} \times 1 - (1/N)$ are sufficiently separated (in frequency) from the transmitter output to relax the filtering requirements of the RF clocks. The filtering requirements do not have to be sharp because the filter can better distinguish between the harmonics and the residual images when they are separated in frequency. Programming the divide by N circuit 50 also provides for the quadrature outputs of the divide by N circuit. Otherwise, with an odd number programmed, the outputs of the divide by N circuit 50 would not be quadrature. For an odd number, the divider 50 outputs will be differential, but will not be 90 degrees out of phase, i.e., will not be I-Q signals.

In the described exemplary embodiment, the RF clocks are generated in the LO generator 14. This can be accomplished in various fashions including, by way of example, either generating the RF clocks in the VCO or using a polyphase circuit to generate the RF clocks. Regardless of the manner in which the RF clocks are generated, the mixer 52 will produce a spectrum of frequencies including the sum and difference frequencies, specifically, $f_{VCO} \times (1 + (1/N))$ and its image $f_{VCO} \times (1 - (1/N))$. To reject the image, the mixer 52 can be configured as a double quadrature mixer as depicted in Figure 3. The double quadrature mixer includes one pair of mixers 55, 57 to generate the Q-clock and a second pair of mixers 59, 61 to generate the I-clock. The Q-clock mixers utilizes a first mixer 55 to mix the I output of the VCO 48 (see Figure 2) with the Q output of the divider 40 and a second mixer 57 to mix the Q output of the VCO with the I output of the divider. The outputs of the first and second mixers are connected together to generate the Q-clock. Similarly, the I-clock mixers utilizes a first mixer 59 to mix the I output of the divider with the Q output of the VCO and a second mixer 61 to mix the Q output of the divider with the I output of the VCO. The outputs of the first and second mixers are connected together to generate the I-clock. This technique provides very accurate I-Q clocks by combination of quadrature VCO and filtering. Because of the quadrature mixing, the accuracy of the I-Q clocks is not affected by the VCO inaccuracy, provided that the divide by N circuit generates quadrature outputs. This happens for even divide ratios, such as N=2.

Optimized performance is achieved through frequency planning and implemented by programmable dividers in the LO generator to select different ratios. Based on Figure 2, all the dependencies of the frequencies are shown by the following equation:

$$f_{LO} = f_{RF} - (M \times f_{OSC}/nL)(1 + 1/N) = f_{OSC}/L$$

where f_{RF} is frequency of the transmitter output.

Turning back to Figure 2, the transmitter 12 includes a complex buffer 54 for coupling incoming I-Q modulated baseband signals to a programmable low-pass filter 56. The low-pass filter 56 can be programmed by the controller through the select input. The output of the low-

pass filter 56 is coupled to complex mixers 58. The complex mixers 58 mixes the I-Q modulated baseband signals with the RF clocks from the LO generator to directly upconvert the baseband signals to the transmitting frequency. The upconverted signal is then coupled to an amplifier 60 and eventually a power amplifier (PA) 62 for transmission into free space through the antenna. A bandpass filter (not shown) may be disposed after the PA 62 to filter out unwanted frequencies before transmission through the antenna.

In the described exemplary embodiment, the transmitter can be configured to minimize spurious transmissions. Spurious transmissions in a direct conversion transmitter are generated mainly because of the nonlinearity of the complex mixers and the DC offsets at the input to the complex mixers. Accordingly, the complex mixers can be designed to meet a specified IIP3 (Input Intercept Point for the 3rd Harmonic) for the maximum allowable spurs over the frequency spectrum of the communications standard. The DC offsets at the input to the complex mixers can be controlled by the physical size of the transistors.

In addition, the transmitter can be designed to minimize spurious transmission outside the frequency spectrum of the communications standard set by the FCC. There are two sources for these spurs: the LO generator and the transmitter. These spurs can be suppressed by multiple filtering stages in the LO generator and transmitter. Specifically, in the LO generator, due to the complex mixing of the VCO signal with the output of the divide by N circuit, all the spurs are at least f_{VCO}/N away from the RF clocks. By setting N to 2, by way of example, these unwanted spurs will be sufficiently separated (in frequency) from the transmitted signal and are easily removed by conventional filters in the LO generator and transmitter. Thus, the spurs will be mainly limited to the harmonics of the transmitted signal, which are also sufficiently separated (in frequency) from the transmitted signal, and therefore, can be rejected with conventional filtering techniques. For further reduction in spurs, a dielectric filter may be placed after the PA in the transmitter.

1.0 Receiver

1.1 Differential Amplifier

In exemplary embodiments of the present invention, a differential amplifier can be used to provide good noise immunity in low noise applications. Although the differential amplifiers

are described in the context of a low noise amplifier (LNA) for a transceiver, those skilled in the art will appreciate that the techniques described are likewise suitable for various applications requiring good noise immunity. Accordingly, the described exemplary embodiments of an LNA for a transceiver is by way of example only and not by way of limitation.

1.1.1 Single-to-Differential LNA

The described LNA can be integrated into a single chip transceiver or used in other low noise applications. In the case of transceiver chip integration, the LNA should be relatively insensitive to the substrate noise or coupling noise from other transceiver circuits. This can be achieved with a single-to-differential LNA. The single-ended input provides an interface with an off-chip single-ended antenna. The differential output provides good noise immunity due to its common mode rejection.

Figure 4 shows a schematic of a single-to-differential amplifier having two identical cascode stages that are driven by the same single-ended input 64. The input 64 is coupled to a T-network having two series capacitors 82, 84 and a shunt inductor 72. The first stage includes a pair of transistors 74, 78 connected between the shunt inductor 72 and a DC power source via an inductor 68. The second stage includes a complimentary pair of transistors 76, 80 connected between ground and the DC power source via an inductor 70. The gate of the one of the transistors 80 in the second stage is connected to the output of the T-network at the capacitor 84. A bias current is applied to the gate of each transistor.

This configuration provides an input that is well matched with the antenna because the parallel connection of the T-network with the source of the transistor 78 transforms the $1/g_m$ (transconductance) of the transistor to a resistance (preferably 50 ohms to match the antenna). By adjusting the values of T-network components, the matching circuit can be tuned for different frequencies and source impedances. The input capacitor 82 of the T-network further provides decoupling between the antenna and the amplifier.

For DC biasing purposes, the shunt inductor 72 provides a short circuit to ground allowing both stages of the amplifier to operate at the same DC drain current. The output

capacitor 84 provides DC isolation between the gate bias applied to the transistor 80 of the second stage and the source 82 of the transistor 78 in the first stage.

In operation, a signal applied to the input of the amplifier is coupled to both the source 82 of the transistor 78 of the first stage and the gate 83 of the transistor 80 of the second stage. This causes the gain of each stage to vary inversely to one another. As a result, the signal voltage applied to the input of the amplifier is converted to a signal current with the signal current in the first stage being inverted from the signal current in the second stage. Moreover, the two stages will generate the same gain because the gm of the transistors should be the same, and therefore, the total gain of the amplifier is twice as much as conventional single-to-differential amplifiers.

1.1.2 Differential LNA

A differential LNA can also be used to provide good noise immunity in low noise applications, such as the described exemplary embodiment of the transceiver. In Figure 4(a), an exemplary differential LNA is shown having a cascode differential pair with inductive degeneration. In the described exemplary embodiment, the differential LNA can be integrated into a single chip transceiver or used in other similar applications.

In the case of transceiver chip integration, an off chip coupler (not shown) can be used to split the single-ended output from the antenna into a differential output with each output being 180° out of phase. The LNA input can be matched to the coupler, i.e., a 50 ohm source, by LC circuits. A shunt capacitor 463 in combination with a series inductor 465 provides a matching circuit for one output of the coupler, and a shunt capacitor 467 in combination with a series inductor 469 provides a matching circuit for the other output of the coupler. At 2.4 GHz., each LC circuit may be replaced by a shunt capacitor and transmission line. In the described exemplary embodiment, the LC circuits are off-chip for improved noise figure performance. Alternatively, the LC circuits could be integrated on chip. However, due to the high loss of on chip inductors, the noise figure, as well as gain, could suffer.

The differential output of the coupler is connected to a differential input of the LNA via the LC matching circuits. The differential input includes a pair of input FET transistors 471, 473 with inductive degeneration. This is achieved with an on chip source inductor 475 connected between the input transistor 471 and ground, and a second on chip source inductor 479 connected

between the input transistor 473 and ground. The on chip inductive degeneration provides a predominantly resistive input impedance. In addition, the FET noise contribution at the operating frequency is reduced.

The outputs of the input transistors 471, 473 are coupled to a cascode stage implemented with a pair of transistors 481, 486, respectively. The cascode stage provides isolation between the LNA input and its output. This methodology improves stability, and reduces the effect of the output load on the LNA input matching circuits. The gates of the cascode transistors 481, 486 are biased at the supply voltage by a resistor 488. The resistor 488 reduces instability that might otherwise be caused by parasitic inductances at the gates of the cascoded transistors 481, 486. Since the described exemplary embodiment of the LNA uses a differential architecture, the resistor does not contribute noise to the LNA output.

The output of cascoded transistor 481 is coupled to the supply voltage through a first inductor 490. The output of the cascoded transistor 486 is coupled to the supply voltage through a second inductor 492. The LNA is tuned to the operating frequency by the output inductors 490, 492. More particularly, these inductors 490, 492 resonate with the LNA output parasitic capacitance, and the input capacitance of the next state (not shown). Embodiments of the present invention integrated into a single integrated circuit do not require a matching network at the LNA output.

The gain of the LNA can be digitally controlled. This is achieved by introducing a switchable resistor in parallel with each of the output inductors. In the described exemplary embodiment, a series resistor 494 and switch 496 is connected in parallel with the output inductor 490, and a second series resistor 498 and switch 500 is connected in parallel with the output inductor 492. The switches can be FET transistors or any other similar switching devices known in the art. In the low gain mode, each resistor 494, 498 is connected in parallel with its respective output inductor 490, 492, which in turn, reduces the quality factor of each output inductor, and as a consequence the LNA gain. In the high gain mode, the resistors 494, 498 are switched out of the LNA output circuit by their respective switches 496, 500.

1.2 A Complex Filter

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In an exemplary embodiment of the present invention, a programmable/tunable complex filter is used to provide frequency planning, agility, and noise immunity. This is achieved with variable components to adjust the frequency characteristics of the complex filter. Although the complex filter is described in the context of a transceiver, those skilled in the art will appreciate that the techniques described are likewise suitable for various applications requiring frequency agility or good noise immunity. Accordingly, the described exemplary embodiment for a complex filter in a transceiver is by way of example only and not by way of limitation.

10 The described complex filter can be integrated into a single chip transceiver or used in other low noise applications. In the case of transceiver chip integration, the off-chip filters used for image rejection and channel selection can be eliminated. A low-IF receiver architecture enables the channel-select feature to be integrated into the on-chip filter. However, if the IF lies within the bandwidth of the received signal, e.g. less than 80 MHz in the Bluetooth standard, the on-chip filter should be a complex filter (which in combination with the complex mixers) can suppress the image signal. Thus, either a passive or an active complex filter with channel select capability should be used. Although a passive complex filter does not dissipate any power by itself, it is lossy, and loads the previous stage significantly. Thus, an active complex filter with channel select capability is preferred. The channel select feature of the active complex filter can achieve comparable performance to conventional band-pass channel-select filters in terms of noise figure, linearity, and power consumption

25 The described exemplary embodiment of the complex filter accommodates several functions in the receiver signal path: it selects the desired channel, rejects the image signal which lies inside the data band of the received signal due to its asymmetric frequency response, and serves as a programmable gain amplifier (PGA). Moreover, the complex filter center frequency and its bandwidth can be programmed and tuned. These capabilities facilitate a robust receiver in a wireless environment, where large interferers may saturate the receiver or degrade the signal-to-noise ratio at the demodulator input. The attenuation of the received signal at certain frequencies can also be enhanced by introducing zeros in the complex filter.

1.2.1 Cascaded Biquads

35 An exemplary embodiment of the complex filter includes a cascade of biquads. Each biquad comprises a 2nd order bandpass filter. The total order of the filter is the sum of orders

of the cascaded biquads. The order of the filter can be programmable. By way of example, four cascaded biquads 83, 85, 87, 89 can be used with each of the cascaded biquads having an individually controlled bypass switch. Referring to Figure 5, a bypass switch 91 is connected across the input stage biquad 83. Similarly, a bypass switch 93 is connected across the second stage biquad 85, a bypass switch 95 is connected across the third stage biquad 87, and a bypass switch 97 is connected across the output stage biquad. With this configuration, the order of the filter can be programmed by bypassing one or more biquads. A biquad that is bypassed contributes a zero order to the filter.

In the described exemplary embodiment, the bypass switches are operated in accordance with the output from the controller 16 (see Figure 2). An 8th order filter can be constructed by opening the bypass switches 91, 93, 95, 97 via the digital signal from the controller output. The complex filter can be reduced to a 6th order filter by closing the bypass switch 97 to effectively remove the output stage biquad from the complex filter. Similarly, the complex filter can be reduced to a 4th order filter by closing bypass switches 95, 97 effectively removing the third stage biquad and output stage biquad. A 2nd order filter can be created by closing bypass switches 93, 95, 97 effectively removing all biquads with the exception of the input stage from the circuit.

1.2.1.1 The Poles of a Biquad Stage

Figure 6 shows an exemplary embodiment of a biquad stage of the complex filter. The biquad stage includes two first order resistor-capacitor (RC) filters each being configured with a differential operational amplifier 94, 96, respectively. The first differential operational amplifier 94 includes two negative feedback loops, one between each differential output and its respective differential input. Each feedback loop includes a parallel RC circuit (98, 106), (108, 100), respectively. Similarly, the second differential operational amplifier 96 includes two negative feedback loops, one between each differential output and its respective differential input. Each feedback loop includes a parallel RC circuit (102-110), (112-104), respectively. This topology is highly linear, and therefore, should not degrade the overall IIP3 of the receiver. The RC values determine the pole of the biquad stage.

The differential inputs of the biquad stage are coupled to their respective differential operational amplifiers through input resistors 114, 116, 118, 120 . The input resistors in combination with their respective feedback resistors set the gain of the biquad stage.

Preferably, some or all of the resistors and capacitors values can be programmable and can be changed dynamically by the controller. This methodology provides a frequency agile biquad stage.

The two first order RC filters are cross coupled by resistors 86, 88, 90, 92. By cross-coupling between the two filters, a complex response can be achieved, that is, the frequency response at the negative and positive frequencies will be different. This is in contrast to a real-domain filter, which requires the response to be symmetric at both positive and the negative frequencies. This feature is useful because the negative frequency response corresponds to the image signal. Thus, the biquad stage selects the desired channel, whereas the image signal, which lies at the negative frequency is attenuated.

For the resistor values shown in figure 6, the biquad stage outputs are:

$$V_{OI} = A \frac{(1+jRC\omega)V_{II} + 2QV_{IQ}}{(1+jRC\omega)^2 + 4Q^2} \quad (1)$$

and

$$V_{OQ} = A \frac{-2QV_{II} + (1+jRC\omega)V_{IQ}}{(1+jRC\omega)^2 + 4Q^2} \quad (2)$$

Figure 7 shows the frequency response for the complex biquad filter.

After the received signal is downconverted, the desired channel in the I path lags the one in the Q path, that is, $V_{II} = -jV_{IQ}$, and therefore:

$$H(j\omega) = \frac{V_o}{V_i}(j\omega) = \frac{A}{1 + jRC\omega - j2Q} \quad (3)$$

This shows a passband gain of A at a center frequency of $2Q/RC$, with a 3-dB bandwidth of $2RC$. Thus, the quality factor of the second-order stage will be Q. For the image signal however, the signal at the I branch leads, and as a result:

$$H(j\omega) = \frac{A}{1 + jRC\omega + j2Q} \quad (4)$$

which shows that the image located at $2Q/RC$ is rejected by $\frac{1}{\sqrt{1 + (4Q)^2}}$. Therefore, the biquad stage has an asymmetric frequency response, that is, the desired signal may be assigned to positive frequencies, whereas the image is attributed to negative frequencies. In general, the frequency response of the biquad stage is obtained by applying the following complex-domain transformation to a normalized real-domain lowpass filter:

$$j\omega \rightarrow \frac{j(\omega - \omega_0)}{BW} \quad (5)$$

where ω_0 is the bandpass (BP) center frequency, and BW is the lowpass (LP) equivalent bandwidth, equal to half of the bandpass filter bandwidth. For instance, for a second-order biquad stage (as shown in Figure 6), $\omega_0 = 2Q/RC$, and $BW = 1/RC$. The biquad stage is designed by finding its LP equivalent frequency response using equation (5). Once the LP poles are known, the BP poles are calculated based on equation (5). Assume that the LP equivalent has n poles, and $p_{i,LP} = \alpha_i + j\beta_i$ is the ith pole. From equation (5), the BP pole will be:

$$P_{i,BP} = BW \cdot P_{i,LP} + j\omega_0 = \alpha_i \cdot BW + j(\omega_0 + \beta_i \cdot BW) \quad (6)$$

The complex filter is realized by cascading n biquad stages. Therefore, similar to real-domain bandpass filters, an nth order complex filter uses $2 \times n$ integrators. Based on equation (3), each biquad stage has a pole equal to $-1/RC + j2Q/RC$. Thus:

$$\alpha_i \cdot BW = \frac{-1}{RC} \quad (7)$$

and

$$\omega_o + \beta_i \cdot BW = \frac{2Q}{RC} \quad (8)$$

Since the LP equivalent poles are located in the left-half plane, a_i is always negative. The above equations set the value of Q and RC in each stage. The gain of each biquad stage can be adjusted based on the desired gain in the complex filter, and noise-linearity trade-off: increasing the gain of one biquad stage lowers the noise contributed by the following biquad stages, but it also degrades the linearity of the complex filter.

In addition to image rejection, the complex frequency transformation of the biquad stage (equation (5)) provides for its frequency response to be symmetric around its center frequency as shown in figure 7. This is in contrast to regular bandpass filters which use the following real-domain transformation:

$$j\omega \rightarrow \frac{j(\omega^2 - \omega_o^2)}{BW \cdot \omega} \quad (9)$$

This symmetric response in the biquad stage ensures a uniform group delay across the data band.

1.2.1.2 The Zeros of a Biquad Stage

The described exemplary embodiment of the biquad stage can be modified to obtain a sharper rejection or notch at an undesired signal at a specific frequency. This can be achieved in the biquad stage by adding zeros. Assume that the input resistors at the biquad input (R_i 114

in figure 6) is replaced with an admittance Y_i . For the received signal, the frequency response of the biquad stage will be equal to:

$$H(j\omega) = \frac{R \cdot Y_i}{1 + jRC\omega - j2Q} \quad (10)$$

Figure 8 shows Y_i having resistor R_z 128 and capacitor C_z 130.

In order to have a zero located at $j\omega$ axis in the frequency response, Y_i should contain a term such as $1 - \omega/\omega_z$. If Y_i is simply made of a resistor R_z in parallel with a capacitor C_z , then the input admittance will be equal to:

$$Y_i = \frac{1}{R_z} + j\omega C_z \quad (11)$$

which is not desirable, since the zero will be in the left-half plane, rather than the $j\omega$ axis.

Figure 9 shows Y_i with the capacitor C_z 132 connected to the Q input 134 and the resistor R_z connected to the I input 136. Now the current I will be equal to:

$$I = \frac{V}{R_z} + jC_z\omega \cdot (jV) \quad (12)$$

Therefore, the input admittance will be equal to:

$$Y_i = \frac{1}{V} = \frac{1}{R_z} - C_z \omega \quad (13)$$

which indicates that the filter will have a zero equal to $1/R_z C_z$ at the $j\omega$ axis.

Figure 10 shows a single biquad stage modified to have a zero at the $j\omega$ axis. The biquad stage includes capacitors 138, 140, 142, 144. The combination of capacitors 138, 140, 142, 148 and resistors 116, 118 determines a complex zero with respect to the center frequency. The transfer function for the received signal will be:

$$H(j\omega) = A \frac{1 - \frac{RC_z}{A} \omega}{1 + jRC\omega - j2Q} \quad (14)$$

Equation (14) is analogous to equation (3), with the difference that now a zero at A/RC_z is added to the biquad stage of the complex filter. By knowing the LP equivalent characteristics of the biquad stage, the poles are calculated based on equation (6). The value of Q and RC in each biquad stage is designed by using equation (7) and equation (8). If the normalized LP zeros are at $\pm\omega_{z,LP}$, then the biquad stage should be realized with two biquad stages cascaded, and the frequency of zeros in the biquad stages will be (equation (5)):

$$\omega_{z1,2} = \omega_0 \pm \omega_{z,LP} \cdot BW \quad (15)$$

If the differential I and Q inputs connected to the zero capacitors are switched, the biquad stage will have zeros at negative frequencies (image response). This property may be exploited to notch the image signal.

1.2.1.3 Tunability and Programmability

In addition to channel selection and image rejection, the described exemplary embodiment of the complex filter can provide variable gain, bandwidth, and center frequency. In addition, an automatic tuning loop can be implemented to adjust the center frequency. These features result in a high quality receiver which can dynamically support different communication standards, modulation schemes and data rates.

By changing the gain of the biquad stages, the complex filter can perform as a PGA in the signal path of the receiver. This assures that the output swing of the complex filter remains constant when the receiver input signal changes. Moreover, adaptivity is achieved through dynamic programming of the bandwidth and center frequency. By way of example, when the receive environment is less noisy, the transmitter may switch to a higher data rate, and the bandwidth of the complex filter should increase proportionally. The center frequency, on the other hand, may be changed to increase the receiver immunity to blockers and other interferers.

The center frequency of each biquad stage is equal to $2Q/RC$. The quality factor, Q , is precisely set, since it is determined by the ratio of two resistors (R_f and R_c in figure 10), which can be accurately established when the resistors are implemented on-chip. However, the RC product varies by temperature and process variations, and therefore, may be compensated by automatic tuning methods.

Referring to Figure 12(a), each capacitor can be implemented with a capacitor connected in parallel with a number of switchable capacitors 150, 152, 154, 156. The capacitance, and thereby the center frequency of the complex filter, can be varied by selectively switching in or out the capacitors based on a four-bit binary code. Each bit is used to switch one of the parallel capacitors from the circuit. In the described exemplary embodiment, the capacitor 148 provides a capacitance of $C_u/2$. Capacitor 150 provides a capacitance of $C_u/2$. Capacitor 152 provides a capacitance of $C_u/4$. Capacitor 154 provides a capacitance of $C_u/8$. Capacitor 156 provides a capacitance of $C_u/16$. This provides $\pm 50\%$ tuning range with $\pm 3\%$ tuning accuracy.

Due to discrete nature of the tuning scheme, there may be some error in the center frequency ($\pm 1/(2 \times 2^n)$ for n-bit array). This inaccuracy can be tolerated with proper design.

Referring to Figure 12(b), each resistor can be implemented with a series of switchable resistors 158, 160, 162, 164, 166. Resistor 166 provides a resistance of R_u . Resistor 164 provides a resistance of $2 R_u$. Resistor 162 provides a resistance of $4 R_u$. Resistor 160 provides a resistance of $8 R_u$. Resistor 158 provides a resistance of $16 R_u$. In the described exemplary embodiment, the resistance can be varied between R_u and $31 \times R_u$ in incremental steps equal to R_u by selectively bypassing the resistor based on a five-bit binary code.

The center frequency of the complex filter can be adjusted by setting $1/R_u C_u$ equal to a reference frequency generated, by way of example, the crystal oscillator in the controller. The filter is automatically tuned by monotonic successive approximation as described in detail in Section 4.0 herein. Once the value of $R_u C_u$ is set, the complex filter characteristics depends only on four-bit code for the capacitors and the four-bit code for the resistors. For example, assume that the value of the resistors in the biquad stage of figure 6 is as following: $R_i = n_A R_u$, $R_f = n_Q R_u$, and $R_c = n_C R_u$. Likewise, assume that $C = n_C C_u$, where n_C is a constant, and that $1/R_u C_u = \omega_u$. The value of ω_u is set to a reference crystal by a successive approximation feedback loop. The filter frequency response for the received signal will be:

$$H(j\omega) = \frac{\frac{n_F}{n_A}}{1 + j n_C n_F R_u C_u \omega - j \frac{n_F}{n_Q}} \quad (16)$$

Therefore, the biquad stage gain (A), center frequency (ω_0), and bandwidth (BW) will be equal to:

$$A = \frac{n_F}{n_A} \quad (17)$$

$$\omega_0 = \frac{1}{n_C n_Q} \cdot \omega_u \quad (18)$$

$$BW = \frac{1}{n_C n_F} \cdot \omega_u \quad (19)$$

The above equations show that the characteristics of the biquad stage is independently programmed by varying n_A , n_F , and n_Q . For instance, by setting n_F , the gain of the biquad stage changes from $n_F/31$ to n_F by changing n_A from 1 to 31.

1.2.2 I-Q Monolithic Bandpass Filter

Alternatively, a low power I-Q monolithic bandpass filter can be used for the complex filter of the described exemplary embodiment of the present invention. The I-Q monolithic bandpass filter is useful for short-range communication applications. It also provides low power monolithic bandpass filtering for high data rates such as Bluetooth and HomeRF applications. The I-Q monolithic bandpass filter can be fully incorporated in monolithic channel select filters for 1-MHz data rates.

Figure 13 is a block diagram of the I-Q monolithic bandpass filter in accordance with an embodiment of the present invention. The I-Q monolithic bandpass filter includes a cascode of selectively intertwined biquads 168 and polyphase circuits 170. The biquads can be the same as the biquads described in Section 1.2.1 herein, or any other biquads known in the art. Similarly, the polyphase circuits can also be any conventional polyphase circuits known in the art. The biquad circuits can be 2nd order lowpass filters, which in conjunction with the polyphase circuits, exhibit a 1-MHz bandwidth bandpass filter with more than 45 dB rejection for all frequencies beyond 2 MHz away from the center of the band. The number of biquads determines the order of the I-Q monolithic bandpass filter. The polyphase filters are for wider

bandwidth and image rejection. The number of polyphase filters determines the number of zeros in the frequency response of the I-Q monolithic bandpass filter.

In the described embodiment, an 8'th order Butterworth filter is implemented in conjunction with selective side band filtering of polyphase circuits to create a low IF I-Q monolithic bandpass filter. The described embodiment of the I-Q monolithic bandpass filter does not suffer excessive group delay despite large bandwidth. The input IP3 can be better than 5dBm with a gain of more than 20 dB and the noise figure can be less than 40 dB. In fully integrated embodiments of the present invention, the I-Q monolithic bandpass filter can have on chip tuning capability to adjust for process, temperature and frequency variations.

1.3 Programmable Multiple Gain Amplifier

In one exemplary embodiment of the present invention, a programmable multiple gain amplifier is used in the receiver path between the complex filter and the complex IF mixer (see figure 2). The programmable multiple gain amplifier can be designed to be programmable to select between a limiter and an AGC feature. The programmable multiple gain amplifier, when operating as a limiter provides a maximum gain for frequency modulation applications. The programmable multiple gain amplifier, operating as an AGC, can be used for applications utilizing amplitude modulation.

Figure 14 shows a block diagram of an exemplary embodiment of the programmable multiple gain amplifier with an RSSI output. The RSSI output provides an indication of the strength of the IF signal. The programmable multiple gain amplifier includes three types of amplifiers. The input buffer is shown as a type I amplifier 900 and the type III amplifier 904 serves as the output buffer. The core amplifier is shown as a direct-coupled cascade of seven differential amplifiers 930, 931, 932, 933, 934, 935, 936. The core amplifier includes seven bypass switches 930', 931', 932', 933', 934', 935', 936', one bypass switch connected across each differential amplifier. The bypass switches provide programmable gain under control of the controller (see Figure 2).

When the programmable gain amplifier is operating as a limiter, all the bypass switches will be opened by the controller. Conversely, when the programmable gain amplifier is operating in the AGC mode, the output gain of the core amplifier will be varied by controlling the bypass

switch positions to prevent saturation of the core amplifier by large signals. In the described exemplary embodiment, the RSSI signal is fed back to control the bypass switch positions through a digital AGC loop in the external processing device. The AGC loop provides information to the controller 16 via the control bus 17 regarding the optimum gain reduction (see Figure 2). The controller translates the information from the external processing device into a digital signal for controlling the bypass switch positions of the core amplifier accordingly. The larger the RSSI signal, the greater the gain reduction of the core amplifier will be and the more bypass switches that will be closed by the controller.

In one embodiment of the programmable gain amplifier, the type I and type III amplifiers can be the same. Figure 15 shows one possible construction of these amplifiers. In this configuration, transistors 952, 954 provide amplification of the differential input signal. The differential input signal is fed to the gates of transistor amplifiers 952, 954, and the amplified differential output signal is taken from the drains. The gain of the transistor amplifiers 952, 954 is set by load resistors 956, 958. Transistors 960, 962 provide a constant current source for the transistor amplifiers 952, 954. The load resistors 956, 958, connected between the drain of their respective transistor amplifiers 952, 954 and a common gate connection of transistors 960, 962, provides a bias current source to common mode feedback.

Turning back to Figure 14, the type II core amplifier 902 includes a direct-coupled cascade of seven differential amplifiers 930, 931, 932, 933, 934, 935, 936, each with a voltage gain, by way of example, 12 dB. The voltage at the output of each differential amplifier 930, 931, 932, 933, 934, 935, 936 is coupled to a rectifier 937, 938, 939, 940, 941, 942, 943, 944, respectively. The outputs of the rectifiers are connected to ground through a common resistor 945. The summation of the currents from each of the rectifiers flowing through the common resistor provides a successive logarithmic approximation of the input IF voltage. With a 12 dB gain per each differential amplifier, a total cascaded gain of 84 dB is obtained. As those skilled in the art will appreciate, any number of differential amplifiers, each with the same or different gain, may be employed.

The input dynamic range of an RSSI is explained using the following derivation. Throughout this section, assume each rectifier has an ideal square law characteristic and its transfer function is:

$$y = \beta^2 V_{in}^2$$

(20)

Now, assume that S is the maximum input range of one differential amplifier and rectifier combination, whichever is smaller. This is determined with the lowest of the two values V_i and V_L that are the maximum input range of each differential amplifier, and the maximum input range of the rectifier, respectively.

$$S = \min(V_i, V_L)$$

(21)

Therefore, the RSSI maximum input level is S , and the ideal RSSI minimum input level is S/A^n , where A is the gain of each differential amplifier and n is the number of the differential amplifiers. Thus, the ideal dynamic range is calculated as follows:

$$\text{Ideal Dynamic Range} = 20 \log \frac{S}{\frac{S}{A^n}} = 20 \log A^n = 20(n) \log A \quad (22)$$

However, in the case of a large amount of gain, the input level will be limited with the input noise and the dynamic range will also be limited to:

$$\begin{aligned} \text{Dynamic Range} &= 20 \log \frac{S}{\sqrt{\sigma_n}} \\ \sqrt{\sigma_n} &= \text{total noise rms} \\ \sigma_n &= (BW) \times \text{Noise Factor} \end{aligned} \quad (23)$$

If each differential amplifier has the same input dynamic range V_L and each full-wave rectifier has similar input dynamic range V_i , then the dynamic range of the logarithmic differential amplifier and the total RSSI circuitry are the same.

The logarithmic approximations are provided by piecewise linear summation of the rectified output of each differential amplifier. This is done by segmentation of the input voltage by the power of $1/A$. Successively, each differential amplifier will reach the limiting point as the input signal grows by the power of A . Assuming each rectifier is modeled as shown in equation (20), the logarithmic approximation is modeled as following:

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For an input being in the following range:

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$$\frac{S}{A^{n-m}} < V_{in} < \frac{S}{A^{n-m-1}} \quad (24)$$

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up to the last m stages of the differential amplifier are all being limited and the rest of the differential amplifiers are in the linear gain region. Therefore, the RSSI is shown to be:

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$$A^2 \beta^2 v_{in}^2 + A^4 \beta^4 v_{in}^4 + \dots + A^{2(n-m)} \beta^{2(n-m)} v_{in}^{2(n-m)} + m \beta^2 S^2 = RSSI \quad (25)$$

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This is further simplified to:

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$$RSSI = \frac{(A\beta)^2}{(A\beta)^2 - 1} V_{in}^2 [(A\beta)^{2(n-m-1)} - 1] + m \beta^2 S^2 \quad (26)$$

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$$RSSI \approx \frac{1}{(A\beta)^2 - 1} V_{in}^2 (A\beta)^{2(n-m)} + m\beta^2 S^2 \quad (27)$$

The above equation is a first order approximation to the logarithmic function shown in equation (28) according to the first two terms of the Taylor expansion at a given operating point.

$$\text{Ideal } RSSI = C \log V_{in}^2 \quad (28)$$

The following calculates the constant C from the maximum and minimum of the RSSI:

$$\text{Max } RSSI - \text{Min } RSSI = C \log A^{2n} \quad (29)$$

$$\Delta RSSI = C \log A^{2n} \quad (30)$$

$$C = \frac{\Delta RSSI}{2n \log A} \quad (31)$$

$$(Ideal) RSSI = \frac{\Delta RSSI}{2n \log A} \log V_{in}^2 \quad (32)$$

To find the relation between the gain of a differential amplifier, the gain of a rectifier, and the maximum input range of the combined differential amplifier and the rectifier, the RSSI will be calculated for the two consecutive differential amplifier and rectifier combinations (see equations (33) and (34)) for both ideal RSSI equations (32) and approximated RSSI equation (27):

$$V_{in1} = \frac{S}{(A)^{n-m}} \quad (33)$$

$$V_{in2} = \frac{S}{(A)^{n-m-1}} \quad (34)$$

1

$$(Ideal) RSSI_2 - RSSI_1 = \log(A)^2$$

5

(35)

$$(Approximated) RSSI_2 - RSSI_1 = \beta^2 S^2$$

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(36)

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Therefore,

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$$C \log(A)^2 = \beta^2 S^2$$

(37)

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Using equations (18) and (12), the following expression is achieved:

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$$\frac{\Delta RSSI}{n} = \beta^2 S^2$$

(38)

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Plugging equation (19) into (8) results in the following:

$$RSSI = \frac{1}{(A\beta)^2 - 1} (A\beta)^{2(n-m)} V_{in}^2 + m \frac{\Delta RSSI}{n}; \frac{S}{A^{n-m}} < V_{in} < \frac{S}{A^{n-m-1}} \quad (39)$$

Figure 16(a) shows a schematic diagram for an exemplary embodiment of the differential amplifier used in the type II core amplifier. The differential input signal is fed to the gates of transistor amplifiers 955, 957. The amplified differential output signal is provided at the drains of the transistor amplifiers 955, 957. The gain of the transistor amplifiers is set by load transistors 958, 860, each connected between the drain of one of the transistor amplifiers and a power source. More particularly, the gain of the differential amplifier is determined by the ratio of the square root of transistor amplifiers-to-load transistors.

$$\begin{aligned} Gain(A) &= \sqrt{\frac{w_{in}}{w_{in}}} \\ &= \sqrt{\frac{200}{6}} \approx 5.8 \end{aligned} \quad (40)$$

The sources of the transistor amplifiers 955, 957 are connected in common and coupled to a constant current source transistor 952. In the described exemplary embodiment, the controller provides the bias to the gate of the transistor 952 to set the current.

An exemplary embodiment of the full-wave rectifier with two unbalanced source-coupled pairs cross-coupled is shown in Figure 16(b). In this embodiment, the differential input signal is fed to an unbalanced pair of transistors. One of the differential input pairs is fed to the gates

of the unbalanced transistor pair 968, 966 and the other differential input pair is fed to the gates of the other unbalanced transistor pair 964, 962. The drains of transistors 968, 962 are connected in common and provide one of the differential output pairs. The drains of transistors 964, 966 are connected in common and provide the other differential output pair. Transistors 968, 964 are connected in a common source configuration and coupled to a constant current source transistor 965. Transistors 962, 966 are also connected in a common source configuration with the common source connected to a current source transistor 967. The gates of the current sources 965, 967 are connected together. In the described exemplary embodiment, the controller provides the bias to the common gate connection to set the current.

Transistors 970 and 971 provide a current-mirror load to cross-coupled transistors 968, 962. Similarly, transistors 972, 973 provide a current-mirror load to cross-coupled transistors 962, 964. The current through the cross-coupled transistors 962, 964 is the sum of the current through the load transistor 972 and the current through the load transistor 971 which is mirrored from the load transistor 970. The current through the cross-coupled transistors 962, 962 is also mirrored to load transistor 973 for the RSSI output.

When the transistors 962, 964, 966, and 968 are operating in the saturation region, the following equations are shown for the differential output current DI_{SQB1} where k is the ratio of the two unbalanced source-coupled transistors:

$$\begin{aligned}
 \text{if } \Delta I_{SQM1} &= (I_{D1} + I_{D4}) - (I_{D2} + I_{D3}) \\
 &= 2(I_{DC} + I_{SQ}) \\
 &= 2 \frac{k-1}{k+1} I_o - 4 \frac{k(k-1)\beta_N}{(k+1)^2} V_I^2
 \end{aligned} \tag{41}$$

1

The input dynamic range of the full rectifier is then:

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$$\text{if } \Delta I_{SQMI} = 0, V_i = \pm \frac{\sqrt{I_o}}{\beta_N} \frac{\sqrt{k+1}}{2k} \quad (42)$$

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The full-wave rectifier includes two unbalanced differential pairs with a unidirectional current output. One rectifier 976 taps each differential pair and sums their currents into a 10 kW resistor R_L .

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The square law portion of equation (41) multiplied by the resistance provides the $\beta^2 S^2$ of equation (42):

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$$\beta^2 S^2 = 4 \frac{k(k-1)\beta_N}{(k+1)^2} V_i^2 R_L \quad (43)$$

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By plugging the V_i from equation (42) and replacing $\beta^2 S^2$ from equation (38), the following relation is obtained:

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$$\frac{\Delta RSSI}{n} = 2 \frac{k-1}{k+1} I_o R_L \quad (44)$$

For $\Delta RSSI=1V$, $n=7$ stages, $R_L=10000\Omega$, and $k=4$, from the above equation I_o is calculated to be 12 mA. Therefore, each rectifier will be biased with two 12 mA current sources (one 12 ma current source for the I signal and a second 12 ma current source for the Q channel). This results in an approximately logarithmic voltage, which indicates the received signal-strength (RSSI).

1.4 Complex IF Mixers

The IF down conversion to baseband signal can be implemented using four fully balanced quadrature mixers as shown in figure 17(a). This mixer configuration includes both quadrature inputs from the programmable multiple stage amplifier and quadrature IF clocks from the LO generator. This configuration produces single sideband, quadrature baseband signals, with minimum number of spurs at the output. These characteristics aid in relaxing the baseband filtering as well as simplifying the demodulator architecture. An IF mixer buffer 352 buffers the IF clock (Clk_I, Clk_Q as shown in figure 17(a)).

The outputs of the limiters are coupled to the quadrature clocks of the IF mixers (I_{in} for mixer 322, I_{in} for mixer 323, Q_{in} for mixer 324, Q_{in} for mixer 325) and the IF clocks are coupled to the data input of the IF mixers. This configuration minimizes spurs at the output of the IF mixers because the signal being mixed is the IF clocks which is a clean sine wave, and therefore, has minimal harmonics. The limiting action of the programmable multiple stage amplifier on the I and Q data will have essentially no effect on the spurs at the output of the IF mixers. Figure 17b shows the IF mixer clock signal spectrum which contains only odd harmonics. The IF signals do not have even harmonics in embodiments of the present invention using a fully differential configuration. The bandwidth of the $m^{th}(=2n+1)$ harmonic is directly

proportional to mfs, whereas its amplitude is inversely proportional to mfs. Figure 17c shows the sinusoidal input spectrum of the IF clocks. Figure 17d shows the IF mixer output spectrum.

1.5 Clock Generator

A clock generator can be used to generate a quadrature sinusoidal signal with controlled amplitude. The clock generator can be located in the receiver, or alternatively the LO Generator, and provides a clean sinusoidal IF from the square wave output of the divider in the LO Generator for downconverting the IF signal in the receiver path to baseband. Figure 18 shows a block diagram and signal spectrum of a clock generator. A sinusoidal signal is generated from a square-wave using cascaded polyphase. Figure 18 shows a clock generator block diagram. The clock generator outputs clk_I and clk_Q for the IF mixer buffer (see figure 17). The clock generator includes a polyphase filter at 3fs 360, a polyphase filter at 5fs 362, and a low pass filter 364. Figure 19a shows the input clock signal spectrum. Figure 19b shows the spectrum at 3fs 366 and at 5fs 368 polyphase. Figure 19c shows the sinusoidal signal generation after the low pass filter 364.

In fully integrated embodiments of the present invention, the controller can provide self calibration to generate precise signal levels with negligible dependency on the process variations. The two polyphase filters 360, 362 with RC calibration can be used to remove the first two odd harmonics of the signal. The remaining harmonics can be filtered with an on chip tunable low pass filter. The output of the clock generator block is a quadrature sinusoidal signal with controlled signal level. This spectrally clean signal is used at the input of complex IF mixers to downconvert the IF signal to baseband.

1.6 Programmable Low Pass Filter

The first major spurs out of downconversion process is at 4 times the IF frequency. A self calibrated 4fs polyphase filter can be used after the complex IF mixers to reduce the spurious and improve the linearity of the demodulator.

The polyphase filter can be implemented with two back to back polyphase to reject both positive phase and the negative phase. Built-in programmability can also be included for

operating with other frequencies. This capability enables the demodulator to be highly flexible. It can support wide range of incoming IF frequencies and with different modulation schemes.

Following the polyphase filter, a quadrature lowpass filter can be used to remove unwanted spurs. The lowpass filter can be programmable and designed to minimize group delay distortion without sacrificing high frequency filtering characteristics.

In fully integrated embodiments of the present invention, the controller can provide on chip RC calibration to minimize any process variation. The programmability of the polyphase filter and the low pass filter adds a new degree of flexibility to the system; it can be used to accommodate different data bandwidths.

Figure 20 shows a baseband spectrum filtering before the discriminator. Figure 20(a) shows the signal spectrum at polyphase input, i.e., the frequency spectrum of the polyphase filter. Figure 20(b) shows the signal spectrum at polyphase output, i.e. the frequency spectrum of the low pass filter. Figure 20(c) shows the signal spectrum at the low pass filter output.

1.7 High Data Rate Frequency Demodulator

The demodulator may take on various forms to accommodate different modulation schemes. One embodiment of the demodulation used in connection with the present invention includes a low power, monolithic demodulator for high data rates in frequency modulated systems. This demodulator can provide data recovery for well over 1-MHz data rates.

The demodulator can be FSK or GMSK demodulator. FSK is digital frequency modulation. GMSK is a specific type of FSK. GMSK stands for Gaussian filtered FSK modulation, which means that GMSK has gaussian filtering at the output of frequency modulation. GMSK has more stringent requirements than FSK. The data rate is higher for GMSK and the modulation index is low for GMSK relative to FSK.

The described embodiment of the demodulator is a low power, fully integrated FSK/GMSK demodulator for high data rates and low modulation index. The FSK operates with the programmable gain stage amplifier as a limiter, and therefore, does not require oversampling clocks or complex AGC blocks.

Figure 21 is a block diagram of an exemplary high data rate frequency demodulator in accordance with the present invention. The demodulator performs a balanced quadrature demodulation. Differentiators 329, 330 convert the baseband signal to a signal having an amplitude proportional to the baseband signal frequency. One differentiator 329 converts the I signal and the other differentiator 330 converts the Q signal. The I signal output of the differentiator 329 is coupled to a multiplier 331 where it is multiplied by the Q signal input into the demodulator. The Q signal output of the differentiator 330 is coupled to a multiplier 332 where it is multiplied by the I signal input into the demodulator. The multipliers 331, 332 produce a single ended DC signal. The DC signals are summed together by summation circuit 333. A peak detector/slicer 334 digitizes the DC signal from the summation circuit, thereby producing discrete zeros and ones.

The frequency discrimination can be performed using a differentiator as shown in Figure 22. A differential input signal is coupled to the input of an amplifier 340 through capacitors 341, 342. A feedback resistor 343, 344 is coupled between each differential output. Its operation is based on generating an output signal level linearly proportional to the incoming signal frequency. In other words, the higher the incoming frequency, the larger signal amplitude output by the differentiator. Therefore, it is desirable to have a spur free signal at the input of this stage. High frequency spurs can degrade the performance of the differentiator. By using the polyphase filter in conjunction with the lowpass filter (see Figure 2) before the demodulator, a nearly ideal baseband signal is input to the differentiator. The capacitors 341, 342 in the signal path with the resistive feedback operation of the amplifier is proportional to the time derivative of the input. For a sinusoidal input, $V(in)=A.\sin(\omega t)$, the output will be $V(out): d/dt(V(in))= \omega A.\cos(\omega t)$. Thus, the magnitude of the output increases linearly with increasing frequency.

The controller provides RC calibration to keep the differentiation gain process invariant. In order to reduce the effect of any high frequency coupling to the differentiator input, the differentiator gain is flattened out for frequencies beyond the band of interest. In addition to frequency discrimination, the differentiation process adds a 90 degrees phase shift to the incoming signal. This phase shift is inherent to differentiation process. Since the output is in quadrature phase with the input (except for differing amplitude), cross multiplication of the input and output results in frequency information.

Figure 23 shows an exemplary analog multiplier 331, 332 with zero higher harmonics in accordance with the present invention. Buffers one 334 and two 335 are added to a Gilbert cell to linearize the voltage levels. Buffers one 334 and two 335 convert the two inputs into two voltage levels for true analog multiplication using a Gilbert cell. The Gilbert cell is comprised of transistors 336, 338, resistors 340, 342 and cross-coupled pairs of transistors 344, 346 and transistors 348, 350.

By cross multiplying the input and the output signals to the differentiator, the amplitude information is generated. Since the signals are at baseband, it can be difficult to filter out any spurs resulting from the multiplication process. Linearized buffers can be used to minimize spurs by providing a near ideal analog multiplier. On chip calibration can also be used to control the multiplication gain and to minimize process variation dependency. In order to accommodate high data rates such as 1 MHz and beyond, all the stages should have low phase delays. In addition, matching all the delays in quadrature signals can be advantageous.

The output of the multiplier is a single ended DC signal which is a linear function of the frequency. This analog output can represent multilevel FSK with arbitrary modulation index. The minimum modulation index is only limited by wireless communication fundamentals.

An exemplary peak detector/slicer for frequency data detection is shown in Figure 24. The differential input signal is coupled to a peak detector 346 which detects the high peak. The differential input signal is also coupled to a second peak 347 detector which detects the low valley of the signal. The outputs of the peak detectors are coupled to a resistor divider network 348, 349 to obtain the average of the output signal. The average signal output from the resistor divider network is used as the calibrated zero frequency to obviate frequency offset problems due to the frequency translation process from IF to baseband.

A differential amplifier 345 is used to digitize the frequency information by comparing the differential input signal with the calibrated zero frequency. The output of the amplifier is a logic "1" if the baseband frequency is greater than the calibrated zero frequency and a logic "0" if the baseband frequency is less than the calibrated zero frequency. The output is amplified through several inverters 350 which in turn generate digital rail to rail output.

2.0. Transmitter

2.1 Differential Power Amplifier

In an exemplary embodiment of the invention, the PA is a differential PA as shown in figure 25. The symmetry of the differential PA in conjunction with other features supports implementation in a variety of technologies including CMOS. The described embodiment of the differential PA can be a fully integrated class A PA. A balun 610 is used to connect the PA to an antenna or a duplexer. The balun converts the differential signal to a single-ended output.

The described embodiments of the differential PA is a two stage device. The two stages minimize backward leakage of the output signal to the input stage. As those skilled in the art will appreciate, any number of stages can be implemented depending on the particular application and operating environment. Equal distribution of gain between the two stages helps prevent oscillation by avoiding excess accumulation of gain in one stage. A cascode architecture may be incorporated into the PA to provide good stability and insulation.

The input stage or pre-amplifier of the power amplifier includes an input differential pair comprising amplifying transistors 612, 614. Transistor 616 is a current source that biases the input differential pair. The presence of a current source provides many positive aspects including common mode rejection. The current is controlled by the voltage applied to the gate of transistor 616. The gate voltage should be chosen to prevent the transistor 616 from operating in the triode region. Triode operation of transistor 616 has a number of drawbacks. Primarily, since transistor 616 is supposed to act as a current source, its operation in the triode region can cause distortion in the current flowing into the transistor 612 and the transistor 614, and consequently gives rise to nonlinearity in the signal. Secondly, the triode behavior of transistor 616 will depend on temperature and process variations. Therefore, the circuit operation will vary over different process and temperature corners.

Cascode transistors 618, 620 provide stability by isolating the output from the input. As a result, no change in the input impedance occurs over frequency. The gates of the cascode transistors 618, 620 devices are biased through a bond wire. A resistor 622 in series with the gates of the cascode transistors prevents the inductance associated with the bonding from resonating with the input capacitance of the transistors, thereby improving stability. The resistor

622 in combination with the gates of transistors 618, 620 also improves common mode rejection and makes the transistor input act like a virtual ground at RF. Resistor 623 isolates the power supply from the PA and provides common mode rejection by increasing the symmetry of the differential PA. Inductors 624, 626 tune out the capacitance at the drains of the transistors 618, 620. At the tuning frequency, the impedance seen at the drains of the transistors 618, 620 is high, which provides the high gain at the tuning frequency.

The differential output of the input stage is provided at the drains of the cascode transistors 618, 620 to AC coupling capacitors 628, 630. Capacitor 628 couples the drain of transistor 618 with the gate of transistor 632. Capacitor 630 couples the drain of transistor 620 with the gate of transistor 634. The transistors 632, 634 provide amplification for the second stage of the PA. Resistors 636, 638 are biasing resistors for biasing the transistors 632, 634.

In the output stage of the PA, the current level is higher and the size of the current source should be increased to maintain the same bias situation. However, large tail devices can lower the common mode rejection. Accordingly, instead of a current source, an inductor 640 can be used to improve the headroom. The inductor 640 is a good substitute for a current source. The inductor 640 is almost a short circuit at low frequencies and provides up to 1Kohm of impedance at RF. By way of example, a 15nH inductor with proper shielding (to increase the Q) and a self-resonance frequency close to 4.5GHz can be used for optimum high frequency impedance and sufficient self-resonance.

Inductors 622, 624 tune out the capacitance at the drains of transistors 632, 634. Capacitors 642, 644 are AC coupling capacitors. Inductors 646 and capacitor 648 match the output impedance of the PA to the antenna, by way of example, 50 Ω . Similarly, inductors 650 and capacitor 652 match the output impedance of the PA to the antenna. Balun 610 is a differential to single-ended voltage converter. Resistance 654 is representative of the load resistance.

Capacitances associated with bias resistors may also be addressed. Consider a typical distributed model for a polysilicon ("poly" for short) resistor. Around 4fF to substrate can be associated with every kilo-ohm of resistance in a poly resistor. This means that, for example in a 20Kohm resistor, around 80fF of distributed capacitance to the substrate exists. This can contribute to power loss because part of the power will be drained into the substrate. One way

of biasing the input stage and the output stage is through a resistive voltage divider as shown in figure 26(a). The biasing of the input stage is shown for the transistor 616 in figure 25, however, those skilled in the art will readily appreciate that the same biasing circuit can be used for the transistor 614 (figure 25). One drawback from this approach, however, is that the gate of the transistor will see the capacitance from the two resistors 658, 660 of the voltage divider. Capacitor 662 is a coupling capacitor, which couples the previous stage to the voltage divider. Switch 664 is for powering down the stage of the power amplifier that is connected to the voltage divider. The switch 664 is on in normal operation and is off in power down mode.

Figure 26(b) is similar to figure 26(a), except that figure 26(b) includes resistor 666. DC-wise the figure 26(a) and figure 26(b) circuits are the same. However, in AC, not only is the resistance seen from the gates of transistors 634, 632 towards the resistive bias network bigger, but the capacitance is smaller because the capacitance is caused by resistor 666 and not resistors 660, 658. Since there is less capacitance, there is less loss of the signal. From figure 25, transistors 618, 620 in the input stage and transistors 632, 634 in the output stage can be biased by the resistive voltage divider shown in figure 26(b).

Figure 27 shows an exemplary bias circuit for the current source transistor 616 of figure 25. To fix the bias current of the circuit over temperature and process variation, a diode-connected switch transistor 672 may be used with a well-regulated current 670. The voltage generated across the diode-connected transistor 672 is applied to the gate of the current source transistor 616. Because of the mirroring effect of this connection and since all transistors move in the same direction over temperature and process corners, the mirrored current will be almost constant. The reference current is obtained by calibration of a resistor by the controller. The calibrated resistor can be isolated from the rest of the PA to prevent high frequency coupling through the resistor to other transceiver circuits. As those skilled in the art will appreciate, the exemplary bias circuit is not limited to the current source transistor of the PA and may be applied to other transistors requiring accurate biasing currents.

Figure 28 shows an exemplary power control circuit. The power control circuit can provide current scaling. The power control circuit changes power digitally by controlling the bias of the current source transistor 616 of the first differential pair 612, 614 in the PA (figure 25). The power control circuit can be used in any application requiring different power levels. The power control is done by applying different voltage levels to the gate of the current source in the

first stage (input stage or preamplifier) of the PA. A combination of current adjustment in both stages (input stage and output stage) of the PA can also be done. Different voltage levels are generated corresponding to different power levels. In one embodiment of the invention, the power control circuit has four stages as shown in figure 28. Alternatively, the power control circuit can have any number of stages corresponding to the number of power levels needed in an application.

The power control circuit includes transistor pairs in parallel. Transistors 674, 676, 678, 680 are switch transistors and are coupled to diode-connected transistors 682, 684, 686, 688, respectively. The switch transistors 674, 676, 678, 680 are coupled to a current source 670. Each diode-connected transistor 682, 684, 686, 688 can be switched into the parallel combination of by turning its respective switching transistor on. Conversely, any diode-connected transistor can be removed from the parallel combination by turning its respective switch transistor off. The current from the current source 670 is injected into a parallel combination of switch transistors 674, 676, 678, 680. The power level can be incremented or decremented by switching one or more switch transistors into the parallel combination. By way of example, a decrease in the power level can be realized by switching a switch transistor into the parallel combination. This is equivalent to less voltage drop across the parallel combination, which in turn corresponds to a lower power level. A variety of stages are comprehended in alternative embodiments of the invention depending on the number of power levels needed for a given application. A thermometer code from the controller can be applied to the power control circuit according to which the power level is adjusted.

As described above, the output of the PA can be independently matched to a 50ohm load. The matching circuit (inductors 646, 650 and capacitors 648, 652) is connected to the balun. Any non-ideality of the balun, bond wire impedance, pin/PCB capacitance, and other parasitics can be absorbed by the matching circuits. High-Q inductors can be used where possible. The loss in efficiency may also be tolerable with low power applications.

2.2 Single-Ended Differential Power Amplifier

In another embodiment of the present invention, the balun can be eliminated by a single-ended to differential PA. Figure 29 shows the output stage of a single-ended to differential PA. The output stage includes resistors 690, 692, inductors 694, 696, 698, and transistors 700, 702.

Coupling capacitor 704 couples the output stage to an LC circuit, the LC circuit including inductor 706 and capacitor 708. Coupling capacitor 710 couples the second stage to a CL circuit, the CL circuit comprising capacitor 712 and inductor 714. The transistors 700, 702 provide amplification of the differential signal applied to the output stage of the PA. The output of the amplifying transistors 700, 702 produces two signals 180 degrees out of phase. The LC circuit is used to match the first output to a 100 ohm load 718 and to shift the phase of the signal by 90 degrees. The CL circuit is deployed to match the second output to a 100 ohm load 720, and to shift the phase of the signal in the opposite direction by 90 degrees. Since the two outputs were out of phase by 180 degrees at the beginning and each underwent an additional 90 degrees of shift (in opposite directions) the two signals appearing across the two 100 ohm loads will be in phase. In an ideal situation, they will also be of similar amplitudes. This means that the two nodes can be connected together to realize a single-ended signal matched for a 50 ohm load 716.

Unlike the differential PA, the differential to single-ended configuration does not enjoy the symmetry of a fully differential path. Accordingly, with respect to embodiments of the present invention integrated into a single IC, the effect of bond wires should be considered. Because of stability and matching issues, a separate ground (bond wire) for the matching circuit should be used. The bond wires should be small and the matching should be tweaked to cancel their effect.

The bias current to the amplifying transistors 700, 702 for embodiments of the present invention integrated into a single IC can be set in a number of ways, including by way of example, the bias circuit shown in figure 27. The voltage generated across the diode-connected transistor 672 is applied to the gate of the amplifying transistor 700. A similar bias circuit can be used for biasing the amplifying transistor 702.

Alternatively, the bias circuit of the amplifying transistors 700, 702 for single IC embodiments can be set with a power control circuit as shown in figure 28. The current source is connected directly the amplifying transistor 700. By incrementally switching the diode-connected transistors 682, 684, 686, 688 into the parallel combination, the voltage applied to the gate of the amplifying transistor 700 is incrementally pulled down toward ground. Conversely, by incrementally switching the diode-connected transistors 682, 684, 686, 688 out of the parallel combination, the voltage applied to the gate of the amplifying transistor 700 is incrementally

pulled up toward the source voltage (not shown). A similar power control circuit can be used with the amplifying transistor 702.

2.3. Digitally Programmable CMOS PA with On-Chip Matching

In another embodiment of the present invention, a PA is integrated into a single IC with digitally programmable circuitry and on-chip matching to an external antenna, antenna switch, or similar device. Figure 30 shows an exemplary PA with digital power control. This circuit comprises two stages. The input stage provides initial amplification and acts as a buffer to isolate the output stage from the VCO. The output stage is comprised of a switchable differential pair to steer the current towards the load. The output stage also provides the necessary drive for the antenna. The power level of the output stage can be set by individually turning on and off current sources connected to each differential pair.

Transistors 722, 724 provide initial amplification. Transistor 726 is the current source that biases the transistors 722, 724. Inductors 728, 730 tune out the capacitance at the drains of the transistors 722, 724. At the tuning frequency, the impedance seen at the drains is high, which provides high gain at the tuning frequency.

Capacitors 732, 736 are AC coupling capacitors. Capacitor 732 couples the drain of transistor 724 with the gate of transistor 734. Capacitor 736 couples the drain of transistor 722 with the gate of transistor 738. Resistors 740, 742 are biasing resistors for biasing the gates of the transistors 734, 738. Transistors 734, 738 are amplifying transistors in the output stage of the PA. Transistor pairs 744, 746, transistor pairs 748, 750, and transistor pairs 752, 754 each provide additional gain for the signal. Each pair can be switched in or out depending on whether a high or low gain is needed. For maximum gain each transistor pair in the output stage of the PA will be switched on. The gain can be incrementally decreased by switching out individual transistor pairs. The PA may have more or less transistor pairs depending on the maximum gain and resolution of incremental changes in the gain that is desired.

Transistor 756 has two purposes. First, it is a current source that biases transistors 734, 738. Second, it provides a means for switching transistors 734, 738 in and out of the circuit to alter the gain of the output stage amplifier. Each transistors 758, 760, 762 serves the same purpose for its respective transistor pair. A digital control, word from the controller can be

applied to the gates of the transistors 756, 758, 760, 762 to digitally set the power level. This approach provides the flexibility to apply ramp up and ramp down periods to the PA, in addition to the possibility of digitally controlling the power level. The drains of the transistors 756, 758, 760, 762 are connected to a circuit that serves a twofold purpose: 1) it converts the differential output to single ended output, and 2) it matches the stage to external 50 ohm antenna to provide maximum transferable gain.

Inductors 764, 766 tune out the capacitance at the drains of transistors 752, 754. Capacitor 768 couples the PA to the load 770. Inductor 772 is a matching and phase-shift element, which advances the phase of the signal by 90° . Capacitor 794 is a matching and phase-shift element, which retards the phase of the signal by 90° . Capacitor 796 is the pad capacitance. The bonding wire 798 bonds the PA to the load resistance 770 (e.g., the antenna).

3.0 Local Oscillator

In embodiments of the present invention utilizing a low-IF or direct conversion architecture, techniques are implemented to deal with the potential disturbance of the local oscillator by the PA. Since the LO generator has a frequency which coincides with the RF signal at the transmitter output, the large modulated signal at the PA output may pull the VCO frequency. The potential for this disturbance can be reduced by setting the VCO frequency far from the PA output frequency. To this end, an exemplary embodiment of the LO generator produces RF clocks whose frequency is close to the PA output frequency, as required in a low-IF or direct-conversion architectures, with a VCO operating at a frequency far from that of the RF clocks. One way of doing so is to use two VCO 864, 866, with frequencies of f_1 and f_2 respectively, and mix 868 their output to generate a clock at a higher frequency of f_1+f_2 as shown in figure 31(a). With this approach, the VCO frequency will be away from the PA output frequency with an offset equal to f_1 (or f_2). A bandpass filter 876 after the mixer can be used to reject the undesired signal at f_1-f_2 . The maximum offset can be achieved when f_1 is close to f_2 .

An alternative embodiment for generating RF clocks far away in frequency from the VCO is to generate f_2 by dividing the VCO output by N as shown in Figure 31(b). The output of the VCO 864 (at f_1) is coupled to a divider 872. The output of the divider 872 (at f_2) is mixed with the VCO at mixer 868 to produce an RF clock frequency equal to: $f_{LO} = f_1'(1+1/N)$, where f_1 is

the VCO frequency. A bandpass filter 874 at the mixer output can be used to reject the lower sideband located at $f_1 - f_I/N$.

In another embodiment of the present invention, a single sideband mixing scheme is used for the LO generator. Figure 32 shows a single sideband mixing scheme. This approach generates I and Q signals at the VCO 864 output. The output of the VCO 864 is coupled to a quadrature frequency divider 876 should be able to deliver quadrature outputs. Quadrature outputs will be realized if the divide ratio (N) is equal to two to the power of an integer ($N = 2^n$). The I signal output of the divider 876 is mixed with the I signal output of the VCO 864 by a mixer 878. Similarly, the Q signal output of the divider 876 is mixed with the Q signal output of the VCO 864 by a mixer 880.

Although a single sideband structure uses two mixers, this should not double the mixer power consumption, since the gain of the single sideband mixer will be twice as much. By utilizing a Gilbert cell (i.e., a current commutating mixer) for each mixer 878, 880, the addition or subtraction required in a single sideband mixer can be done by connecting the two mixers 878, 880 outputs and sharing a common load (e.g., an LC circuit). The current from the mixers is added or subtracted, depending on the polarity of the inputs, and then converted to a voltage by an LC load (not shown) resonating at the desired frequency.

Figure 33 shows an LO generator architecture in accordance with an embodiment of the present invention. This architecture is similar to the architecture shown in figure 32, except that the LO generator architecture in figure 33 generates I-Q data. In a low-IF system, a quadrature LO is desirable for image rejection. In the described embodiment, the I and Q outputs of the VCO can be applied to a pair of single sideband mixer to generate quadrature LO signals. A quadrature VCO 48 produces I and Q signals at its output. Buffers are included to provide isolation between the VCO output and the LO generator output. The buffer 884 buffers the I output of the VCO 48. The buffer 886 buffers the Q output of the VCO 48. The buffer 888 combines the I and Q outputs of the buffers 884, 886. The signal from the buffer 888 is coupled to a frequency divider 890 where it is divided by N and separated into I and Q signals. The I-Q outputs of the divider 890 are buffered by buffer 892 and buffer 894. The I output of the divider 890 is coupled to a buffer 892 and the Q signal output of the divider 890 is coupled to a buffer 894. A first mixer 896 mixes the I signal output of the buffer 892 with the I signal output of the buffer 884. A second mixer 897 mixes the Q signal output from the buffer 894 with Q signal output from the

buffer 886. A third mixer 898 mixes the Q signal output of the buffer 894 with the I signal output of the buffer 884. A fourth mixer 899 mixes the I signal output from the buffer 892 with the Q signal output from the buffer 886. The outputs of the first and second mixers 896, 897 are combined and coupled to buffer 900. The outputs of the third and fourth mixers 898, 899 are combined and coupled to buffer 902. LC circuits (not shown) can be positioned at the output of each buffer 900, 902 to provide a second-order filter which rejects the spurs and harmonics produced due to the mixing action in the LO generator.

Embodiments of the present invention which are integrated into a single IC may employ buffers configured as differential pairs with a current source to set the bias. With this configuration, if the amplitude of the buffer input is large enough, the signal amplitude at the output will be rather independent of the process parameters. This reduces the sensitivity of the design to temperature or process variation.

The lower sideband signal is ideally rejected with the described embodiment of the LO generator because of the quadrature mixing. However, in practice, because of the phase and amplitude inaccuracy at the VCO and divider outputs, a finite rejection is obtained. In single IC fully integrated embodiments of the present invention, the rejection is mainly limited to the matching between the devices on chip, and is typically about 30-40 dB. Since the lower sideband signal is $2 \times f_1/N$ away in frequency from the desired signal, by proper choice of N, it can be further attenuated with on-chip filtering.

Because of the hard switching action of the buffers, the mixers will effectively be switched by a square-wave signal. Thus, the divider output will be upconverted by the main harmonic of VCO (f_1), as well as its odd harmonics ($n \times f_1$), with a conversion gain of $1/n$. In addition, at the input of the mixer, because of the nonlinearity of the mixers, and the buffers preceding the mixers, all the odd harmonics of the input signals to the mixers will exist. Even harmonics, both at the LO and the input of the mixers can be neglected if a fully balanced configuration is used. Therefore, all the harmonics of VCO ($n \times f_1$) will mix with all the harmonics of input ($m \times f_2$), where f_2 is equal to f_1/N . Because of the quadrature mixing, at each upconversion only one sideband appears at the mixer output. Upper or lower sideband rejection depends on the phase of the input and LO at each harmonic. For instance, for the main harmonics mixed with each other, the lower sideband is rejected, whereas when the main harmonic of the VCO mixes with the third harmonic of the divider output signal, the upper sideband is rejected.

Table 1 gives a summary of the cross-modulation products up to the 5th harmonic of the VCO and input. In each product, only one sideband is considered, since the other one is attenuated due to quadrature mixing, and is negligible.

All the spurs are at least $2 \times f_1/N$ away from the main signal located at $f_1 \times (1+1/N)$. The VCO frequency will be f_1/N away from the PA output. Thus, by choosing a smaller N better filtering can be obtained. In addition, the VCO frequency will be further away from the PA output frequency. The value of N, and the quality factor (Q) of the resonators (not shown) positioned at the output of each component determine how much each spur will be attenuated. The resonator quality factor is usually set by the inductor Q, and that depends merely on the IC technology. Higher Q provides better filtering and lower power consumption.

	1 st : f_1/N	3 rd : $3f_1/N$	5 th : $5f_1/N$
1 st : f_1	$f_1 \times (1+1/N)$	$f_1 \times (1-3/N)$	$f_1 \times (1+5/N)$
3 rd : $3f_1$	$f_1 \times (3-1/N)$	$f_1 \times (3+3/N)$	$f_1 \times (3-5/N)$
5 th : $5f_1$	$f_1 \times (5+1/N)$	$f_1 \times (5-3/N)$	$f_1 \times (5+5/N)$

Table 1: Cross-Modulation Products at the LO Generator Output

The maximum filtering is obtained by choosing $N = 1$. Moreover, in this case, the frequency divider is eliminated. This lowers the power consumption and reduces the system complexity of the LO generator. However, the choice of $N = 1$ may not be practical for certain embodiments of the present invention employing a low-IF receiver architecture with quadrature LO signals. The problem arises from the fact that the third harmonic of the VCO (at $3f_1$) mixed with the divider output (at f_1) also produces a signal at $2f_1$ which has the same frequency as the main component of the RF clock output from the LO generator. With the configuration shown in figure 33, the following relations hold for the main harmonics:

$$\cos(\omega_1 t) \cdot \cos(\omega_1 t) - \sin(\omega_1 t) \cdot \sin(\omega_1 t) \rightarrow \cos(2\omega_1 t) \quad (45)$$

and

$$\cos(\omega_1 t) \cdot \sin(\omega_1 t) + \sin(\omega_1 t) \cdot \cos(\omega_1 t) \rightarrow \sin(2\omega_1 t) \quad (46)$$

which show that at the output of the mixers, quadrature signals at twice the VCO frequency exist. For the VCO third harmonic mixed with the divider output, however, the following relations hold:

$$-\cos(\omega_1 t) \cdot 1/3 \cos(3\omega_1 t) - \sin(\omega_1 t) \cdot 1/3 \sin(3\omega_1 t) \rightarrow -1/3 \cos(2\omega_1 t) \quad (47)$$

and

$$\cos(\omega_1 t) \cdot 1/3 \sin(3\omega_1 t) - \sin(\omega_1 t) \cdot 1/3 \cos(3\omega_1 t) \rightarrow -1/3 \sin(2\omega_1 t) \quad (48)$$

The factor 1/3 appears in the above equations because the third harmonic of a square-wave has an amplitude which is one third of the main harmonic. Comparing equation (46) with equation (48), the two products are added in equation (46), while they are subtracted in equation (47). The reason is that for the main harmonic of the VCO, quadrature outputs have phases of 0 and 90°, whereas for the third harmonic, the phases are 0 and 270°. The same holds true for equation (45) and equation (47). The two cosines in equation (45) and equation (47), when added, give a cosine at $2\omega_1$ with an amplitude of 2/3, yet the two sinewaves in equation (46) and equation (48) when added, give a component at $2\omega_1$ with an amplitude of 4/3. Therefore, a significant amplitude imbalance exists at the I and Q outputs of the mixers. When these signals pass through the nonlinear buffer at the mixers output, the amplitude imbalance will be reduced. However, because of the AM to PM conversion, some phase inaccuracy will be introduced. The accuracy

can be improved with a quadrature generator, such as a polyphase filter, after the mixers. A polyphase filter, however, is lossy, especially at high frequency, and it can load its previous stage considerably. This increases the LO generator power consumption significantly, and renders the choice of $N = 1$ unattractive for embodiments of the present invention employing a low-IF receiver architecture with quadrature LO signals.

For $N = 2$, the LO generator output will have a frequency of $1.5f_1$, and the closest spurs will be located $\pm f_1$ away from the output. These spurs can be rejected by positioning LC filters (not shown) at the output of each circuit in the LO generator. A second-order LC filter tuned to f_0 , with a quality factor Q , rejects a signal at a frequency of f as given in the following equation:

$$|H(f)| = \frac{\frac{f}{Qf_0}}{\sqrt{\left[1 - \left(\frac{f}{f_0}\right)^2\right]^2 + \left(\frac{f}{Qf_0}\right)^2}} \quad (49)$$

The following discussion changes based on the Q value. Considering a Q of about 5 for the inductor, with $f_0 = 1.5f_1$, the spur located at $2.5f_1$ is rejected by about 15 dB by each LC circuit. This spur is produced at the LO generator output due to the mixing of the VCO third harmonic (at $3f_1$) with the divider output (at $0.5f_1$). This signal is attenuated by 10 dB since the third harmonic of a square-wave is one third of the main harmonic, 15 dB at the LC resonator at the mixers output tuned to $1.5f_1$, and another 15 dB at the output of the buffers (900, 902 in figure 33). This gives a total rejection of 40 dB. When applied to the mixers in the transmitter, this LO generator output will upconvert the baseband data to $2.5f_1$. With LC filters (not shown) positioned at the upconversion mixers and PA output in the transmitter, another $15+15 = 30$ dB rejection is obtained (figure 33).

The spur located at $0.5f_1$ is produced because of the third harmonic of the divider output (at $1.5f_1$) is mixed with the VCO output (at f_1). Because of the hard switching action at the divider output, the third harmonic is about 10 dB lower than the main harmonic at $0.5f_1$. The

buffer at the divider output tuned to $0.5f_1$ (892, 8943 in figure 33), rejects this signal by about 22 dB (equation (24)). This spur can be further attenuated by LC circuits at the mixer and its buffer output by $(2)(22) = 44$ dB. The total rejection is 76 dB.

Figure 33(a) shows a signal passing through a limiting buffer 910 (such as the buffers implemented in the LO generator). When a large signal at a frequency of f accompanied with a small interferer at a frequency of Δf 902 away pass through a limiting buffer, at the limiter output the interferer produces two tones $\pm \Delta f$ 914, 916 away from the main signal, each with 6 dB lower amplitude. Therefore, the spur at $2.5f_1$ will actually be $10+15+15+6 = 46$ dB attenuated when it passes through the buffer, instead of the 40 dB calculated above. It will also produce an image at $0.5f_1$ which is $10+15+22+6 = 53$ dB lower than the main signal. This will dominate the spur at $0.5f_1$ because of the third harmonic of the divider mixed with the VCO signal, which is more than 75 dB lower than the main signal.

Since the buffer is nonlinear, another major spur at the LO generator output is the third harmonic of the main signal located at $3 \times 1.5f_1$. This signal will be $10+22 = 32$ dB lower than the main harmonic. The 22 dB rejection results from an LC circuit (not shown) tuned to $1155f_1$ (equation (49)) in the buffer. This undesired signal will not degrade the LO generator performance, since even if a perfect sinewave is applied to upconversion (or downconversion) mixers, due to hard switching action of the buffer, the mixer is actually switched by a square-wave whose third harmonic is only 10 dB lower. Thus, if a nonlinear PA is used in the transmitter, even with a perfect input to the PA, the third harmonic at the transmitter output will be $10+22+10 = 42$ dB lower. The first 10 dB is because the third harmonic of a square-wave is one third of the main one, the 22 dB is due to the LC filter at the PA output, and the last 10 dB is because the data is spread in the frequency domain by three times. Any DC offset at the mixer input in the transmitter is upconverted by the LO, and produces a spur at f_1 . This spur can be attenuated by 13 dB for each LC circuit used (equation (49)). In addition, the signal at the mixer input in the transmitter is considerably larger (about 10-20 times) than the DC offset. Thus the spur at f_1 will be about $13+13+26 = 52$ dB lower than the main signal. All other spurs given in Table 1 are more than 55 dB lower at the LO generator output. The dominant spur is the one at $2.5f_1$ which is about 46 dB lower than the main signal.

Choosing $N > 2$ may not provide much benefit for single IC embodiments of the present invention with the possible exception that the on-chip filtering requirements may be relaxed.

When using an odd number for N, further disadvantages may be realized because the divider output will not be in quadrature thereby preventing single sideband mixing. In addition, for N > 2 the divider becomes more complex and the power consumption increases. Nevertheless, in certain applications, N = 4 may be selected over N = 2 so that the divider quadrature accuracy will not depend on the duty cycle of the input signal.

When choosing N equal to 2^n , such as N = 2, quadrature signals are readily available at the divider output despite quadrature phase inaccuracies at the output of the VCO. Assume that the VCO outputs have phase of 0 and $90^\circ + q$, where q is ideally 0, and that the divider produces perfect quadrature outputs. At the LO generator outputs the following signals exist:

$$V_{out_I} = \cos(\omega_2 t) \cdot \cos(\omega_1 t + \theta) - \sin(\omega_2 t) \cdot \sin(\omega_1 t)$$

(50)

and

$$V_{out_Q} = \cos(\omega_2 t) \cdot \sin(\omega_1 t) + \sin(\omega_2 t) \cdot \cos(\omega_1 t + \theta)$$

(51)

where ω_1 is the VCO radian frequency, and ω_2 is the divider radian frequency, equal to $0.5\omega_1$. By simplifying equation (25) and equation (26), the signals at the output of mixers will be:

$$V_{out_I} = -\sin\left(\frac{\theta}{2}\right) \cdot \sin\left((\omega_1 - \omega_2)t + \frac{\theta}{2}\right) + \cos\left(\frac{\theta}{2}\right) \cdot \cos\left((\omega_1 + \omega_2)t + \frac{\theta}{2}\right) \quad (52)$$

and

$$V_{out_Q} = -\sin\left(\frac{\theta}{2}\right) \cdot \cos\left((\omega_1 - \omega_2)t + \frac{\theta}{2}\right) + \cos\left(\frac{\theta}{2}\right) \cdot \sin\left((\omega_1 + \omega_2)t + \frac{\theta}{2}\right) \quad (53)$$

The above equations show that regardless of the value of θ , the outputs are always in quadrature. However, other effects should be evaluated. First, a spur at $\omega_1 - \omega_2 = 0.5\omega_1$ is produced at the output. This spur can be attenuated by $2 \times 22 = 44$ dB by the LC filters at the mixer and its buffer outputs. Thus, for 60 dB rejection, the single sideband mixers need to provide an additional 16 dB of rejection (about 0.158). Based on equation (53), $\tan(\theta/2) = 0.158$, or $\theta \approx 18^\circ$, phase accuracy of better than 18° can generally be achieved. Second, phase error at the VCO output lowers the mixer gain (term $\cos(\theta/2)$ in equation (52) or (53)). For a phase error of 18° , the gain reduction is, however, only 0.1 dB, which is negligible. For $\theta = 90^\circ$ (a single-phase VCO), both sidebands are equally upconverted at the mixer output. However, the LC filters reject the lower sideband by about 44 dB. The mixer gain will also be 3 dB lower. This will slightly increase the power consumption of the LO generator. If $\theta = 180^\circ$ (the VCO I and Q outputs are switched), the lower sideband is selected, and the desired sideband is completely rejected.

Similarly, the LO generator will not be sensitive to the phase imbalance of the divider outputs if the VCO is ideal. However, if there is some phase inaccuracy at both the divider and VCO outputs, the LO generator outputs will no longer be in quadrature. In fact, if the VCO output has a phase error of q_1 and the divider output has a phase error of q_2 , the LO generator outputs will be:

$$V_{out_I} = -\sin\left(\frac{\theta_1 - \theta_2}{2}\right) \cdot \sin\left((\omega_1 - \omega_2)t + \frac{\theta_1 - \theta_2}{2}\right) + \cos\left(\frac{\theta_1 + \theta_2}{2}\right) \cdot \cos\left((\omega_1 + \omega_2)t + \frac{\theta_1 + \theta_2}{2}\right) \quad (54)$$

and

$$V_{out_Q} = -\sin\left(\frac{\theta_1 + \theta_2}{2}\right) \cdot \cos\left((\omega_1 - \omega_2)t + \frac{\theta_1 - \theta_2}{2}\right) + \cos\left(\frac{\theta_1 - \theta_2}{2}\right) \cdot \sin\left((\omega_1 + \omega_2)t + \frac{\theta_1 + \theta_2}{2}\right) \quad (55)$$

This shows that the outputs still have phases of 0 and 90°, but their amplitudes are not equal. The amplitude imbalance is equal to:

$$\frac{\Delta A}{A} = 2 \frac{\cos\left(\frac{\theta_1 + \theta_2}{2}\right) - \cos\left(\frac{\theta_1 - \theta_2}{2}\right)}{\cos\left(\frac{\theta_1 + \theta_2}{2}\right) + \cos\left(\frac{\theta_1 - \theta_2}{2}\right)} = 2 \tan\left(\frac{\theta_1}{2}\right) \times \tan\left(\frac{\theta_2}{2}\right) \quad (56)$$

If θ_1 and θ_2 are small and have an equal standard deviation, that is, the phase errors in the VCO and divider are the same in nature, then the output amplitude standard deviation will be:

$$\sigma_A \approx \frac{(\sigma_\theta)^2}{2}$$

(57)

where σ_A is the standard deviation of the output amplitude, and σ_θ is the phase standard deviation in radians. Equation (57) denotes that the phase inaccuracy in the VCO and divider has a second order effect on the LO generator. For instance, if θ_1 and θ_2 are on the same order and about 10° , the amplitude imbalance of the output signals will be only about 1.5%. In this case, the lower sideband will be about 15 dB rejected by the mixers, which will lead to a total attenuation of about $22+22+15 = 59$ dB. This shows that the LO generator is robust to phase errors at the VCO or divider outputs, since typically phase errors of less than 5° can be obtained on chip.

Phase errors in the divider can originate from the mismatch at its output. Moreover, for $N = 2$, if the input of the divider does not have a 50% duty cycle, the outputs will not be in quadrature. Again, the deviation from a 50% duty cycle in the divider input signal may be caused due to mismatch. Typically, with a careful layout, this mismatch is minimized to a few percent. The latter problem can also be alleviated by improving the common-mode rejection of the buffer preceding the divider (888 in figure 33). One possible way of doing so is to add a small resistor at the common tail of the inductors in the buffer. For a differential output, this resistor does not load the resonator at the buffer output, since the inductors common tail is at AC ground. A common-mode signal at the output is suppressed however, since this resistor degrades the LC circuit quality factor. The value of the resistor should be chosen appropriately so as not to produce a headroom problem in the buffer.

Embodiments of the present invention that are fully integrated onto a single IC can be implemented with a wide tuning range VCO with constant gain. In a typical IC process, the capacitance can vary by 20%. This translates to a 10% variation in the center frequency of the oscillator. A wide tuning range can be used to compensate for variation. Variations in temperature and supply voltage can also shift the center frequency. To generate a wide tuning range, two identical oscillators can be coupled together as shown in figure 34. This approach forces the oscillation to be dependent on the amount of coupling between the two oscillators.

In the described exemplary embodiment of the VCO shown in figure 34, the tuning curve is divided into segments with each segment digitally selected. This approach ensures a sufficient amount of coupling between the two oscillators for injection lock. In addition, good phase noise performance is also obtained. The narrow frequency segment prevents the gain of the VCO from saturating. The segmentation lowers the VCO gain by the number of segments, and finally by scaling the individual segments, a piecewise linear version of the tuning curve is made resulting in a constant gain VCO.

Figure 34 shows a block diagram of the wide tuning range VCO comprising two coupled oscillators where the amount of coupling transconductance is variable. The wide tuning range VCO comprises two resonators 800, 802 and four transconductance cells, g_m cells 804, 806, 808, 810. The transconductance cells are driver that converts voltage to current. The transconductance cells used to couple the oscillators together have a variable gain. The first VCO 800 provides the I signal and the second VCO provides the Q signal. The output of the first VCO 800 and the output of the second VCO 802 are coupled to transconductance cells 806, 807, respectively, combined, and fed back to the first VCO 800. The transconductance cell 807 used for feeding back the output of the second VCO to the first VCO is a programable variable gain cell. Similarly, the output of the second VCO 802 and the output of the first VCO 800 are coupled to transconductance cells 805, 804, respectively, combined, and fed back to the second VCO 802. The transconductance cell 804 used for feeding back the output of the first VCO to the second VCO is a programmable variable gain cell. The gain of the programmable variable gain transconductance cells 804, 807 can be digitally controlled from the controller

Figure 35 shows a schematic block diagram of the wide-tuning range VCO described in connection with figure 34. The wide-tuning range VCO includes individual current sources 810, 812, 814, 816, cross-coupled transistors 818, 820 with resonating inductors 826, 828, and cross-coupled transistors 822, 824 with resonating inductors 830, 832. Two differential pairs couple the two sets of oscillators. Differential pair 834, 836 are coupled to the drains of transistors 824, 822, respectively. Differential pair 838, 840 are coupled to the drains of transistors 818, 820. Tank #1 comprises inductors 826 and 828. Tank #2 comprises inductors 830 and 832.

Transistors 818 and 820 form a cross-coupled pair that injects a current into tank #1 in which the current through the transistor 818 is exactly 180 degrees out of phase with the current in the transistor 820. Likewise, transistors 822 and 824 form a cross-coupled pair that injects

1 a current into tank #2 in which the current through the transistor 822 is exactly 180 degrees out
of phase with the current in the transistor 824. The first set of coupling devices 834, 836 injects
a current into tank #1 that is 90 degrees out of phase with current injected respectively by the
5 transistors 818, 820. The second set of coupling devices 838, 840 injects a current into tank #2
that is 90 degrees out of phase with the current injected respectively by the transistors 822, 824.
The tank impedances causes a frequency dependent phase shift. By varying the amplitude of the
coupled signals, the frequency of oscillation changes until the phase shift through the tanks
results in a steady-state solution. Varying the bias of the current source controls the gm of the
10 coupling devices. Current sources 812, 816 provide control of VCO tuning. Current sources 810,
814 provide segmentation of the VCO tuning range.

Figure 36(a) shows the typical tuning curve of the wide tuning range VCO before and
after segmentation. The horizontal axis is voltage. The vertical axis is frequency. Figure 36(b)
15 shows how segmentation is used to divide the tuning range and linearize the tuning curve. The
linear tuning curves correspond to different VCO segments. The slope of the linear tuning curves
is a result control of VCO tuning. The horizontal axis is voltage. The vertical axis is frequency.

Figure 37(a) shows how the VCO of figure 34 can be connected to the divider before
being upconverted to the RF clock frequency in the LO generator. The I output signal of the
VCO is coupled to buffer 884 and the Q output signal of the VCO is coupled to buffer 886.
Buffer 888 combines the I-Q data from the buffer 884 and the buffer 886 to obtain a larger signal.
The large signal is coupled to a divider 50 where it is divided in frequency by N to get quadrature
25 signals.

In another embodiment of the present invention, a polyphase filter 892 follows a single-
phase VCO as shown in Figure 37(b). This approach uses a single phase VCO 48 with a
polyphase filter 892 to get quadrature signals. The output of the VCO 48 is coupled to a buffer
30 888. The buffer provides sufficient drive for the polyphase filter 892.

A multiple stage polyphase filter can be used to obtain better phase accuracy at a certain
frequency range. Embodiments of the present invention that are fully integrated into a single IC,
the required frequency range is mainly set by the process variation on the chip and the system
35 bandwidth.

Any amplitude imbalance in the signals at the VCO and divider output will only cause a second order mismatch in the amplitude of the LO generator signals, and the output phase will remain 0 and 90°. If the standard deviation of the amplitude imbalance at the VCO and divider are the same and equal to σ_a , then the standard deviation of the LO generator output amplitude imbalance (σ_A) will be:

$$\sigma_A = \frac{(\sigma_a)^2}{2} \quad (58)$$

The reason phase inaccuracy is more emphasized here is that because of the limiting stages in the LO generator and the hard switching at the mixers LO input, most of the errors will be in phase, rather than amplitude.

Although the phase or amplitude inaccuracy at the mixers input or LO has only a second order effect on the LO generator, any mismatch at the mixers outputs or the following stages will directly cause phase and amplitude imbalance in the LO generator outputs. This mismatch will typically be a few percent, and will not adversely impact the transceiver performance, since in a low-IF or direct conversion architectures the required image rejection is usually relaxed.

4.0 Controller

The controller performs adaptive programming and calibration of the receiver, transmitter and LO generator (see figure2). An exemplary embodiment of the controller in accordance with one aspect of the present invention is shown in figure 38. A control bus 17 provides two way communication between the controller and the external processing device (not shown). This communication link can be used to externally program the transceiver parameters for different modulation schemes, data rates and IF operating frequencies. In the described exemplary embodiment, the external processing device transmits data across the control bus 17 to a bank

1 of addressable registers 900-908 in the controller. Each addressable register 900-908 is configured to latch data for programming one of the components in the transmitter, receiver LO generator. By way of example, the power amplifier register 900 is used to program the gain of the power amplifier 62 in the transmitter (see figure 2). The LO register 902 is used to program the IF frequency in the LO generator. The demodulator register 903 is used to program the demodulator for FSK demodulation, or alternatively in the described exemplary embodiment, program the A/D converter to handle different modulation schemes. The AGC register 905 programs the gain of the programmable multiple stage amplifier when in the AGC mode. The filter registers 901, 904, 906 program the frequency and bandwidth of their respective filters.

15 The transmission of data between the external processing device and the controller can take on various forms including, by way of example, a serial data stream parsed into a number of data packets. Each data packet includes programming data for one of the transceiver components accompanied by a register address. Each register 900-908 in the controller is assigned a different address and is configured to latch the programming data in the each data packet where the register address in that data packet matches its assigned address.

20 The controller also may include various calibration circuits. In the described exemplary embodiment, the controller is equipped with an RC calibration circuit 907 and a bandgap calibration circuit 908. The RC calibration circuit 907 can compensate an integrated circuit transceiver for process, temperature, and power supply variations. The bandgap calibration circuit can be used by the receiver, transmitter, and LO generator to set amplifier gains and voltage swings.

25 The programming data from the addressable registers 900-908 and the calibration data from the RC calibration circuit 907 and the bandgap calibration circuit 908 are coupled to an output register 909. The output register 909 formats the programmability and calibration data into a data packets. Each data packet includes a header or preamble which addresses the appropriate transceiver component. The data packets are then transmitted serially over a controller bus 910 to their final destination. By way of example, the output register 909 packages the programming data from the power amplifier register 900 with the header or preamble for the power amplifier and outputs the packaged data as the first data packet to the controller bus 910.

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The second data packet generated by the output register 909 is for the programmable low pass filter in the transmitter. The second data packet includes two data segments each with its own header or preamble. The first segment consists of both programmability and calibration data. Because the programmability feature requires a large dynamic range as far as programming the programmable low pass filter to handle different frequency bands, and the calibration feature is more of a fine tuning function of the programmable low pass filter once tuned requiring a much smaller dynamic range, a single digital word containing both programming and calibration information can be used with the most significant bits (MSB) having the programming information and the least significant bits (LSB) having the calibration information. To this end, the output register 909 combines the output of the low pass filter register 901 with the output of the RC calibration circuit 907 with the low pass filter register output constituting the MSBs and the RC calibration circuit output constituting the LSBs. A header or preamble is attached to the combined outputs identifying the data packet for RC calibration of the programmable low pass filter in the transmitter. Similarly, the second segment of the second data packet is generated by combining the low pass filter register output (as the MSBs) with the bandgap calibration circuit output (as the LSBs) and attaching a header or preamble identifying the data packets for bandgap calibration of the programmable low pas filter.

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The third data packet generated and transmitted by the output register 909 can program the dividers in the LO generator to produce different IF frequencies. The third data packet can be a single segment of data with a header or preamble identifying the LO generator for programming each divider. Alternatively, the third data packet can include any number of data segments with, in one embodiment, different programming data for each divider in the LO generator. Each data segment would include a header or preamble identifying a specific divider in the LO generator.

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The fourth data packet generated and transmitted by the output register 909 could include the programming data output from the demodulator register 904 with the appropriate header or preamble.

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The output of the complex bandpass filter register 904 can be combined with the output from the RC calibration circuit 907 to form the first segment of the fifth data packet. The output of the complex bandpass filter register 904 can also be combined with the output of the bandgap calibration circuit 908 to form the second segment of the fifth data packet. Each segment can

1 have its own header or preamble indicating the type of calibration data for the complex bandpass filter.

5 The sixth data packet generated and transmitted by the output register 909 can be the output data from the AGC register 905 accompanied by a header or preamble identifying the data packet for the programmable multiple stage amplifier in the receiver.

10 The output of the polyphase filter register 906 can be combined with the output from the RC calibration circuit 907 to form the first segment of the seventh data packet. The output of the polyphase filter register 906 can also be combined with the output of the bandgap calibration circuit 908 to form the second segment of the seventh data packet. Each segment can have its own header or preamble indicating the type of calibration data for the polyphase filter.

15 Finally, the output register 907 can configure additional data packets from the output of the RC calibration circuit 907 and, in separate data packets, the output of the bandgap calibration circuit 908 with appropriate headers or preambles.

20 As those skilled in the art will appreciate, other data transmission schemes can be used. By way of example, the separate output registers for each transceiver component could be used. In this embodiment, each output register would be directly connected to one or more transceiver components.

25 4.1 RC Calibration Circuit

RC calibration circuits can provide increased accuracy for improved performance. Embodiments of the present invention that are integrated into a single IC can utilize RC calibration to compensate for process, temperature, and power supply variation. For example, variations in the absolute value of the RC circuit in a complex filter can limit the amount of rejection that the filter can provide. In the described exemplary embodiments of the present invention, an RC calibration circuit in the controller can provide dynamic calibration of every RC circuit by providing a control word to the transmitter, receiver and LO generator.

35 Figure 39 shows an exemplary RC calibration circuit in accordance with an embodiment of the present invention. The calibration circuit uses the reference clock from the LO generator

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to generate a 4-bit control word using a compare-and-increment loop until an optimum value is obtained. The 4-bit control provides an efficient technique for calibrating the RC circuits of the transceiver with a maximum deviation from its optimal value of only 5 %.

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Transistors 172, 174, 176, 178, 180, 182 form a cascode current source with a reference current I_{REF} 184. With the gates of the transistors 172 and 178 tied to their respective sources, a fixed reference current I_{REF} 184 can be established. By tying the gates of the transistors 174, 180 to the gates of the transistors 172, 178, respectively, the current through resistor R_C 186 can be mirrored to I_{REF} 184. Similarly, by tying the gates of the transistors 176, 182 to the gates of the transistors 174, 180, respectively, the current through resistor R_C 186 can be mirrored to a tunable capacitor C_C 188. The calibration circuit tunes the absolute value of the RC to a desired frequency by using this cascode-current source to provide identical currents to the on-chip reference resistor R_C 186 and to the tunable capacitor C_C 188 generating the voltages V_{RES} 190 and V_{CAP} 192, respectively. Embodiments of the present invention that are integrated into a single IC can use an off-chip reference resistor R_c to obtain greater calibration accuracy. The current through the tunable capacitor is controlled by a logic control block 195 via switch S_2 193. During the charging phase, switch S_2 193 is closed and switch S_1 is open to charge the tunable capacitor C_C 188 to V_{CAP} . The voltage held on the tunable capacitor 188 V_{CAP} is then compared, using a latched comparator 198, to a voltage generated across the reference resistor 186. The value of the tunable capacitor C_c 188 is incremented in successive steps by the logic control block 195 until the voltage held by the tunable capacitor C_C matches the voltage across the reference resistor 186, at which point the 4-bit control word for optimal calibration of the RC circuits for the transmitter, receiver, and LO generator is obtained. More particularly, once the voltage V_{CAP} reaches the voltage V_{RES} , the output of the comparator output 198 switches. The switched comparator output is detected by the control logic 195. The control logic 195 opens switch S_2 193 and closes switch S_1 194 causing the tunable capacitor 188 C_C to discharge. The resultant 4-bit control word is latched by the control logic 195 and coupled to the transceiver, receiver, and LO generator.

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C_p 200 compensates for the parasitic capacitance loading of the capacitive branch. By choosing C_c 188 to be much larger than C_p 200, the voltage error at node V_{CAP} 192 caused by charging the parasitic capacitance becomes negligible.

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The clock signals used by the calibration circuit are generated by first dividing the reference clock down in frequency, and then converting the result into different phases for the

charging, comparison, increment, and discharging phases of calibration. Embodiments of the present invention that are integrated onto a single IC can obtain an accurate RC value because capacitor scaling and matching on the same integrated circuit can be well-controlled with proper layout technique. The described RC calibration circuit provides an RC-tuning range of approximately +40 %, which is sufficient to cover the range of process variation typical in semiconductor fabrication.

4.2 RC Calibration Circuit using polyphase filtering

An RC calibration circuit using polyphase filtering is an alternative method for calibrating RC circuits in the transmitter, receiver, and LO generator. The RC calibration using polyphase filtering circuit includes an auto-calibration algorithm in which the capacitors or the RC circuits in the transceiver, receiver and LO generator can be calibrated with a control word generated by comparing the signal attenuation across two tunable polyphase filters. The calibrated RC value obtained as a result of this algorithm is accurate to within $\pm 5\%$ of its optimal value.

Figure 40 shows an exemplary embodiment of the RC calibration circuit using polyphase filtering. The RC calibration circuit uses the reference clock from the LO generator to adjust the RC value in two polyphase filters 280, 282 in successive steps until an optimum value has been selected. In this process, the two polyphase filters 280, 282 provide signal rejection that is dependent upon the value of $\omega = (RC)^{-1}$ to which they are tuned by control logic 286. Initially, the first filter (Polyphase A) 280 is tuned to a frequency less than the frequency of the reference clock (reference frequency), and the second filter (Polyphase B) 282 is tuned to a frequency greater than the reference frequency by control logic 286. The signals at the outputs of the polyphase filters are detected with a received-signal-strength-indicator (RSSI) block 284, 285 in each path. A filter is coupled to RSSI block 284 and the polyphase B filter is coupled to RSSI block 285.

With an input dynamic range of 50 dB, the RSSI circuit is designed to detect the levels of rejection provided by the polyphase filtering. The outputs of RSSI block 284 and RSSI block 285 are coupled to a comparator 280 where the level of signal rejection of each polyphase filter is compared by comparator 280. The outputs of the RSSI blocks are also coupled to the control logic 286. The control logic 286 determines from the RSSI outputs which polyphase filter has a lower amount of signal suppression. Then, the control logic 286 adjusts the frequency tuning of that filter in an incremental step via the control logic 286. This is done by either increasing the tuned frequency of

the first filter (polyphase A) filter 280, or by decreasing the tuned frequency of the second filter (polyphase B) 282 by changing the appropriate 4-bit control word. This process continues in successive steps until the 4-bit control word in each branch are identical, at which point, the RC values of the two polyphase filters are equal. The 4-bit control word provides a maximum deviation of only $\pm 5\%$.

In the described exemplary embodiment, the frequency of the input signal X_{IN} is derived from the reference frequency and is chosen to be, by way of example, 2 MHz. This input signal X_{IN} is obtained by initially dividing the reference clock down in frequency, followed by a conversion into quadrature phases at the control logic 286. By dividing the reference clock by a factor greater than two with digital flip-flops (not shown), the input signal at X_{IN} is known to be differential with well-defined quadrature phases.

Two branches of polyphase filtering are used in this algorithm. Two 4-bit control words are used to control the value of the capacitances in each polyphase filter. The initial control words set the capacitance in the first filter (Polyphase A) to its maximum value and the capacitance in the second filter (Polyphase B) to its minimum value. This provides an initial condition in which the filters have maximum signal suppression set at frequencies (ω_{low} and ω_{high}) that are approximately $\pm 40\%$ of the frequency of the input signal X_{IN} for the case of nominal process variation. For a sinusoidal input X_{IN} , the calibration circuit depicted in Figure 40 would require only a single-stage polyphase filter in each branch. The single-stage filters would attenuate the sinusoid input signal, generating outputs at X_A and X_B with the dominant one still at the same frequency as the input signal. However, the reference clock from the LO generator is a digital rail-to-rail clock. Because the input is not a pure sinusoid, multiple-stage filters may provide greater calibration accuracy. In the case of a single-stage filter with a digital clock, the filter would suppress the fundamental frequency component at ω_{in} to a significant degree but the harmonics would pass through relatively unaffected. The RSSI block would then detect and limit the third harmonic component of the input signal at $3\omega_{in}$, as it becomes the dominant frequency component after the fundamental is suppressed. This could result in an inaccurate calibration code.

A three-stage polyphase filter can be used in each branch to suppress the fundamental frequency component of X_{IN} as well as the 3rd and 5th harmonics. The first stage of the polyphase filter can provide rejection of the fundamental frequency component. The second stage can provide rejection of the 3rd harmonic. The third stage can provide rejection of the 5th harmonic. At the same

time, the higher harmonics of the input signal X_N can be suppressed with an RC lowpass filter in a buffer (not shown) preceding the polyphase filters. As a result, the dominant frequency component of the signals X_A and X_B remains at the input frequency ω_{in} , which is then properly detected by the RSSI blocks.

A calibration clock used for the control logic runs at a frequency of 250 kHz. The reference clock can be divided down inside the controller, or alternatively in the control logic. This clock frequency has been selected to allow the RSSI outputs to settle after the capacitance value in one of the polyphase filters has been incremented or decremented. For a clock frequency of 250 kHz and a 4-bit control word generating 2^4 possible capacitance values, the calibration is completed within $(250 \text{ kHz})^{-1}(2^4 - 1) = 60 \mu\text{s}$. During the calibration process the calibration circuitry draws 4 mA from a 3-V supply, and the RC calibration circuitry can be powered down when the optimal RC value has been selected to reduce power consumption.

4.3 The Capacitor Array

In the transmitter, receiver and LO generator, metal-insulator-metal (MIM) capacitors can be used as the calibration component for the RC circuits. As those skilled in the art will appreciate, other capacitor technologies may be used. The MIM capacitors are generally characterized by a low bottom-plate parasitic capacitance to substrate of 1%.

A parallel capacitor array can be used in calibrating each RC circuit as shown in Figure 41. The parallel array is much smaller in area than a series array for the same capacitor value.

Complementary MOS switches or other switches known in the art, can be used in the capacitor array. The capacitor array can include any number of capacitors. In the exemplary embodiment, the capacitor array capacitors 290, 292, 294, 296, 298 are connected in parallel. Switches 300, 302, 304, 306 are used to switch the capacitors 292, 294, 296, 298, respectively, in and out of the capacitor array. In the described embodiment, capacitor 290 is 2.4 pF, capacitor 292 is 2.4 pF, capacitor 294 is 1.2 pF, capacitor 296 is 0.6 pF, capacitor 298 is 0.3 pF. The switch positions are nominally selected to produce an equivalent capacitance equal to 4.8 pF. A code of "0111" means that capacitors 294, 296, 298 are switched out of the capacitor array and capacitors 290, 292 are in parallel.

The switches can be binary-weighted in size and the switch sizes can be chosen according to tradeoffs regarding parasitic capacitances and frequency limitations based on the on-resistance of the CMOS switches. The capacitive error resulting from the parasitic capacitance in each capacitive array does not result in frequency error between the three polyphase stages of the RC calibration circuit in the controller. This is because by using same capacitor array in each filter, and by scaling the resistance accordingly in each case. Scaling resistances, relative to those in the fundamental polyphase filter, by factors of 1/3 and 1/5 in the 3rd and 5th harmonic filters respectively, are achieved with a high degree of accuracy with proper layout. Similarly, RC tuning in all other blocks utilizing the calibrated code is optimized when an identical capacitive array is used, scaling only the resistance value in tuning to the desired frequency. The capacitors in the capacitive arrays are laid out in 100 fF increments to improve the matching and parasitic fringing effects.

4.4 Bandgap Calibration Circuit for Accurate Bandgap Reference Current

In accordance with an exemplary embodiment of the present invention, a bandgap reference current is generated by a bandgap calibration circuit. The bandgap reference current is used by the receiver, transmitter, and LO generator to set amplifier gains and voltage swings. The bandgap calibration circuit generates an accurate voltage and resistance. An accurate bandgap reference current results from dividing the accurate voltage by the an accurate resistance.

Bandgap calibration circuits can provide increased accuracy for improved performance. Embodiments of the present invention that are integrated onto a single IC can utilize bandgap calibration circuits to compensate for process, temperature, and power supply variations. For example, variations in the absolute value of the resistance in a bandgap reference may result in deviations from optimal performance in sensitive circuitry that rely on accurate biasing conditions. In the described exemplary embodiment of the transceiver, a bandgap calibration circuit in the controller 16 provides an effective technique for self-calibration of resistance values in the transmitter, receiver and LO generator. The calibrated resistance values obtained as a result of the algorithm employed in the bandgap calibration circuit generate a bias current that varies by only +2% over typical process, temperature, and supply variation.

Embodiments of the present invention which are integrated into a single IC can use the described bandgap calibration circuit to provide accurate on-chip resistors by comparing the on-chip

resistances to an off-chip reference resistor with a low tolerance of 1%. Using this method, trimming of on-chip resistance values with a total tolerance of 2% can be achieved.

Figure 42 shows an exemplary embodiment of the bandgap calibration circuit. The bandgap calibration circuit uses the reference clock provided from the LO generator and a reference resistor R_{REF} 236 to adjust a tunable resistance value R_{POLY} 238 in a compare-and-increment loop until an optimum value is obtained. In embodiments of the present invention which are integrated into a single IC, the reference resistor R_{REF} 236 can be off-chip to provide improved calibration accuracy. A 4-bit control word is output to accurately calibrate the resistors in the transmitter, receiver and LO generator within $\pm 2\%$. Transistors 227, 226, 228, 230, 232, 234 form a cascode current with a reference current I_{REF} . The transistors 224, 230 each have their gates tied to their respective sources to set up the reference current I_{REF} . By tying the gates of the transistors 224, 230, respectively to the gates of the transistors 226, 232, the reference current I_{REF} is mirrored to the reference resistor R_{REF} 236. Similarly, by tying the gates of the transistors 228, 234, respectively to the gates of the transistors, the reference current I_{REF} is also mirrored to the tunable resistor R_{POLY} 238. The voltage generated across the tunable resistor R_{POLY} 238 is compared, using a latched comparator 240, to the voltage generated across the reference resistor R_{REF} 236. The value of the tunable resistor R_{POLY} 236 is incremented in successive steps, preferably, every 0.5 μ s, through the utilization of control logic 242 that is clocked, by way of example, at 2 MHz. This process continues until the voltage V_{POLY} across the tunable resistor R_{POLY} 238 matches the voltage V_{REF} across the off-chip reference resistor R_{REF} 236 causing the output of the comparator to change states and disable the control logic 242. Once the control logic is disabled, the 4-bit control word can be used to accurately calibrate the resistors in the transmitter, receiver and LO generator.

The clock signals used by the calibration circuit are generated by first dividing the reference clock input into the controller from the LO generator down in frequency, and then converting the result into different phases for the comparison and increment phases of calibration. This bandgap calibration circuit provides accurate resistance values for use in various on-chip circuit implementations because resistor scaling and matching on the same integrated circuit can be well controlled with proper layout techniques. The bandgap calibration circuit provides a resistor tuning range of approximately +30%, which is sufficient to cover the range of process variation typical in semiconductor fabrication. With a 4-bit control word generating 24 possible resistance values, the calibration is completed within $(2 \text{ MHz})^{-1}(24 - 1) = 7.5 \text{ ms}$. The calibration circuit can be powered down when the optimal resistance value has been obtained.

The bandgap calibration circuit can be used for numerous applications. By way of example, figure 43 shows a bandgap calibration circuit 244 used in an application for calibrating a bandgap reference current that is independent of temperature. The 4-bit control word from the bandgap calibration circuit is coupled, by way of illustration, to the receiver. The 4-bit control word is used to calibrate resistances in a proportional-to-absolute-temperature (PTAT) bias circuit 246, and also in a V_{BE} (negative temperature coefficient) bias circuit 248. The outputs of these blocks are two bias voltages, V_p 250 and V_n 252 that generate currents exhibiting a positive temperature coefficient, and a negative temperature coefficient, respectively. When these currents are summed together using the cascode current mirror formed by transistors 254, 256, 258, 260, the result is a current I_{OUT} displays a (ideally) zero temperature coefficient.

4.5 Resistor Array

In the transmitter, receiver and LO generator non-silicided polysilicon resistors can be used. As those skilled in the art will appreciate, other resistor technologies can also be used. Non-silicided polysilicon resistors have a high sheet resistance of 200- Ω /square along with desirable matching properties. A switching resistor array as shown in figure 44 can be used to calibrate a resistor. The array includes serial connected resistors 208, 210, 212, 214, 216, which, by way of example, have resistances of 2200 Ω , 1100 Ω , 550 Ω , 275 Ω , and 137 Ω , respectively. The resistors 210, 212, 214, 216 include a bypass switch for switching the resistors in and out of the array. The switch positions are nominally selected to produce an equivalent of 3025 Ω . This resistance value has been chosen as a convenience to match the value used in generating an accurate bandgap reference current. A 4-bit calibration code 206 is used to control the total resistance in this array. As seen in figure 44, the resistances are binary-weighted in value and the accurate scaling of each incremental resistance results by placing the largest resistor (2200 Ω) 208 in series to generate each value. In the described embodiment, the incremental resistances shown in figure 44 are chosen so that the total resistance in the array covers a range 30% above and below its nominal value, with a maximum resistance error of +2% determined by the incremental resistance switched by the LSB. The range of resistance covered by the array is sufficient to cover typical process variations in a semiconductor process. A series resistive array may be desirable opposed to a parallel resistive array because of the smaller area occupied on the wafer.

CMOS switches are one of several different types of switch technology that can be used. The sizing of the switches entails a tradeoff between the on-resistance of each switch and the frequency

limitations that result from the parasitic capacitances associated with each switch. For calibration resistors in the bandgap reference circuits, large switches are used to minimize the effect of the on-resistance of each switch, as frequency limitations are not a concern for this application.

5.0 Floating MOSFET Capacitors

Embodiments of the present invention that are integrated into a single IC can be implemented with a variety of technologies including, by way of example, CMOS technology. Heretofore, CMOS capacitors between two nodes with similar voltages (i.e., floating capacitors) have been problematic. In the described exemplary embodiment of the present invention, a MOS capacitor is used between two nodes having similar voltages for signals with no DC information. The capacitor is made of two MOS capacitors in series with a large resistor in between to ground for biasing.

Figure 45 is a block diagram of the Floating MOS capacitor in accordance with an embodiment of the present invention.. As shown in Figure 45, the capacitor comprises two similar devices 858, 860 in series. Each MOS transistor has its source and drain connected together. The connected drain-source terminal of the MOS transistor 858 constitutes the input of the CMOS capacitor and the connected drain-source terminal of the MOS transistor 860 constitutes the output of the CMOS capacitor. The gates of each MOS transistor are connected through a common resistor 862 to a bias source (not shown).

6.0 Duplexing

In an alternative embodiment of the present invention, an integrated matching circuit can be used to connect the LNA in the receiver to the PA in the transmitter. As the level of integration in radio communication circuits tend to grow, more functions are embodied on the same chip and off-chip components are used less than ever. Presence of external components not only augments the manufacturing costs, but also increases the pin count on the main chip. The antenna switch is an example of such components. This switch is used to connect the receiver to antenna in reception mode and the transmitter to antenna in transmission mode. In the described exemplary embodiment of the present invention, the antenna switch can be eliminated, and the input of the receiver can be tied to the output of the transmitter. This approach has various applications including, but not limited to, single chip integration.

Since the antenna is usually single-ended, differential applications generally require a mechanism to convert the antenna signal from single-ended to differential for connection to the differential low noise amplifier (LNA) or the differential PA. The circuit implementation for a single-ended to differential LNA is shown in Figures 46 and 47. LC circuit, 646, 648 and the CL circuit 652, 650 matches the PA to the antenna when the PA is on and the LNA is off (as shown in figure 46), and matches the LNA to the antenna when the LNA is on and the PA is off (as shown in figure 47). Since the LNA is off and it only introduces a capacitive loading to the PA. The matching circuit can be designed to compensate for this additional capacitance.

In operation, during the transmit mode, a differential voltage across the drains of the PA transistors 634, 632 is generated. The two drains assert 180-degree out of phase voltages and they are combined through the LC and CL matching circuits to yield a single-ended voltage at the output. The LC circuit shifts the phase of the output signal from the transistor 634 by 90 degrees. The CL circuit shifts the phase of the signal output from the transistor 632 by 90 degrees in the opposite direction. Consequently, both signals are in-phase when combined at the output of the matching circuits.

Although a preferred embodiment of the present invention has been described, it should not be construed to limit the scope of the appended claims. For example, the present invention can be into a single integrated circuit, can be constructed from discrete components, or can include one or more integrated circuits supported by discrete components. Those skilled in the art will understand that various modifications may be made to the described embodiments. Moreover, to those skilled in the various arts, the invention itself herein will suggest solutions to other tasks and adaptations for other applications. It is therefore desired that the present embodiments be considered in all respects as illustrative and not restrictive, reference being made to the appended claims rather than the foregoing description to indicate the scope of the invention.

WHAT IS CLAIMED IS:

1. An oscillator, comprising:
 - a first resonator having a first tuning input to tune the first resonator as a function of a first current applied to the first tuning input; and
 - a second resonator coupled to the first resonator, the second resonator having a second tuning input to tune the second resonator as a function of a second current applied to the second tuning input.
2. The oscillator of claim 1 wherein the first resonator comprises a first output and the second resonator comprises a second output.
3. The oscillator of claim 2 wherein the first and second outputs comprises a quadrature output.
4. The oscillator of claim 2 wherein the output of the first resonator is fed back to the second tuning input for the second resonator, and the output of the second resonator is fed back to the first tuning input for the first resonator.
5. The oscillator of claim 4 further comprising a first transconductance cell positioned between the output of the first resonator and the second tuning input, and a second transconductance cell positioned between the output of the second resonator and the first tuning input.
6. The oscillator of claim 5 wherein the first transconductance cell has a digitally programmable variable gain.
7. The oscillator of claim 6 wherein the second transconductance cell has a digitally programmable variable gain.
8. The oscillator of claim 5 wherein the output of the first resonator is fed back to the first tuning input, and the output of the second resonator is fed back to the second tuning input.

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9. The oscillator of claim 8 further comprising a third transconductance cell positioned between the output of the first resonator and the first tuning input, and a fourth transconductance cell positioned between the output of the second resonator and the second tuning input.

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10. The oscillator of claim 9 wherein one of the first, second, third and fourth transconductance cells has a gain control input responsive to a digital word to program a gain thereof.

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11. The oscillator of claim 9 wherein the first transconductance cell comprises a first gain control input responsive to a first digital word to program a gain thereof, the second transconductance cell comprises a second gain control input responsive to a second digital word to program a gain thereof, the third transconductance cell comprises a third gain control input responsive to a third digital word to program a gain thereof, and the fourth transconductance cell comprises a fourth gain control input responsive to a fourth digital word to program a gain thereof.

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12. The oscillator of claim 11 wherein the first transconductance cell comprises a first current source having the first gain control input, the second transconductance cell comprises a second current source having the second gain control input, the third transconductance cell comprises a third current source having the third gain control input, and the fourth transconductance cell comprises a fourth current source having the fourth gain control input.

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13. The oscillator of claim 11 wherein the coupled first and second resonators have a tuning range over a tuning frequency, the tuning frequency being divided into a plurality of frequency bands, one of the frequency bands being selected in response to the third and fourth digital words respectively applied to the third and fourth gain control inputs.

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14. The oscillator of claim 13 wherein the coupled first and second resonators have an operating frequency, the operating frequency being tunable over the selected frequency band in response to the first and second digital words respectively applied to the first and second gain control inputs.

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15. An oscillator, comprising:
a first resonator having a first tuning input;
a second resonator coupled to the first resonator, the second resonator having a second
35 tuning input;

first control means for controlling a first current applied to the first resonator to tune the first resonator; and

second control means for controlling a second current applied to the second resonator to tune the second resonator.

16. The oscillator of claim 15 wherein the first resonator comprises a first output and the second resonator comprises a second output.

17. The oscillator of claim 16 wherein the first and second outputs comprises a quadrature output.

18. The oscillator of claim 16 wherein the first control means feeds back the output of the second resonator to the first tuning input, and the second control means feeds back the output of the first resonator to the second tuning input.

19. The oscillator of claim 18 wherein the first control means comprises a first transconductance cell to feed back the output of the second resonator to the first tuning input, and the second control means comprises a second transconductance to feed back the output of the first resonator to the second tuning input.

20. The oscillator of claim 19 wherein the first transconductance cell comprises first programming means for digitally programming gain.

21. The oscillator of claim 20 wherein the second transconductance cell comprises second programming means for digitally programming gain.

22. The oscillator of claim 19 wherein the first control means further feeds back the output of the first resonator to the first tuning input, and the second control means feeds back the output of the second resonator to the second tuning input.

23. The oscillator of claim 22 wherein the first control means further comprises a third transconductance cell to feed back the output of the first resonator to the first tuning input, and the second control means comprises a fourth transconductance cell to feed back the output of the second resonator to the second tuning input.

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24. The oscillator of claim 23 wherein one of the first, second, third and fourth transconductance cells means for programming a gain thereof in response to a digital word.

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25. The oscillator of claim 23 wherein the first transconductance cell comprises a first programming means for programming a gain thereof in response to a first digital word, the second transconductance cell comprises a second programming means for programming the gain thereof in response to a second digital word, the third transconductance cell comprises a third programming means for programming a gain thereof in response to a third digital word, and the fourth transconductance cell comprises a fourth programming means for programming the gain thereof in response to a fourth digital word.

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26. The oscillator of claim 25 wherein the first programming means comprises a first current source, the second programming means comprises a second current source, the third programming means comprises a third current source, and the fourth programming means comprises a fourth current.

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27. The oscillator of claim 25 wherein the coupled first and second resonators have a tuning range over a tuning frequency, the tuning frequency being divided into a plurality of frequency bands, one of the frequency bands being selected in response to the third and fourth digital words respectively applied to the third and fourth programming means.

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28. The oscillator of claim 27 wherein the coupled first and second resonators have an operating frequency, the operating frequency being tunable over the selected frequency band in response to the first and second digital words respectively applied to the first and second programming means.

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29. An oscillator, comprising:
a first resonator having a first tuning input and a first output;
a second resonator having a second tuning input and a second output;
a first transconductance cell coupled between the first output and the second tuning input;
a second transconductance cell coupled between the second output and the first tuning input;

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a third transconductance cell coupled between the first output and the first tuning input; and
a fourth transconductance cell coupled between the second output and the second tuning input.

30. The oscillator of claim 29 wherein the first and second outputs comprises a quadrature output.

31. The oscillator of claim 29 wherein the first transconductance cell comprises a first gain control input responsive to a first digital word to program a gain thereof, the second transconductance cell comprises a second gain control input responsive to a second digital word to program a gain thereof, the third transconductance cell comprises a third gain control input responsive to a third digital word to program a gain thereof, and the fourth transconductance cell comprises a fourth gain control input responsive to a fourth digital word to program a gain thereof.

32. The oscillator of claim 31 wherein the first transconductance cell comprises a first current source having the first gain control input, the second transconductance cell comprises a second current source having the second gain control input, the third transconductance cell comprises a third current source having the third gain control input, and the fourth transconductance cell comprises a fourth current source having the fourth gain control input.

33. The oscillator of claim 31 wherein the first and second resonators each have a tuning range over a tuning frequency, the tuning frequency being divided into a plurality of frequency bands, one of the frequency bands being selected in response to the third and fourth digital words respectively applied to the third and fourth gain control inputs.

34. The oscillator of claim 13 wherein the first and second resonators each have an operating frequency, the operating frequency being tunable over the selected frequency band in response to the first and second digital words respectively applied to the first and second gain control inputs.

35. A transceiver, comprising:
a current controlled oscillator including a first resonator having a first tuning input to tune the first resonator as a function of a first current applied to the first tuning input, and a second

resonator coupled to the first resonator, the second resonator having a second tuning input to tune the second resonator as a function of a second current applied to the second tuning input; and
a controller having a first control to control the first current to the first tuning input,
and a second control to control the second current to the second tuning input.

36. The transceiver of claim 35 wherein the first resonator comprises a first resonator output and the second resonator comprises a second resonator output.

37. The transceiver of claim 36 wherein the first and second resonator outputs comprises a quadrature output.

38. The transceiver of claim 36 wherein the first resonator output is fed back to the second tuning input for the second resonator, and the second resonator output is fed back to the first tuning input for the first resonator.

39. The transceiver of claim 38 wherein the current controlled oscillator comprises a first transconductance cell positioned between the first resonator output and the second tuning input, and a second transconductance cell positioned between the second resonator output and the first tuning input.

40. The transceiver of claim 39 wherein the first transconductance cell has a digitally programmable variable gain.

41. The transceiver of claim 40 wherein the second transconductance cell has a digitally programmable variable gain.

42. The transceiver of claim 39 wherein the first resonator output is fed back to the first tuning input, and the second resonator output is fed back to the second tuning input.

43. The transceiver of claim 42 wherein the current controlled oscillator comprises a third transconductance cell positioned between the first resonator output and the first tuning input, and a fourth transconductance cell positioned between the second resonator output and the second tuning input.

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44. The transceiver of claim 43 wherein the first control output comprises a first, second digital word and the second control output comprises a third and fourth digital word, the first transconductance cell comprises a first gain control input responsive to the third digital word to program a gain thereof, the second transconductance cell comprises a second gain control input responsive to the first digital word to program a gain thereof, the third transconductance cell comprises a third gain control input responsive to the second digital word to program a gain thereof, and the fourth transconductance cell comprises a fourth gain control input responsive to the fourth digital word to program a gain thereof.

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45. The transceiver of claim 44 wherein the first transconductance cell comprises a first current source having the first gain control input, the second transconductance cell comprises a second current source having the second gain control input, the third transconductance cell comprises a third current source having the third gain control input, and the fourth transconductance cell comprises a fourth current source having the fourth gain control input.

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46. The transceiver of claim 44 wherein the coupled first and second resonators have a tuning range over a tuning frequency, the tuning frequency being divided into a plurality of frequency bands, one of the frequency bands being selected in response to the third and fourth digital words respectively applied to the second and fourth gain control inputs.

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47. The transceiver of claim 46 wherein the coupled first and second resonators have an operating frequency, the operating frequency being tunable over the selected frequency band in response to the first and third digital words respectively applied to the first and second gain control inputs.

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48. A method of tuning an oscillator, comprising:
converting an output of a first resonator to a first current;
converting an output of a second resonator to a second current;
tuning a first resonator as a function of the second current; and
tuning the second resonator as a function of the first current.

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49. The method of claim 48 further comprising converting the output of the first resonator to a third current, and converting the output of the second resonator to a fourth current, the tuning of

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the first resonator being a function of the first and third currents, and the tuning of the second resonator being a function of the second and fourth currents.

50. The method of claim 49 further comprising digitally programming the conversion of the output of the first resonator to set the first current.

51. The method of claim 49 further comprising digitally programming the conversion of the output of the second resonator to set second current.

52. The method of claim 49 further comprising digitally programming the conversion of the output of the third resonator to set the third current.

53. The method of claim 49 further comprising digitally programming the conversion of the output of the fourth resonator to set the fourth current.

54. The method of claim 49 further comprising digitally programming the conversion of the output of the first resonator to set the first current, digitally programming the conversion of the output of the second resonator to set the second current, digitally programming the conversion of the output of the third resonator to set the third current, and digitally programming the conversion of the output of the fourth resonator to set the fourth current.

55. The method of claim 54 wherein the first and second resonators have a tuning range over a tuning frequency, the tuning frequency being divided into a plurality of frequency bands, and the setting of the third and fourth currents comprises selecting one of the frequency bands.

56. The method of claim 55 wherein the first and second resonators have an operating frequency, and the setting of the first and second currents comprises tuning the first and second resonators over the selected frequency bands.

57. A method of tuning an oscillator having a tuning range over a tuning frequency, the tuning frequency being divided into a plurality of frequency bands, the method comprising:
generating a first digital word;
selecting one of the frequency bands with the first digital word;
generating a second digital word; and

1 tuning the oscillator to an operating frequency within the selected frequency bands with the second digital word.

5 58. The method of claim 57 wherein the oscillator comprises first resonator having a first tuning input and a first resonator output, and a second resonator having a second tuning input a second resonator output, and wherein the selection of one of the frequency bands comprises feeding back the first resonator output to the first tuning input as a function of the first digital word, and feeding back the second resonator output to the second tuning input as a function of the first digital word.

10 59. The method of claim 58 wherein the generation of the first digital word comprises generating a first digital word associated with the feedback of the first resonator output to the first tuning input that is different from the first digital word associated with the feedback of the second resonator output to the second tuning input.

15 60. The method of claim 58 wherein the generation of the first digital word comprises generating a first digital word associated with the feedback of the first resonator output to the first tuning input that is the same as the first digital word associated with the feedback of the second resonator output to the second tuning input.

20 61. The method of claim 57 wherein the oscillator comprises first resonator having a first tuning input and a first resonator output, and a second resonator having a second tuning input a second resonator output, and wherein the tuning of the oscillator comprises feeding back the first resonator output to the second tuning input as a function of the second digital word, and feeding back the second resonator output to the first tuning input as a function of the second digital word.

25 62. The method of claim 61 wherein the generation of the second digital word comprises generating a second digital word associated with the feedback of the first resonator output to the second tuning input that is different from the second digital word associated with the feedback of the second resonator output to the first tuning input.

30 63. The method of claim 61 wherein the generation of the second digital word comprises generating a second digital word associated with the feed back of the first resonator output to the second tuning input that is the same as the second digital word associated with the feedback of the second resonator output to the first tuning input.

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64. The method of claim 57 wherein the oscillator comprises first resonator having a first tuning input and a first resonator output, and a second resonator having a second tuning input a second resonator output, and wherein the selection of one of the frequency bands comprises feeding back the first resonator output to the first tuning input as a function of the first digital word, and feeding back the second resonator output to the second tuning input as a function of the first digital word, and wherein the tuning of the oscillator comprises feeding back the first resonator output to the second tuning input as a function of the second digital word, and feeding back the second resonator output to the first tuning input as a function of the second digital word.

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65. The method of claim 64 wherein the generation of the first digital word comprises generating a first digital word associated with the feedback of the first resonator output to the first tuning input that is different from the first digital word associated with the feedback of the second resonator output to the second tuning input, and the generation of the second digital word comprises generating a second digital word associated with the feedback of the first resonator output to the second tuning input that is different from the second digital word associated with the feedback of the second resonator output to the first tuning input.

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66. The method of claim 64 wherein the generation of the first digital word comprises generating a first digital word associated with the feedback of the first resonator output to the first tuning input that is the same as the first digital word associated with the feedback of the second resonator output to the second tuning input, and the generation of the second digital word comprises generating a second digital word associated with the feed back of the first resonator output to the second tuning input that is the same as the second digital word associated with the feedback of the second resonator output to the first tuning input.

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67. The method of claim 57 wherein the oscillator comprises first resonator having a first tuning input and a first resonator output, and a second resonator having a second tuning input a second resonator output, and wherein the selection of one of the frequency bands comprises converting the first resonator output to a first current as a function of the first digital word, feeding back the first current to the first tuning input, converting the second resonator output to a second current as a function of the first digital word, and feeding back the second current to the second tuning input.

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68. The method of claim 67 wherein the generation of the first digital word comprises generating a first digital word associated with the conversion of the first resonator output to the first

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current that is different from the first digital word associated with the conversion of the second resonator output to the second current.

69. The method of claim 67 wherein the generation of the first digital word comprises generating a first digital word associated with the conversion of the first resonator output to the first current that is the same as the first digital word associated with the conversion of the second resonator output to the second current.

70. The method of claim 57 wherein the oscillator comprises first resonator having a first tuning input and a first resonator output, and a second resonator having a second tuning input a second resonator output, and wherein the tuning of the oscillator comprises converting the first resonator output to a first current as a function of the second digital word, feeding back the first current to the second tuning input, converting the second resonator output to a second current as a function of the second digital word, and feeding back the second current to the first tuning input.

71. The method of claim 70 wherein the generation of the second digital word comprises generating a second digital word associated with the conversion of the first resonator output to the first current that is different from the second digital word associated with the conversion of the second resonator output to the second current.

72. The method of claim 70 wherein the generation of the second digital word comprises generating a second digital word associated with the conversion of the first resonator output to the first second tuning input that is the same as the second digital word associated with the feedback of the second resonator output to the first tuning input.

73. The method of claim 57 wherein the oscillator comprises first resonator having a first tuning input and a first resonator output, and a second resonator having a second tuning input a second resonator output, and wherein the selection of one of the frequency bands comprises converting the first resonator output to a first current as a function of the first digital word, feeding back the first current to the first tuning input, converting the second resonator output to a second current as a function of the first digital word, and feeding back the second current to the second tuning input, and wherein the tuning of the oscillator comprises converting the first resonator output to a third current as a function of the second digital word, feeding back the third current to the second tuning input,

converting the second resonator output to a fourth current as a function of the second word, and feeding back the fourth current to the first tuning input.

74. The method of claim 73 wherein the generation of the first digital word comprises generating a first digital word associated with the conversion of the first resonator output to the first tuning input that is different from the first digital word associated with the conversion of the second resonator output to the second tuning input, and the generation of the second digital word comprises generating a second digital word associated with the conversion of the first resonator output to the third current that is different from the second digital word associated with the conversion of the second resonator output to the fourth current.

75. The method of claim 73 wherein the generation of the first digital word comprises generating a first digital word associated with the conversion of the first resonator output to the first current that is the same as the first digital word associated with the conversion of the second resonator output to the second current, and the generation of the second digital word comprises generating a second digital word associated with the conversion of the first resonator output to the third current that is the same as the second digital word associated with the conversion of the second resonator output to the fourth tuning input.

76. An oscillator having a tuning range over a tuning frequency, the tuning frequency being divided into a plurality of frequency bands, the oscillator comprising:
selection means for selecting one of the frequency bands as a function of a first digital word; and
tuning means for tuning the oscillator to an operating frequency within the selected frequency bands as a function of a second digital word.

77. The oscillator of claim 76 further comprising a first resonator having a first tuning input, a second resonator coupled to the first resonator, the second resonator having a second tuning input, the selection means and the tuning means being coupled to the first tuning input to tune the first resonator, and the selection means and tuning means being coupled to the second tuning input to tune the second resonator.

78. The oscillator of claim 77 wherein the first resonator comprises a first output and the second resonator comprises a second output.

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79. The oscillator of claim 78 wherein the first and second outputs comprises a quadrature output.

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80. The oscillator of claim 78 wherein the tuning means feeds back the output of the second resonator to the first tuning input, and feeds back the output of the first resonator to the second tuning input.

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81. The oscillator of claim 80 wherein the tuning means comprises a first transconductance cell to feed back the output of the second resonator to the first tuning input, and a second transconductance to feed back the output of the first resonator to the second tuning input.

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82. The oscillator of claim 81 wherein the first transconductance cell comprises first programming means for digitally programming gain in response to the second digital word.

83. The oscillator of claim 82 wherein the second transconductance cell comprises second programming means for digitally programming gain in response to the second digital word.

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84. The oscillator of claim 83 wherein the first and second programming means each comprises a current source.

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85. The oscillator of claim 83 wherein the second digital word associated with the first programming means is different from the second digital word associated with the second programming means.

86. The oscillator of claim 83 wherein the second digital word associated with the first programming means is the same as the second digital word associated with the second programming means.

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87. The oscillator of claim 78 wherein the selection means feeds back the output of the first resonator to the first tuning input, and feeds back the output of the second resonator to the second tuning input.

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88. The oscillator of claim 87 wherein the selection means a first transconductance cell to feed back the output of the first resonator to the first tuning input, and a second transconductance cell to feed back the output of the second resonator to the second tuning input.

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89. The oscillator of claim 87 wherein the first transconductance cell comprises first programming means for digitally programming gain in response to the first digital word.

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90. The oscillator of claim 88 wherein the second transconductance cell comprises second programming means for digitally programming gain in response to the first digital word.

91. The oscillator of claim 90 wherein the first and second programming means each comprises a current source.

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92. The oscillator of claim 90 wherein the first digital word associated with the first programming means is different from the first digital word associated with the second programming means.

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93. The oscillator of claim 90 wherein the first digital word associated with the first programming means is the same as the first digital word associated with the second programming means.

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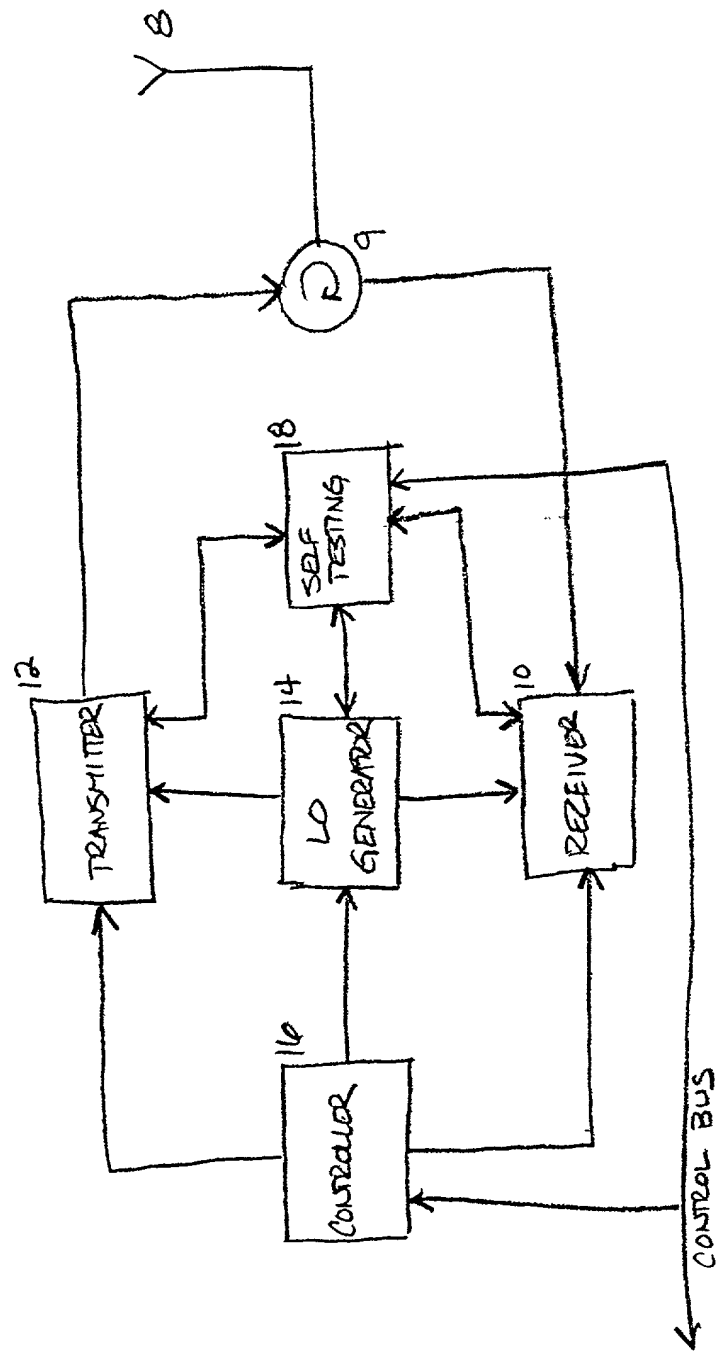
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AN ADAPTIVE RADIO TRANSCEIVER WITH A WIDE TUNING RANGE VCO

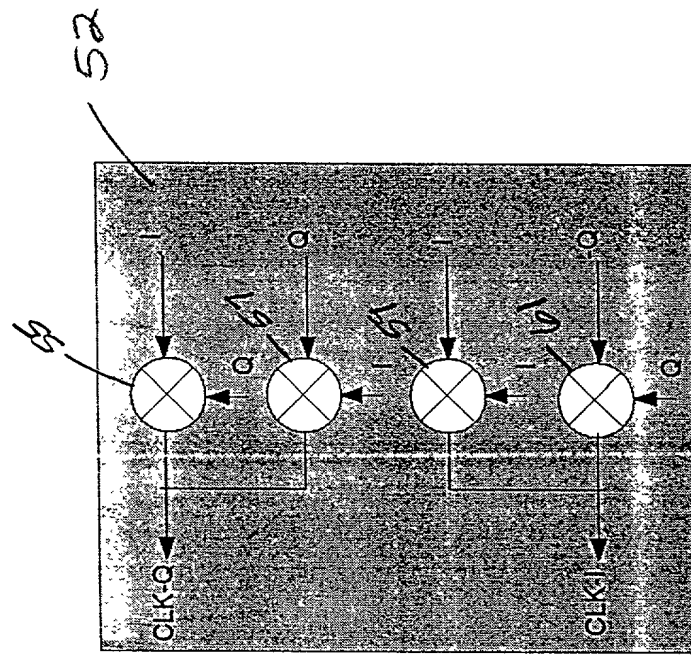
ABSTRACT OF THE DISCLOSURE

An exemplary embodiment of the present invention described and shown in the specification and drawings is a transceiver with a receiver, a transmitter, a local oscillator (LO) generator, a controller, and a self-testing unit. All of these components can be packaged for integration into a single IC including components such as filters and inductors. The controller for adaptive programming and calibration of the receiver, transmitter and LO generator. The self-testing unit generates is used to determine the gain, frequency characteristics, selectivity, noise floor, and distortion behavior of the receiver, transmitter and LO generator. It is emphasized that this abstract is provided to comply with the rules requiring an abstract which will allow a searcher or other reader to quickly ascertain the subject matter of the technical disclosure. It is submitted with the understanding that it will not be used to interpret or limit the scope or the meaning of the claims.



FILE

Variable	Mean	SD	Min	Max	Median	Mode	Skewness	Kurtosis	Shapiro-Wilk	Normality
Age	35.2	12.5	18	65	32	30	0.15	2.10	0.98	Normal
Gender	1.2	0.4	1	2	1	1	0.05	0.10	0.99	Normal
Marital Status	2.1	0.8	1	3	2	2	0.10	0.50	0.97	Normal
Education	14.5	2.5	10	20	15	15	0.05	0.10	0.99	Normal
Income	1200	300	500	2000	1100	1000	0.10	0.50	0.97	Normal
Occupation	1.5	0.5	1	3	1	1	0.05	0.10	0.99	Normal
Health Status	2.5	0.5	1	3	2	2	0.10	0.50	0.97	Normal
Stress Level	3.5	1.0	1	5	3	3	0.15	2.10	0.98	Normal
Life Satisfaction	4.2	0.8	3	5	4	4	0.05	0.10	0.99	Normal
Resilience	3.8	0.9	2	5	3	3	0.10	0.50	0.97	Normal
Emotional Stability	4.5	0.7	3	5	4	4	0.05	0.10	0.99	Normal
Psychological Well-being	4.0	0.8	3	5	4	4	0.05	0.10	0.99	Normal
Life Satisfaction (Scale 1-5)	4.2	0.8	3	5	4	4	0.05	0.10	0.99	Normal
Resilience (Scale 1-5)	3.8	0.9	2	5	3	3	0.10	0.50	0.97	Normal
Emotional Stability (Scale 1-5)	4.5	0.7	3	5	4	4	0.05	0.10	0.99	Normal
Psychological Well-being (Scale 1-5)	4.0	0.8	3	5	4	4	0.05	0.10	0.99	Normal



35.4

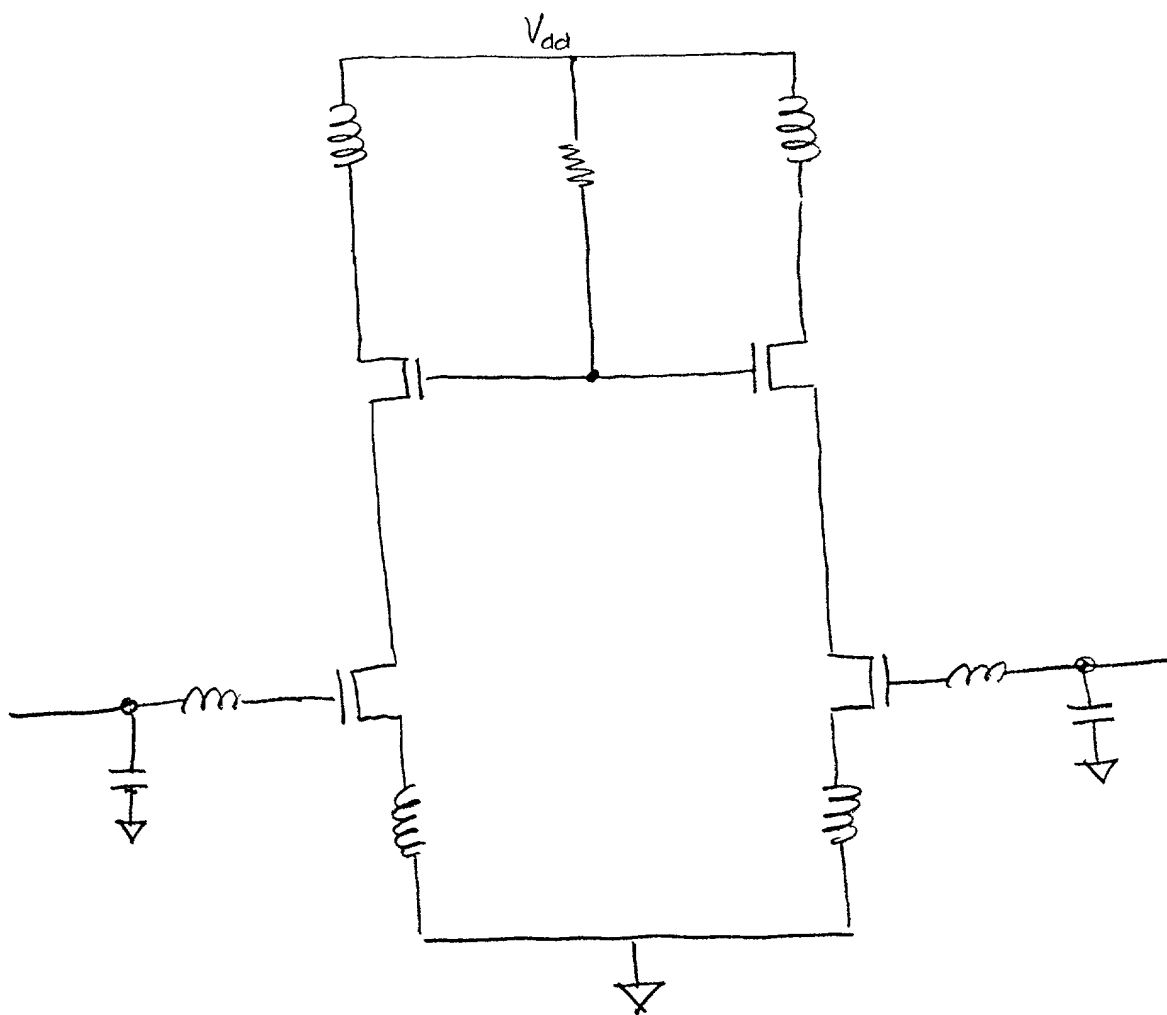


FIG. 4(a)

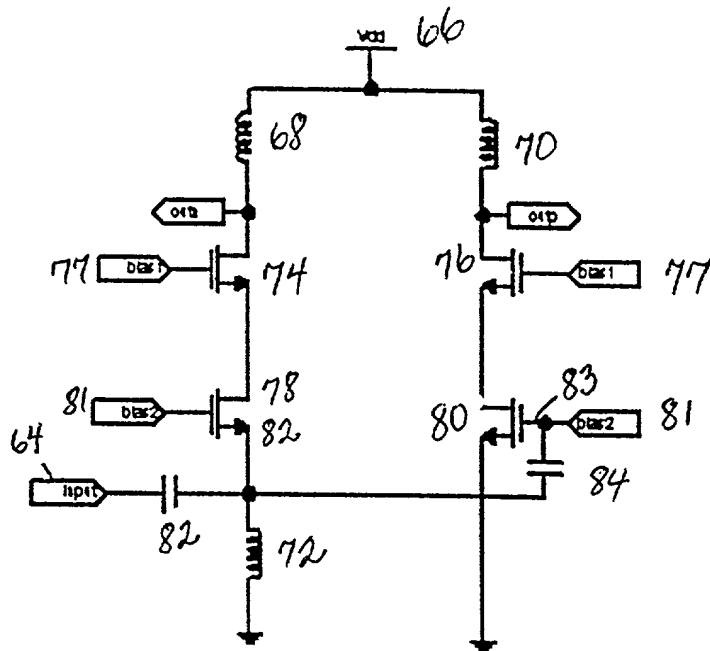


FIG. 4

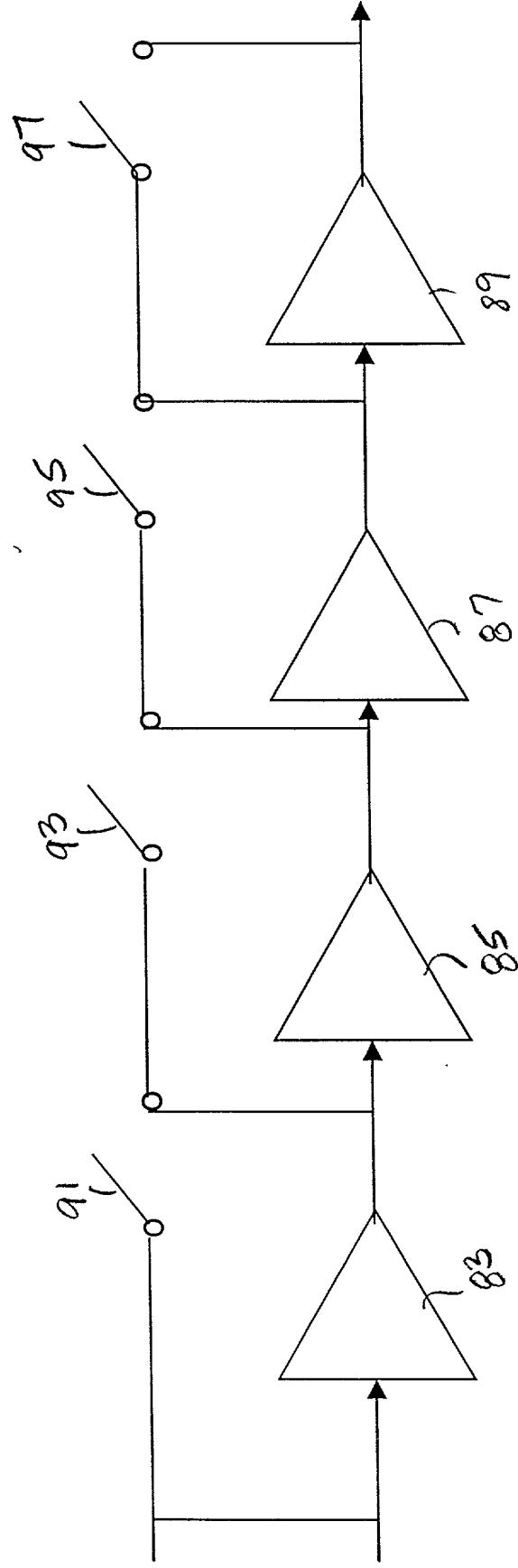


FIG. 5

FIG. 6

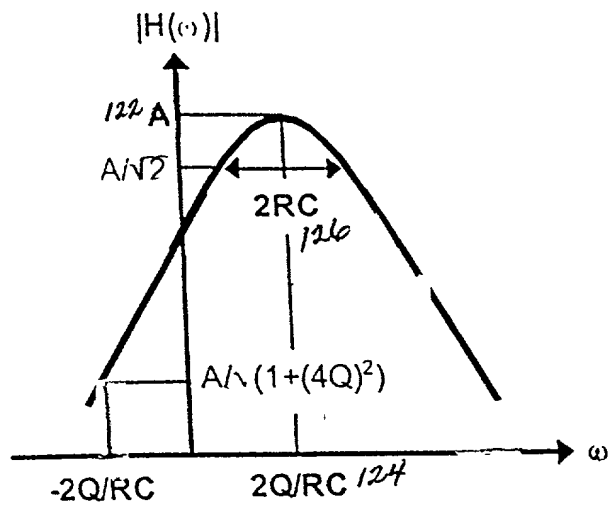


FIG. 7

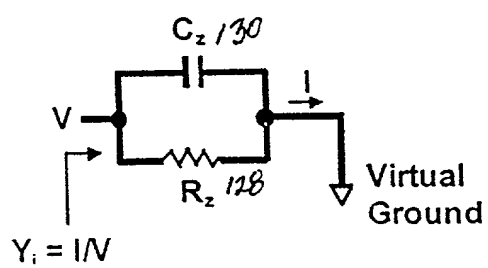


FIG. 8

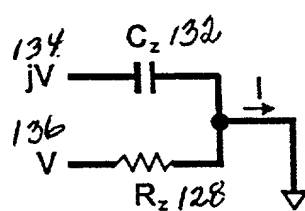


FIG. 9

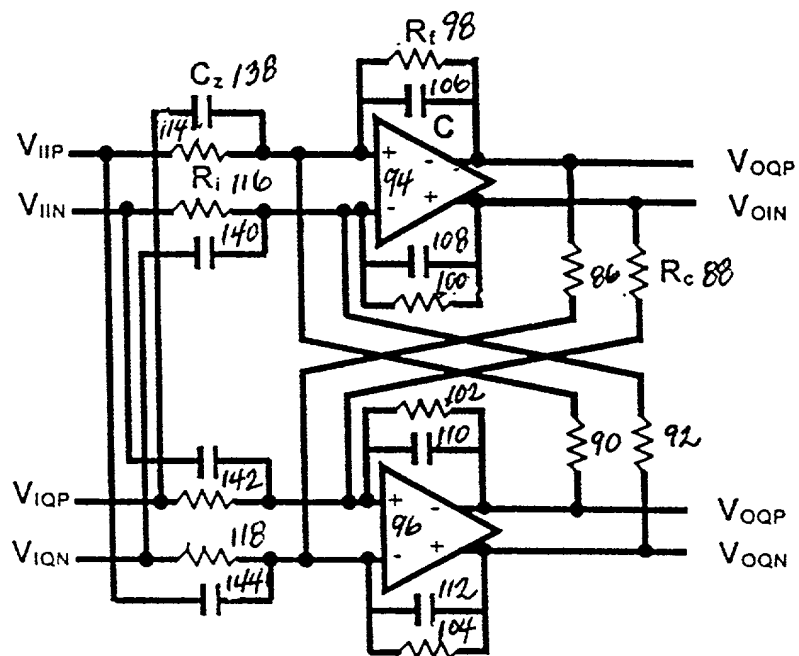


FIG. 10

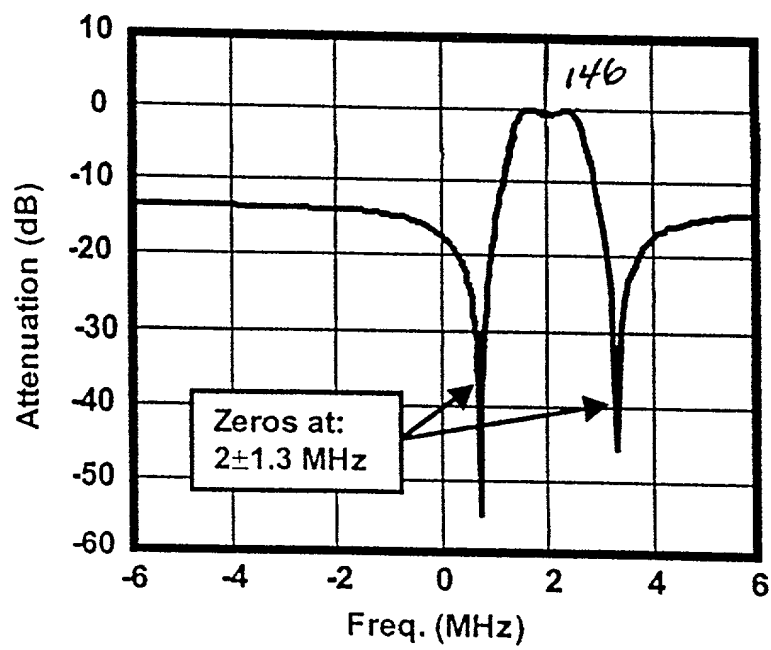


FIG. 11

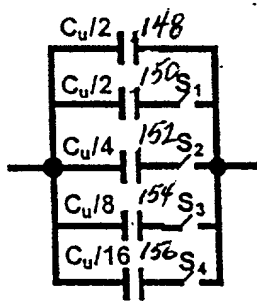


FIG. 12(a)

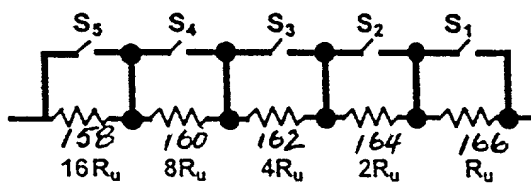


FIG. 12(b)

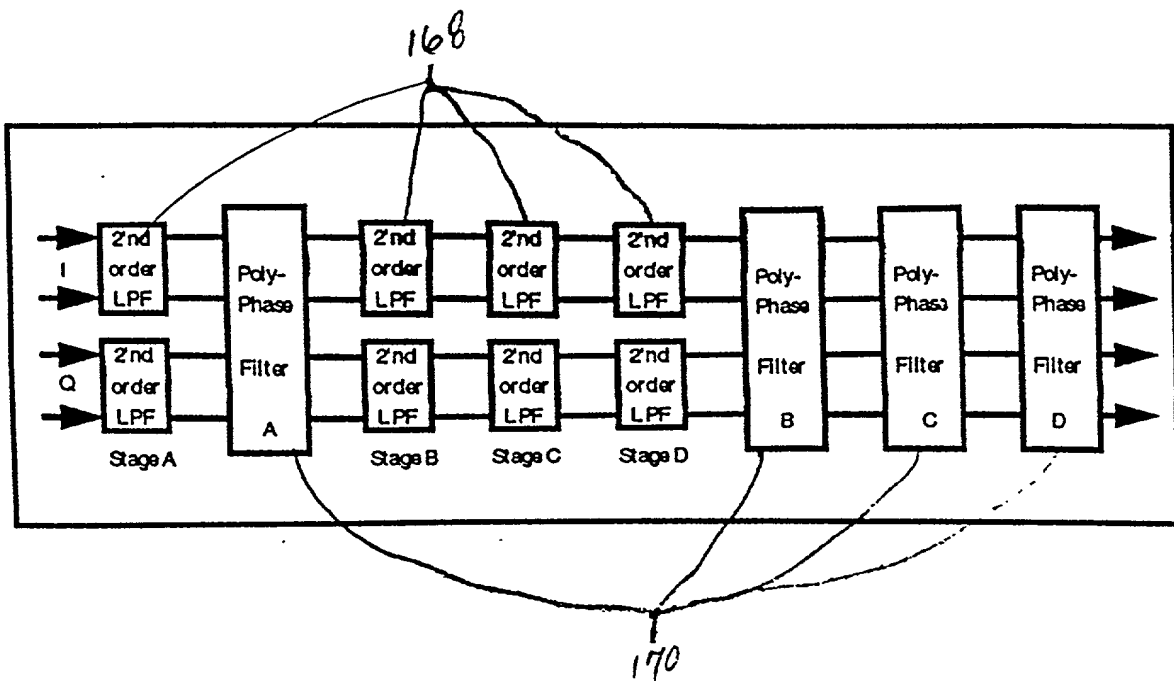


FIG. 13

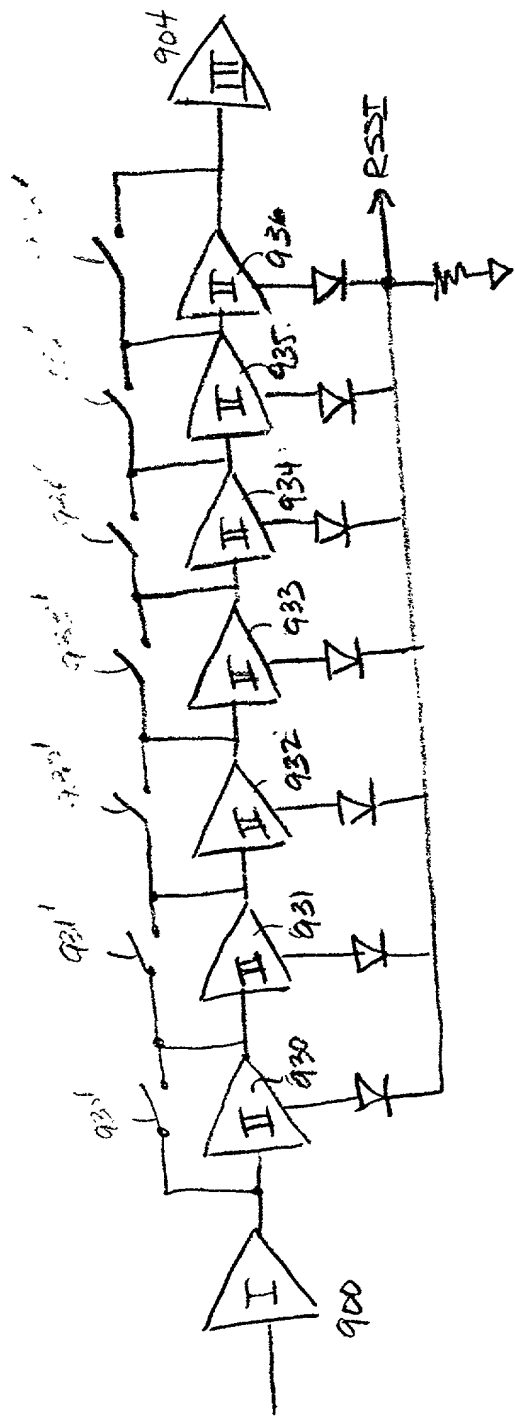


FIG. 14

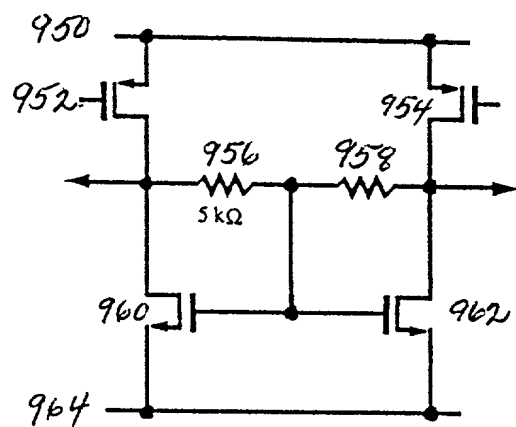


FIG. 15

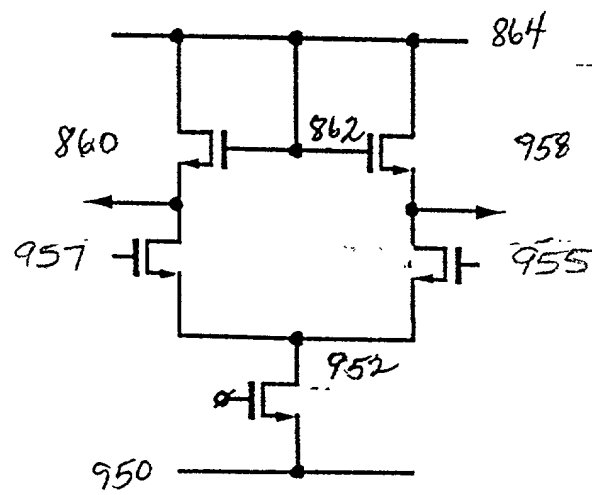
[illegible]

FIG. 11b(a)

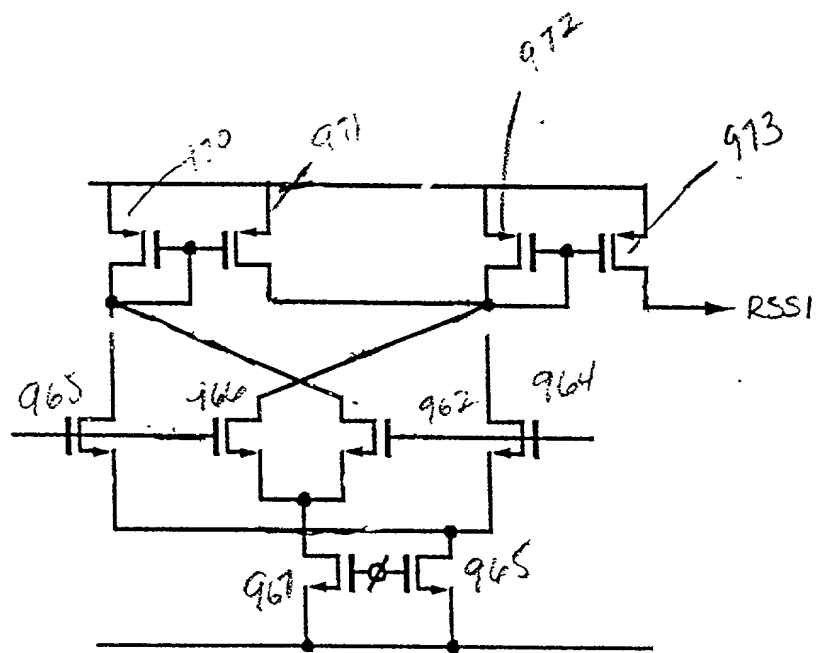


FIG. 16(b)

FIG. 17(a)

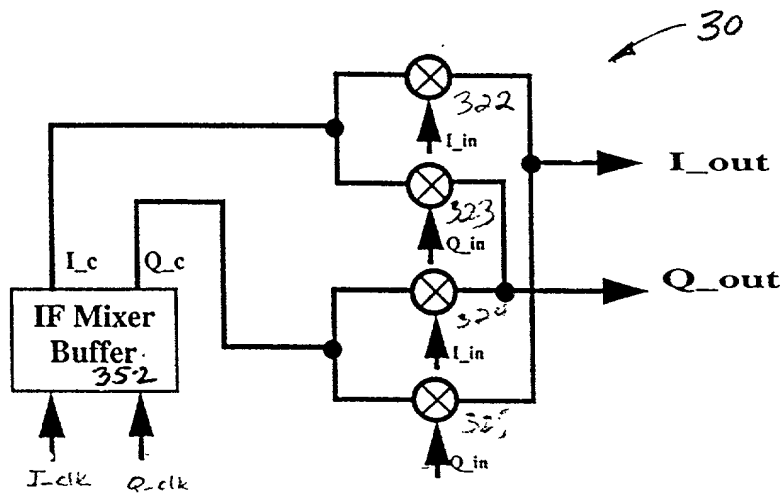


FIG. 17(b)

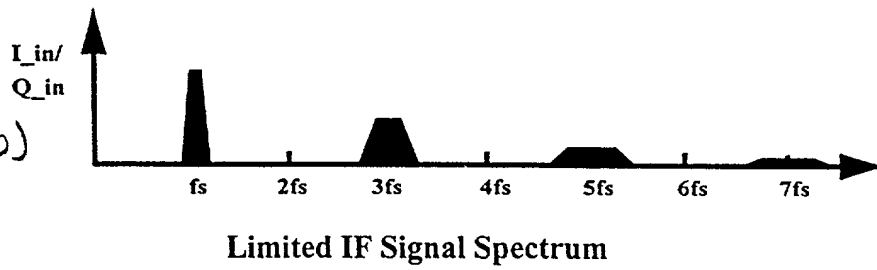


FIG. 17(c)

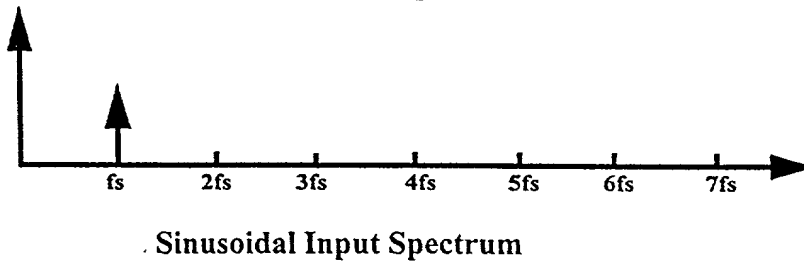


FIG. 17(d)

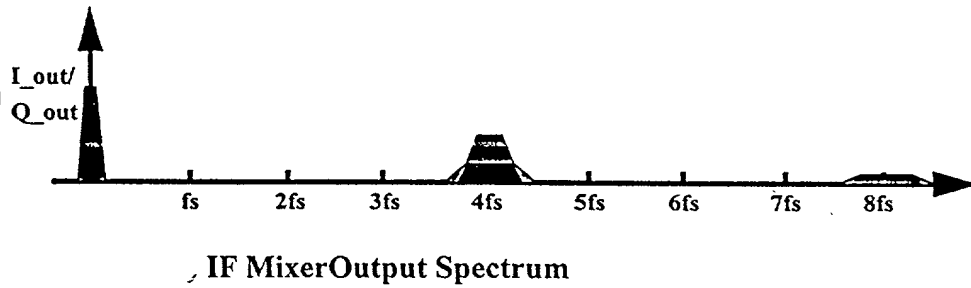


FIG. 18

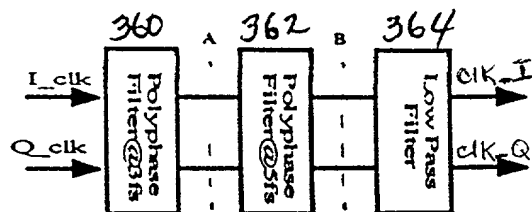


FIG. 19(a)

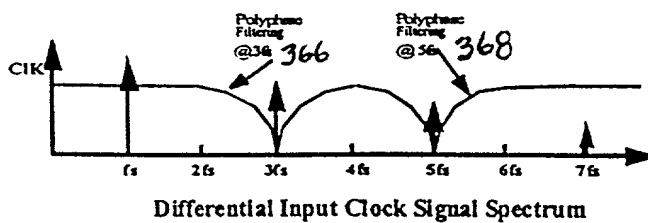


FIG. 19(b)

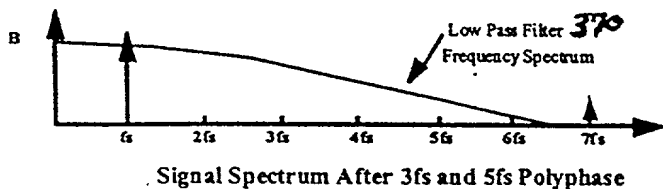
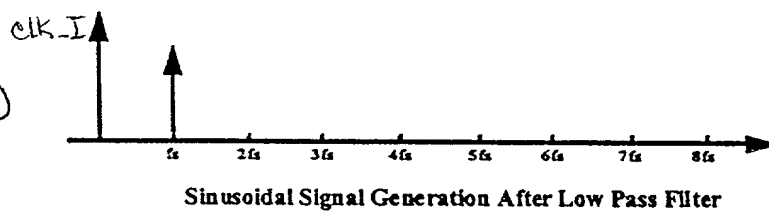
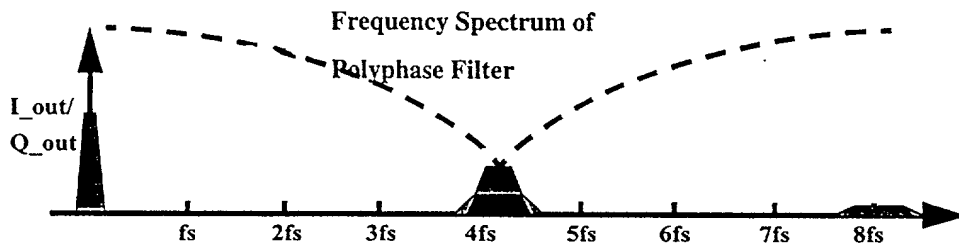


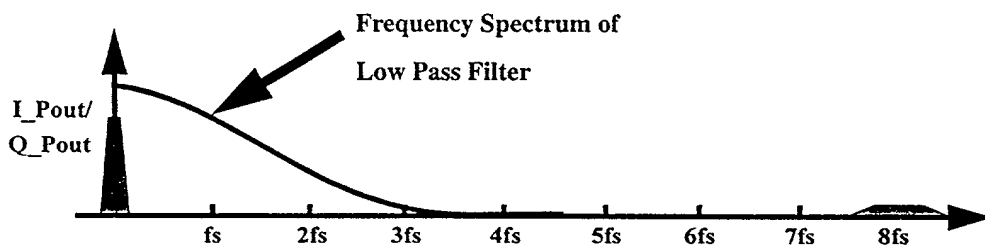
FIG. 19(c)





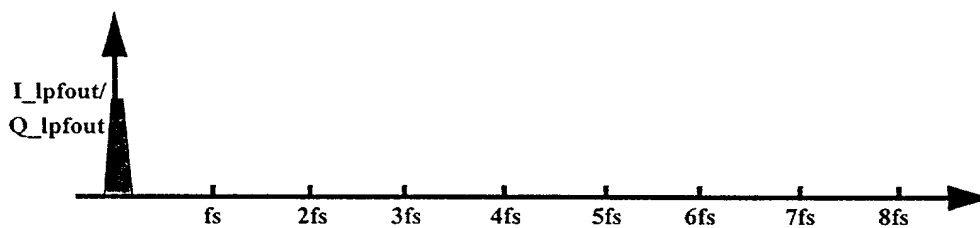
Signal Spectrum at Polyphase Input

FIG. 20(a)



Signal Spectrum at Polyphase Output

FIG. 20(b)



Signal Spectrum at Low Pass Filter Output

FIG. 20(c)

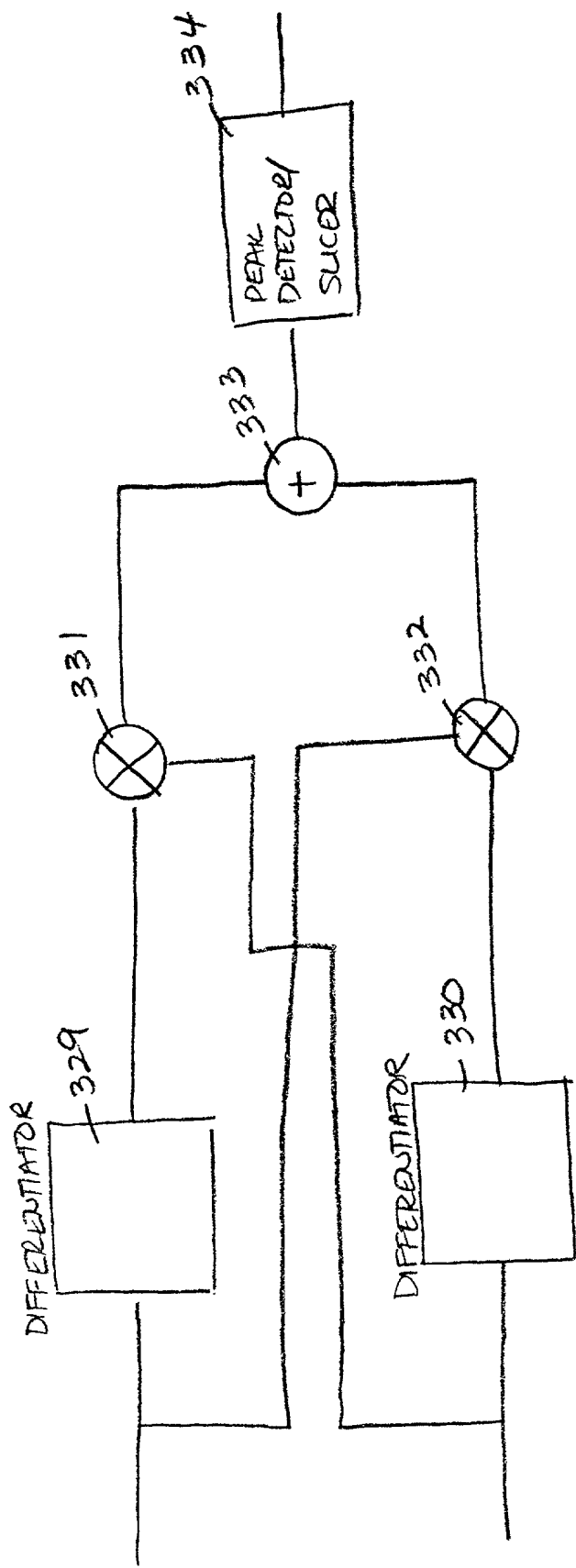


FIG. 21

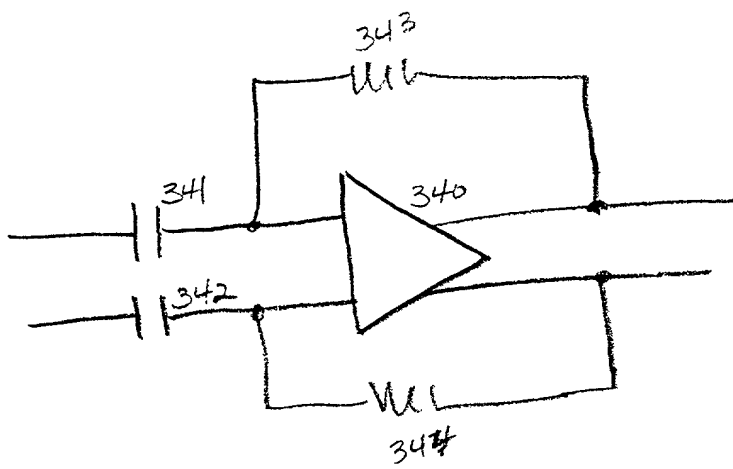
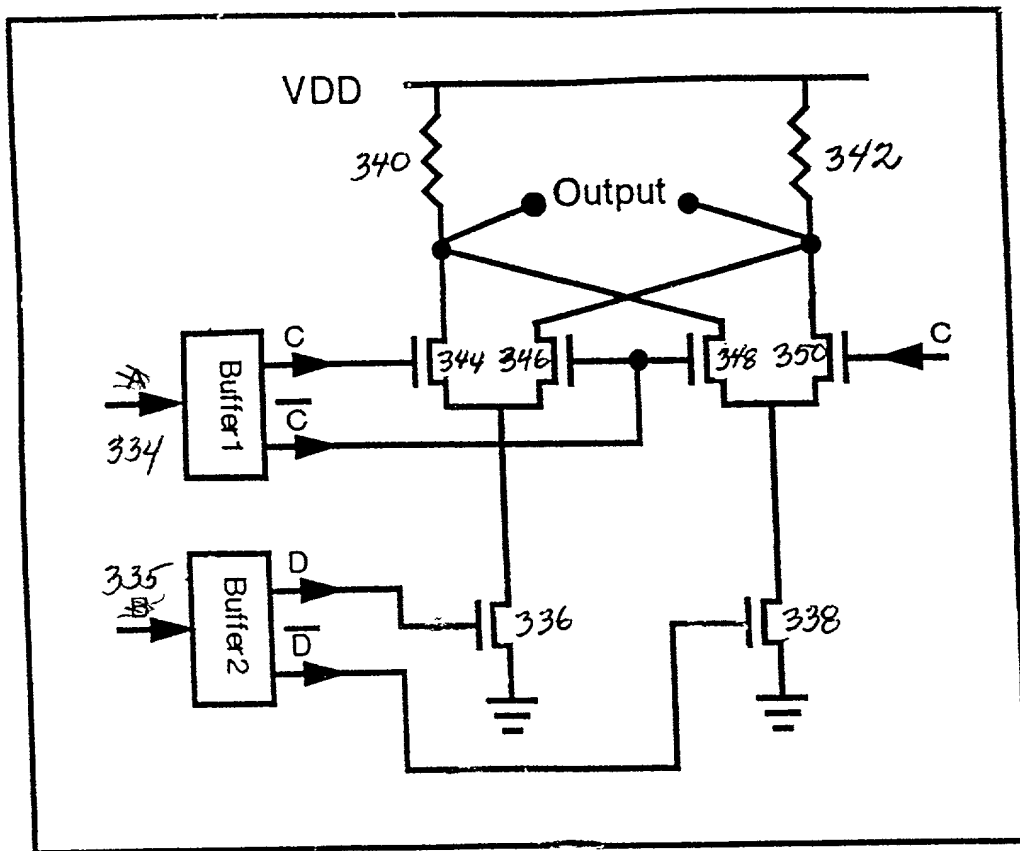


FIGURE 22



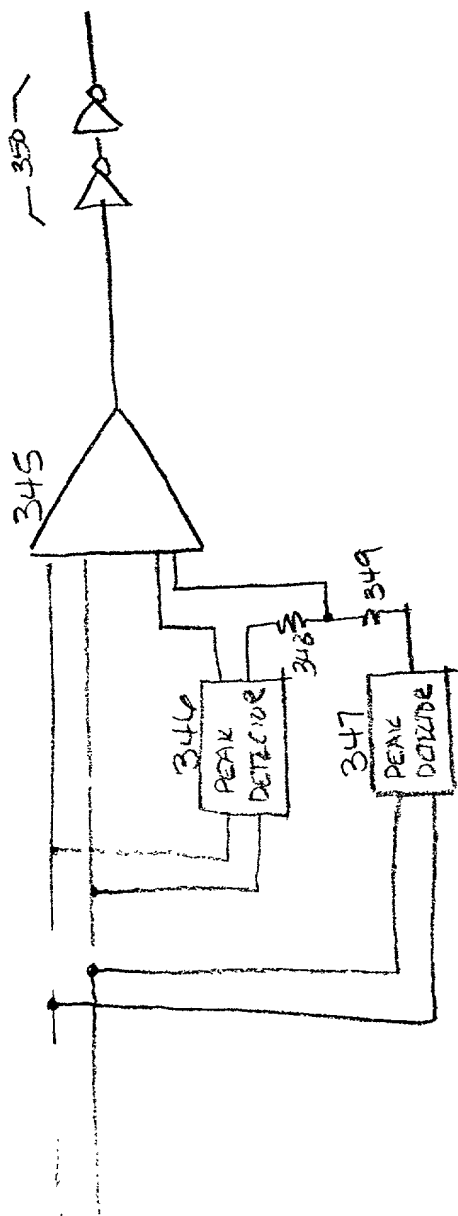


FIGURE 24

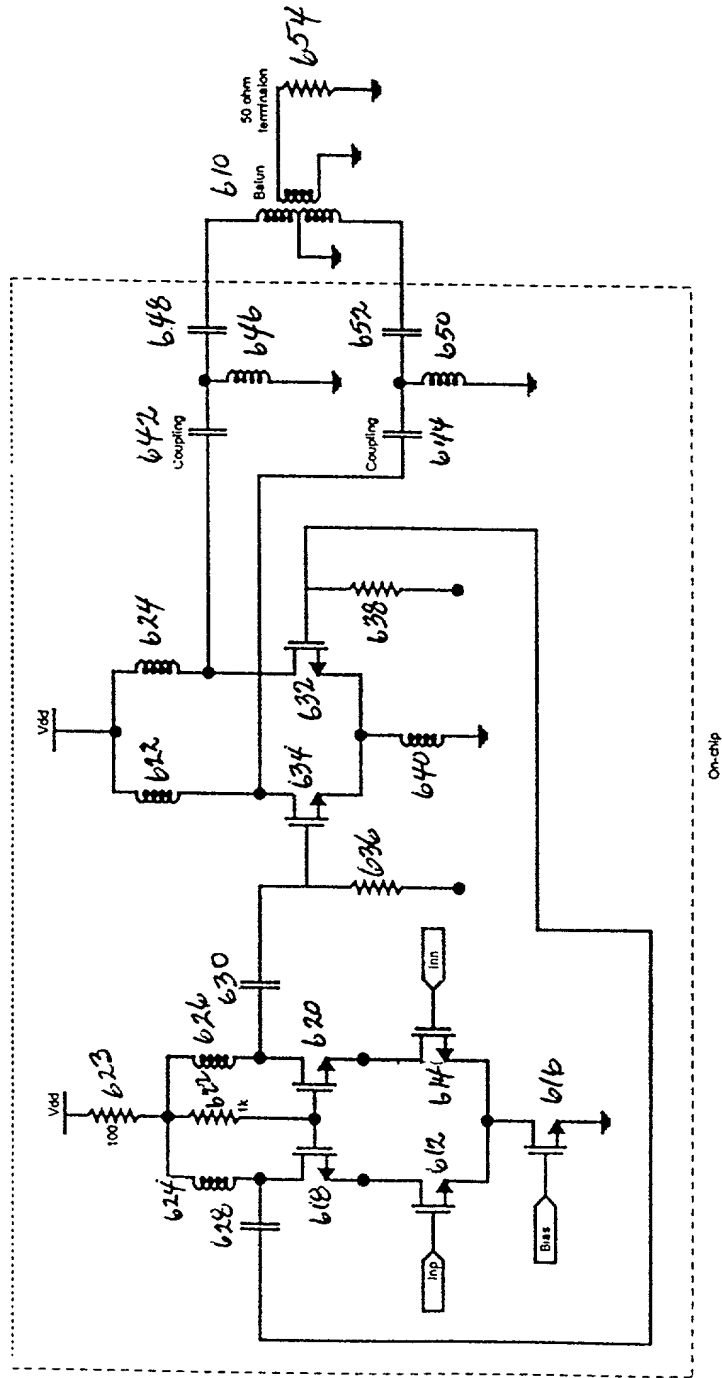


FIG. 25

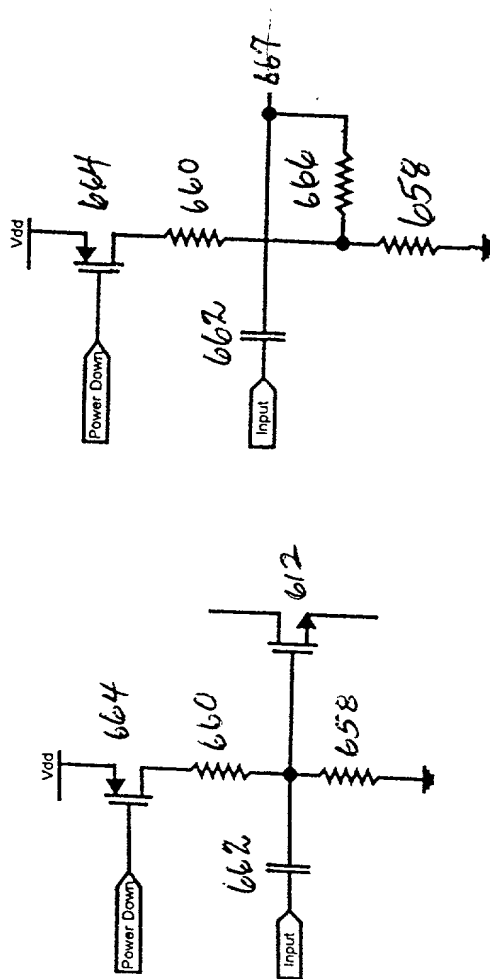


FIG. 26(a)

FIG. 26(b)

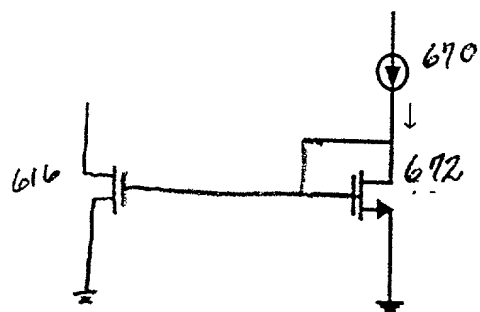


FIG. 27

00314173636363

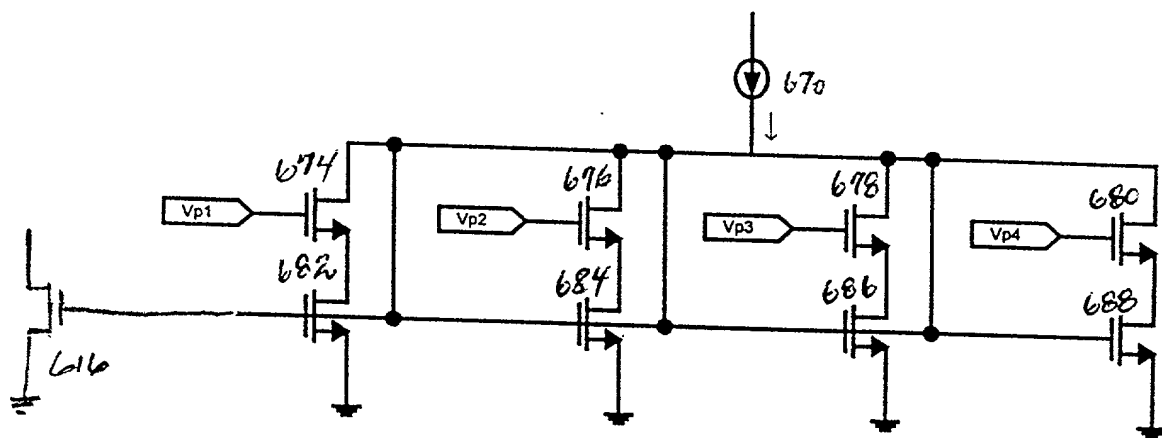


FIG. 28

FIG. 29

FIG. 30

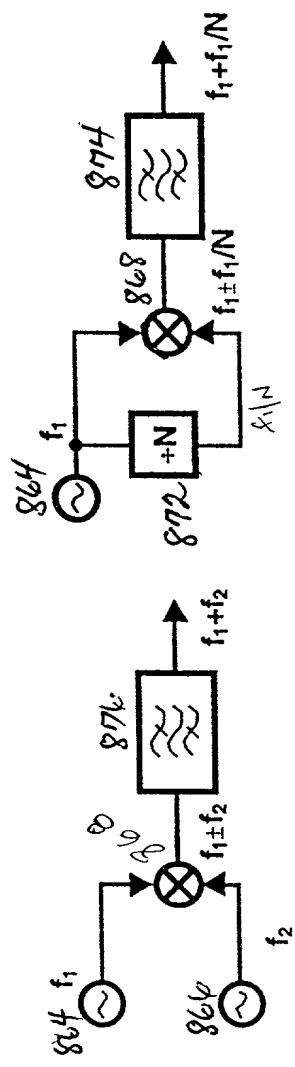


FIG. 31(a)

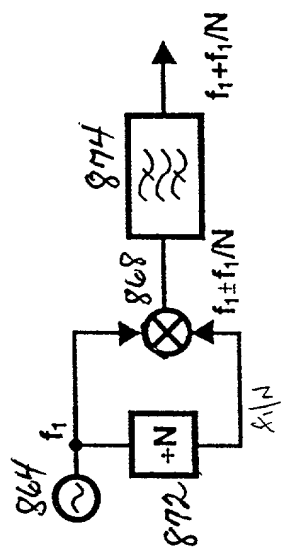


FIG. 31(b)

	1990	1991	1992	1993	1994	1995	1996	1997	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034	2035	2036	2037	2038	2039	2040	2041	2042	2043	2044	2045	2046	2047	2048	2049	2050	2051	2052	2053	2054	2055	2056	2057	2058	2059	2060	2061	2062	2063	2064	2065	2066	2067	2068	2069	2070	2071	2072	2073	2074	2075	2076	2077	2078	2079	2080	2081	2082	2083	2084	2085	2086	2087	2088	2089	2090	2091	2092	2093	2094	2095	2096	2097	2098	2099	2100	2101	2102	2103	2104	2105	2106	2107	2108	2109	2110	2111	2112	2113	2114	2115	2116	2117	2118	2119	2120	2121	2122	2123	2124	2125	2126	2127	2128	2129	2130	2131	2132	2133	2134	2135	2136	2137	2138	2139	2140	2141	2142	2143	2144	2145	2146	2147	2148	2149	2150	2151	2152	2153	2154	2155	2156	2157	2158	2159	2160	2161	2162	2163	2164	2165	2166	2167	2168	2169	2170	2171	2172	2173	2174	2175	2176	2177	2178	2179	2180	2181	2182	2183	2184	2185	2186	2187	2188	2189	2190	2191	2192	2193	2194	2195	2196	2197	2198	2199	2200	2201	2202	2203	2204	2205	2206	2207	2208	2209	2210	2211	2212	2213	2214	2215	2216	2217	2218	2219	2220	2221	2222	2223	2224	2225	2226	2227	2228	2229	2230	2231	2232	2233	2234	2235	2236	2237	2238	2239	2240	2241	2242	2243	2244	2245	2246	2247	2248	2249	2250	2251	2252	2253	2254	2255	2256	2257	2258	2259	2260	2261	2262	2263	2264	2265	2266	2267	2268	2269	2270	2271	2272	2273	2274	2275	2276	2277	2278	2279	2280	2281	2282	2283	2284	2285	2286	2287	2288	2289	2290	2291	2292	2293	2294	2295	2296	2297	2298	2299	2300	2301	2302	2303	2304	2305	2306	2307	2308	2309	2310	2311	2312	2313	2314	2315	2316	2317	2318	2319	2320	2321	2322	2323	2324	2325	2326	2327	2328	2329	2330	2331	2332	2333	2334	2335	2336	2337	2338	2339	2340	2341	2342	2343	2344	2345	2346	2347	2348	2349	2350	2351	2352	2353	2354	2355	2356	2357	2358	2359	2360	2361	2362	2363	2364	2365	2366	2367	2368	2369	2370	2371	2372	2373	2374	2375	2376	2377	2378	2379	2380	2381	2382	2383	2384	2385	2386	2387	2388	2389	2390	2391	2392	2393	2394	2395	2396	2397	2398	2399	2400	2401	2402	2403	2404	2405	2406	2407	2408	2409	2410	2411	2412	2413	2414	2415	2416	2417	2418	2419	2420	2421	2422	2423	2424	2425	2426	2427	2428	2429	2430	2431	2432	2433	2434	2435	2436	2437	2438	2439	2440	2441	2442	2
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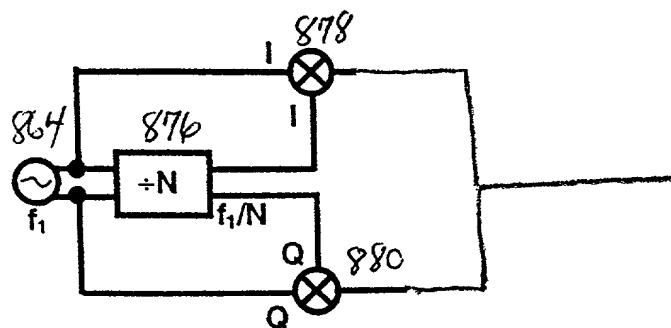


FIG. 32

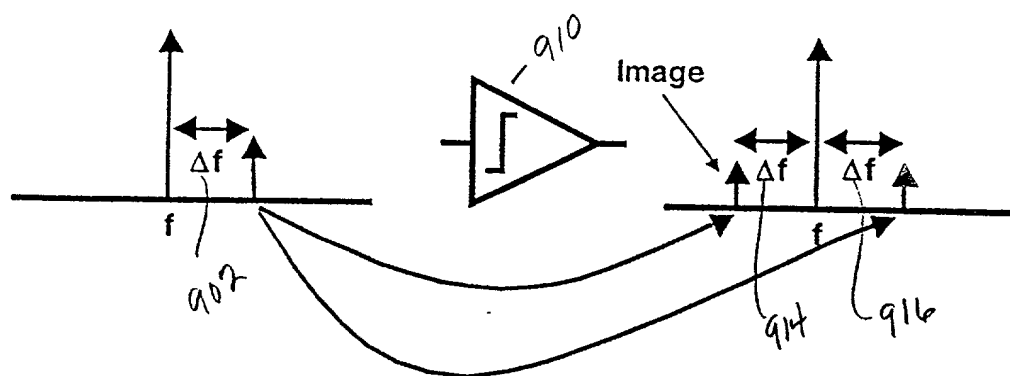


FIG. 33(a)

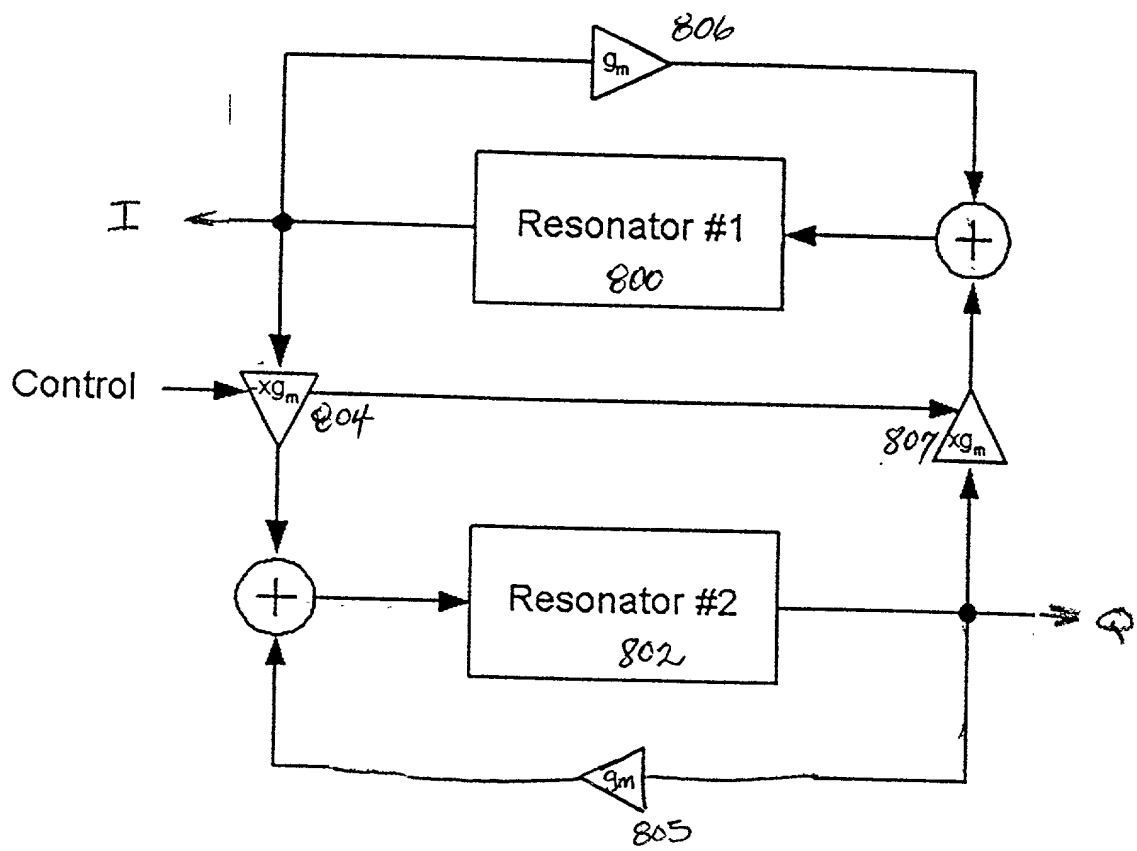
[illegible]

FIG. 34

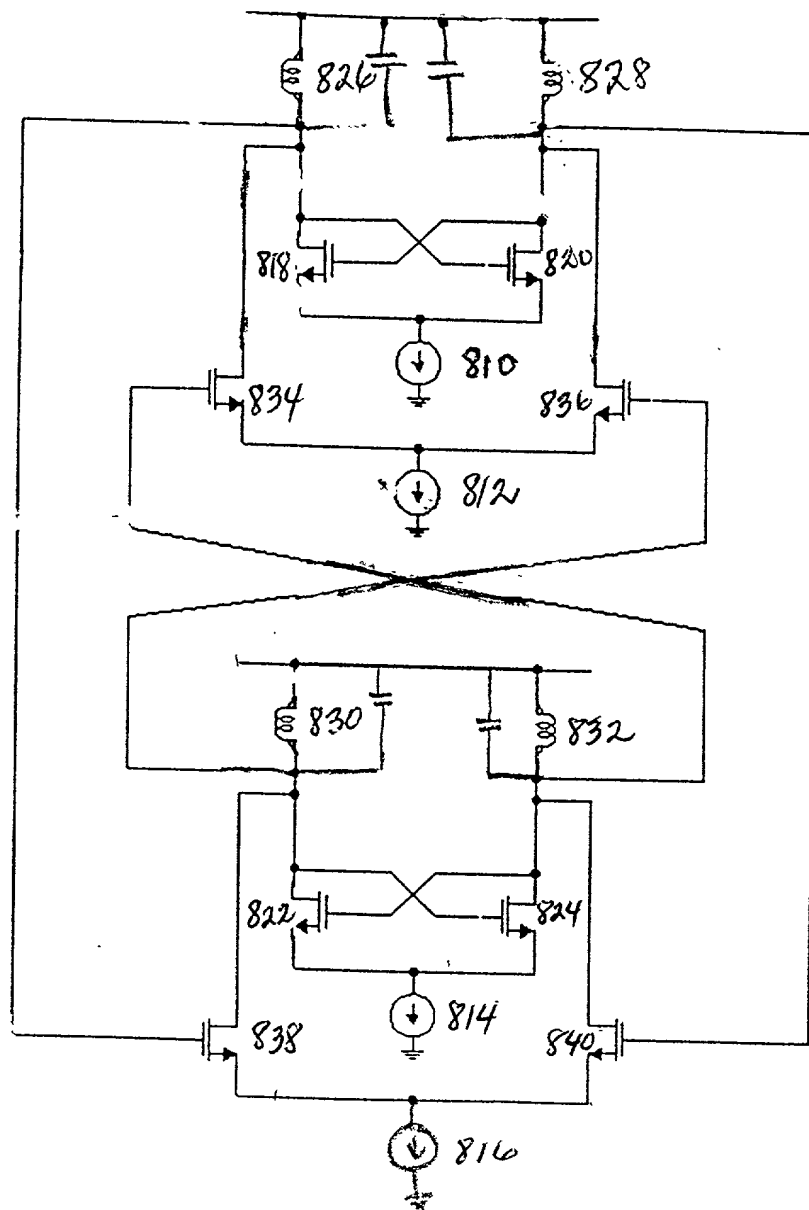
[illegible]

FIG. 35

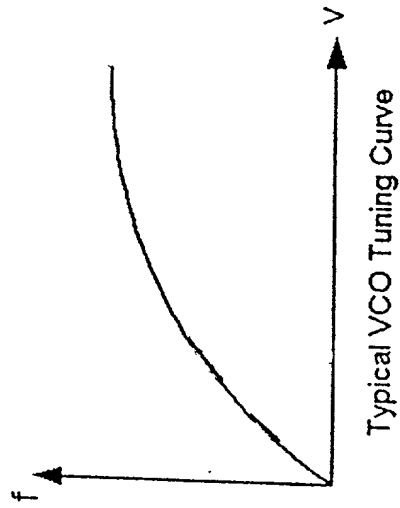


FIG. 36(a)

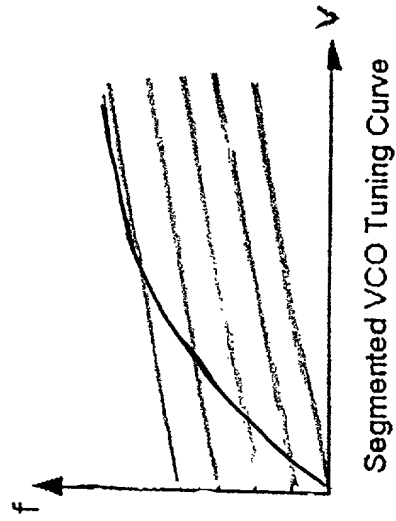


FIG. 36(b)

FIG. 37(a)

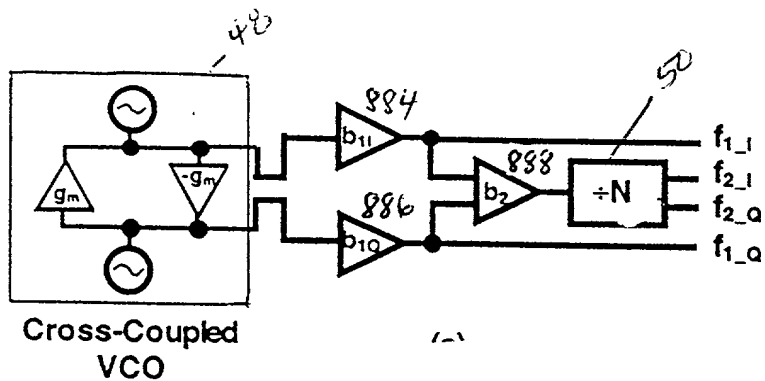
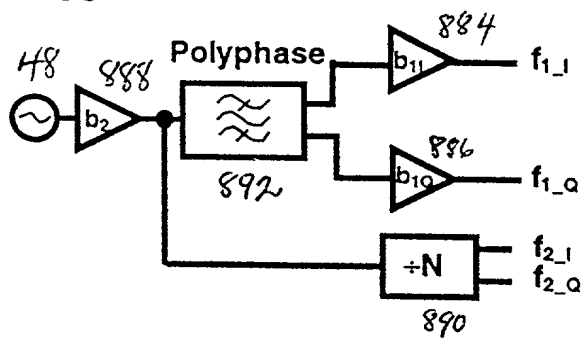


FIG. 37(b)



Country	Year	GDP (constant 2005 US\$)		GDP per capita (constant 2005 US\$)		Population (millions)		Urban population (millions)		Rural population (millions)		Total population (millions)	
		2000	2005	2000	2005	2000	2005	2000	2005	2000	2005	2000	2005
Algeria	2000	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2005	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2010	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2015	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2020	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2025	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2030	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2035	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2040	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2045	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2050	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2055	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2060	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2065	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2070	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2075	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2080	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2085	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2090	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2095	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2100	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2105	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2110	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2115	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2120	10,000,000,000	10,000,000,000	1,000	1,000	20	20	10	10	10	10	20	20
Algeria	2125	10,0											

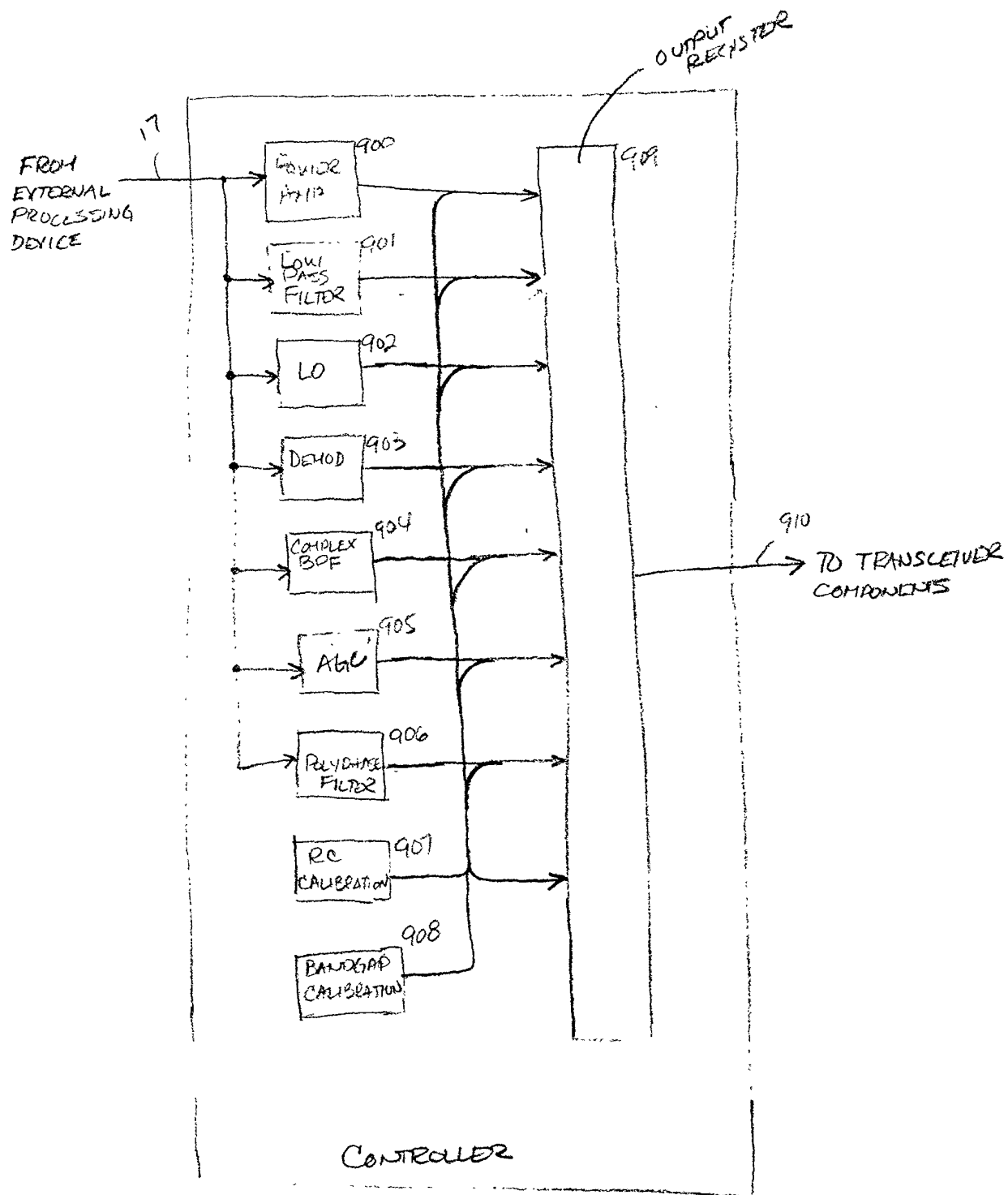


FIGURE 38

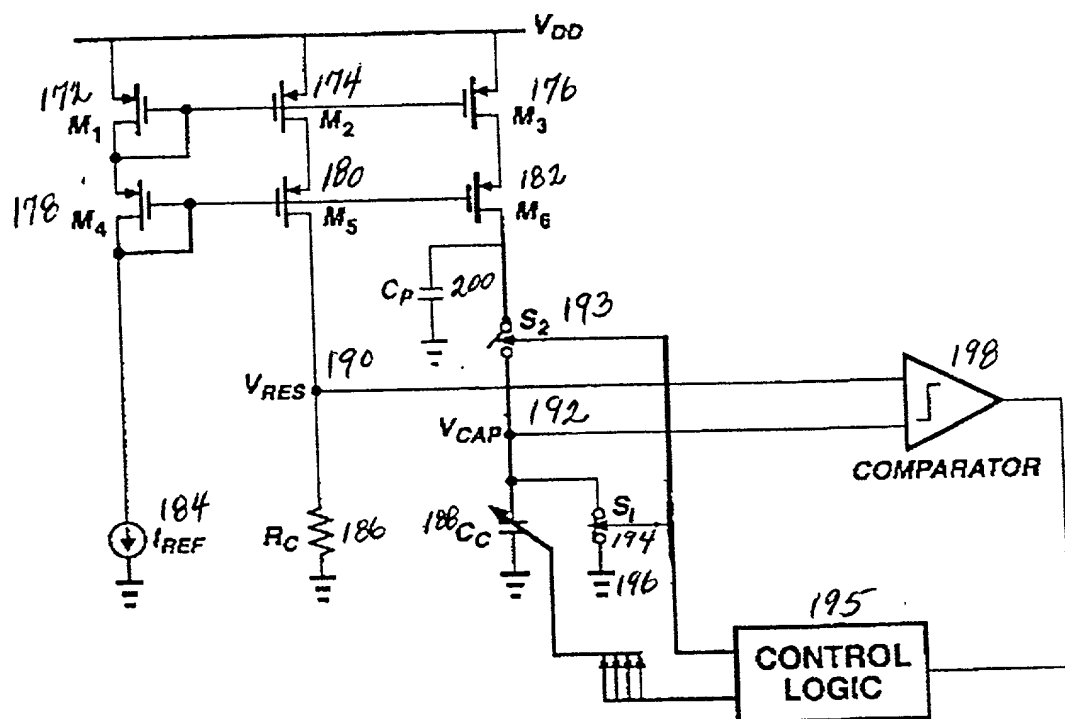


FIG. 39

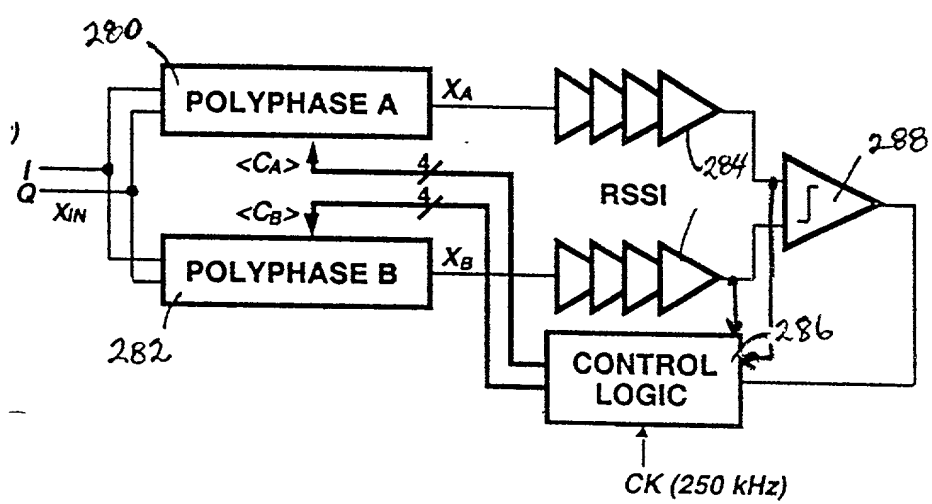


FIG. 40

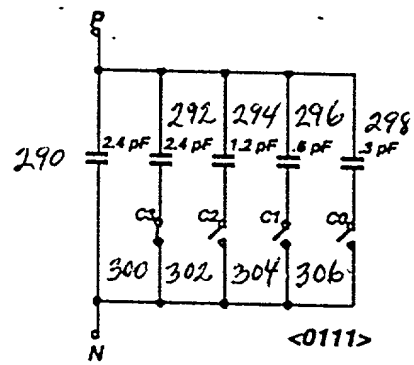


FIG. 41

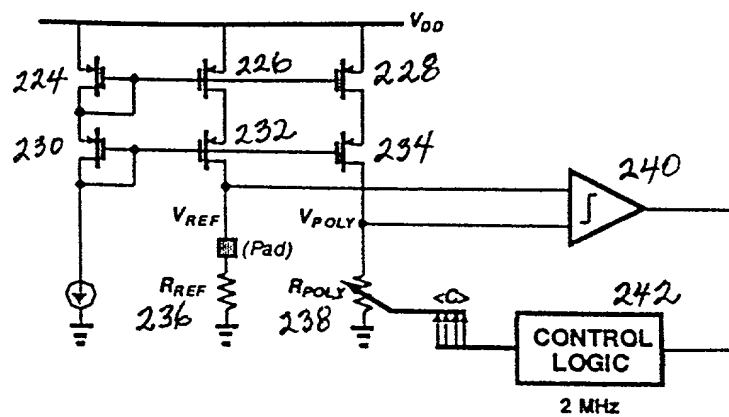


FIG. 42

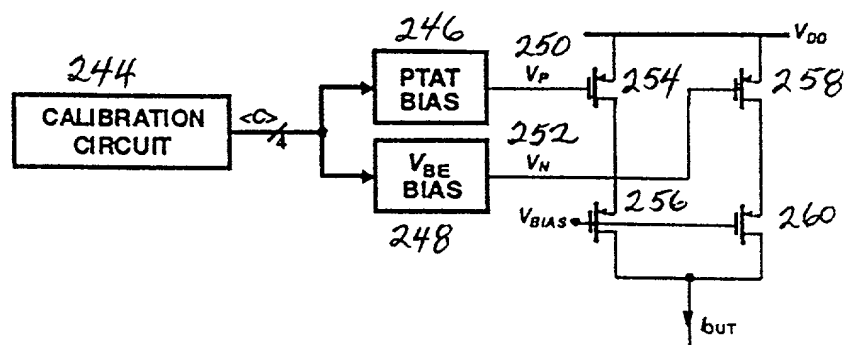


FIG. 43

000007692630

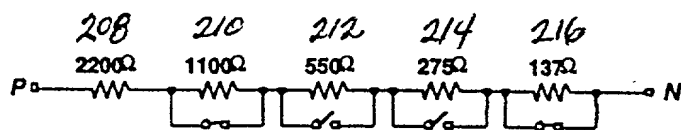
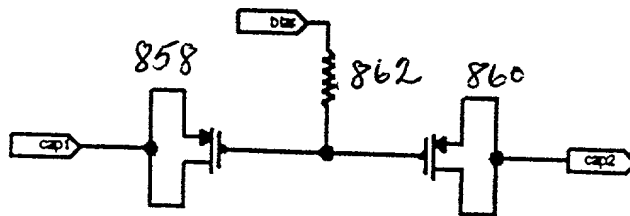


FIG. 44

FIG. 45



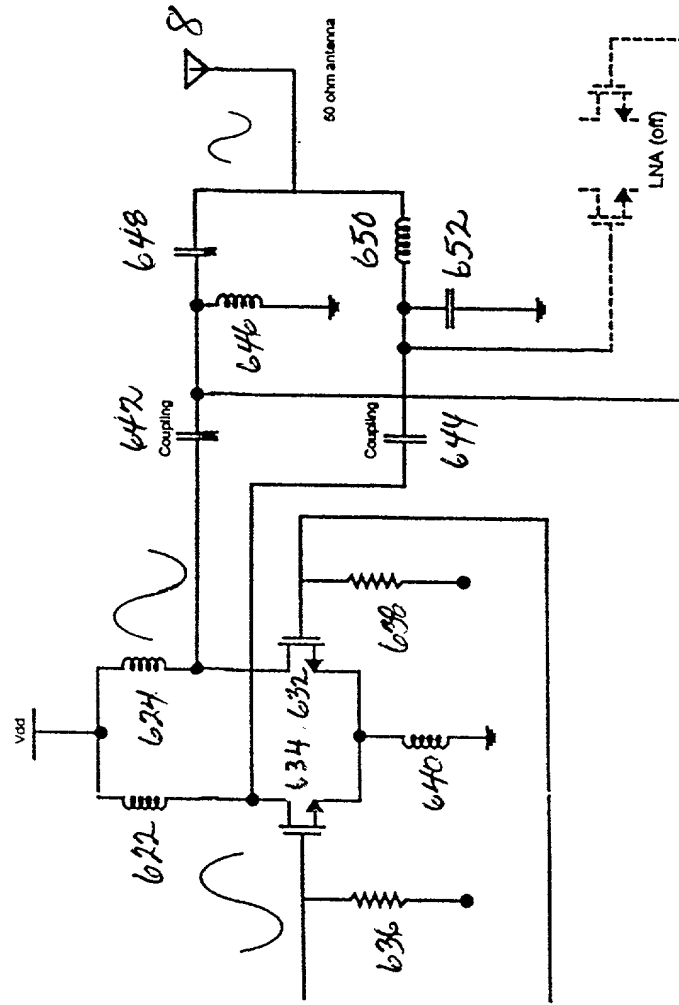


FIG. 46

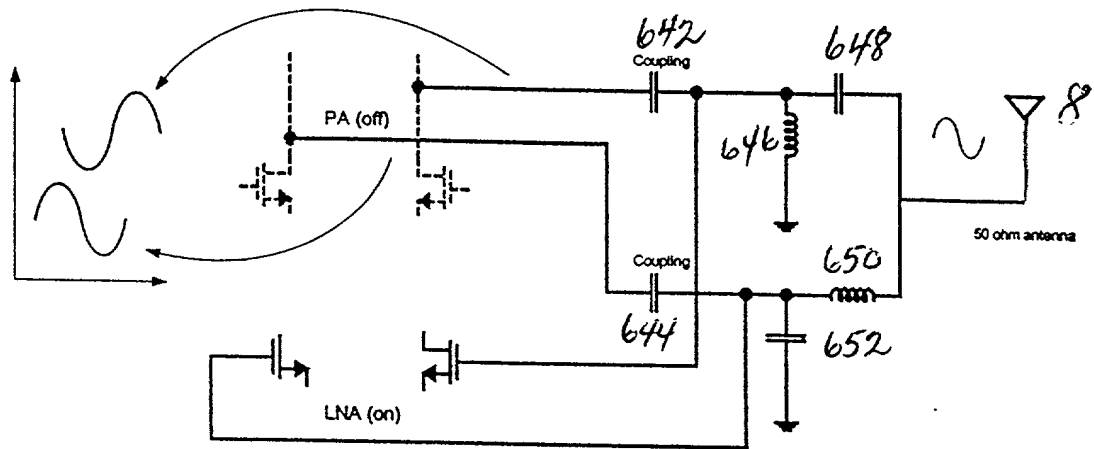


FIG. 47

**DECLARATION AND POWER OF ATTORNEY
FOR PATENT APPLICATIONS**

PATENT

Docket No. : 39390/CAG/B600

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled AN ADAPTIVE RADIO TRANSCEIVER WITH A WIDE TUNING RANGE VCO, the specification of which is attached hereto unless the following is checked:

___ was filed on ___ as United States Application Number or PCT International Application Number ___ and was amended on ___ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of the foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)

<u>Application Number</u>	<u>Country</u>	<u>Filing Date (day/month/year)</u>	<u>Priority Claimed</u>
---------------------------	----------------	-------------------------------------	-------------------------

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below.

<u>Application Number</u>	<u>Filing Date</u>
---------------------------	--------------------

60/160,806	October 21, 1999
60/163,487	November 4, 1999
60/163,398	November 4, 1999
60/164,442	November 9, 1999
60/164,194	November 9, 1999
60/164,314	November 9, 1999
60/165,234	November 11, 1999
60/165,239	November 11, 1999
60/165,356	November 12, 1999
60/165,355	November 12, 1999
60/172,348	December 16, 1999
60/201,335	May 2, 2000
60/201,157	May 2, 2000
60/201,179	May 2, 2000
60/202,997	May 2, 2000
60/201,330	May 2, 2000

**DECLARATION AND POWER OF ATTORNEY
FOR PATENT APPLICATIONS**

Docket No. 39390/CAG/B600

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

<u>Application Number</u>	<u>Filing Date</u>	<u>Patented/Pending/Abandoned</u>
09/634,552	August 8, 2000	Pending

POWER OF ATTORNEY: I hereby appoint the following attorneys and agents of the law firm CHRISTIE, PARKER & HALE, LLP to prosecute this application and any international application under the Patent Cooperation Treaty based on it and to transact all business in the U.S. Patent and Trademark Office connected with either of them in accordance with instructions from the assignee of the entire interest in this application; or from the first or sole inventor named below in the event the application is not assigned; or from __ in the event the power granted herein is for an application filed on behalf of a foreign attorney or agent.

R. W. Johnston	(17,968)	Gregory S. Lampert	(35,581)	Cynthia A. Bonner	(44,548)
D. Bruce Prout	(20,958)	Grant T. Langton	(39,739)	Jun-Young E. Jeon	(43,693)
Hayden A. Carney	(22,653)	Constantine Marantidis	(39,759)	Marc A. Karish	(44,816)
Richard J. Ward, Jr.	(24,187)	Daniel R. Kimbell	(34,849)	John F. O'Rourke	(38,985)
Russell R. Palmer, Jr.	(22,994)	Craig A. Gelfound	(41,032)	Richard J. Paciulan	(28,248)
LeRoy T. Rahn	(20,356)	Syed A. Hasan	(41,057)	Josephine E. Chang	(46,083)
Richard D. Seibel	(22,134)	Kathleen M. Olster	(42,052)	Frank L. Cire	(42,419)
Walter G. Maxwell	(25,355)	Daniel M. Cavanagh	(41,661)	Harold E. Wurst	(22,183)
William P. Christie	(29,371)	Molly A. Holman	(40,022)	Robert A. Green	(28,301)
David A. Dillard	(30,831)	Lucinda G. Auciello	(42,270)	Derrick W. Reed	(40,138)
Thomas J. Daly	(32,213)	Norman E. Carte	(30,455)	John W. Peck	(44,284)
Vincent G. Gioia	(19,959)	Joel A. Kauth	(41,886)	Stephen D. Burbach	(40,285)
Edward R. Schwartz	(31,135)	Patrick Y. Ikehara	(42,681)	David B. Sandelands, Jr.	(46,023)
John D. Carpenter	(34,133)	Mark Garscia	(31,953)	Heidi L. Eisenhut	(46,812)
David A. Plumley	(37,208)	Gary J. Nelson	(44,257)	Nicholas J. Pauley	(44,999)
Wesley W. Monroe	(39,778)	Raymond R. Tabandeh	(43,945)	Mark J. Marcelli	(36,593)

The authority under this Power of Attorney of each person named above shall automatically terminate and be revoked upon such person ceasing to be a member or associate of or of counsel to that law firm.

DIRECT TELEPHONE CALLS TO : Craig A. Gelfound, 626/795-9900
SEND CORRESPONDENCE TO : CHRISTIE, PARKER & HALE, LLP
P.O. Box 7068, Pasadena, CA 91109-7068

I declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

**DECLARATION AND POWER OF ATTORNEY
FOR PATENT APPLICATIONS**

Docket No. 39390/CAG/B600

Full name of sole or first joint inventor Jacob Rael	Inventor's signature	Date
Residence and Post Office Address Los Angeles, California		Citizenship USA

Full name of second joint inventor Ahmadreza Rofougaran	Inventor's signature	Date
Residence and Post Office Address Marina Del Rey, California		Citizenship USA

EJ PAS280419 1-*·10/18/00 7 11 AM